

ADC32RF5x Dual Channel 14-bit 2.6 to 3-GSPS RF Sampling Data Converter

1 Features

- 14-Bit, dual channel 2.6 to 3-GSPS ADC
- Noise spectral density:
 - NSD = -155.6 dBFS/Hz (no AVG)
 - NSD = -158.1 dBFS/Hz (2x AVG)
 - NSD = -160.4 dBFS/Hz (4x AVG)
- Single core (non-interleaved) ADC architecture
- Aperture jitter: 50 fs
- Low close-in residual phase noise:
 - -127 dBc/Hz at 10 kHz offset
- Spectral performance ($f_{IN} = 1$ GHz, -4 dBFS):
 - 2x internal averaging
 - SNR: 62.3 dBFS
 - SFDR HD2,3: 63 dBc
 - SFDR worst spur: 85 dBFS
- Spectral performance ($f_{IN} = 1.8$ GHz, -4 dBFS):
 - 2x internal averaging
 - SNR: 63 dBFS
 - SFDR HD2,3: 68 dBc
 - SFDR worst spur: 86 dBFS
- Input fullscale: 1.1 to 1.35 Vpp (2 to 3.5 dBm)
- Code error rate (CER): 10^{-15}
- Full power input bandwidth (-3 dB): 2.75 GHz
- JESD204B serial data interface
 - Maximum lane rate: 13 Gbps
 - Supports subclass 1 deterministic latency
- Digital down-converters
 - Up to four DDC per ADC channel
 - Complex output: 4x to 128x decimation
 - 48-bit NCO phase coherent frequency hopping
 - Fast frequency hopping: < 1 us
- Power consumption: 2.6 W/channel (2x AVG)
- Power supplies: 1.8 V, 1.2 V

2 Applications

- Phased array radar
- Spectrum analyzer
- Software defined radio (SDR)
- [Electronic warfare](#)
- High-speed digitizer
- Cable infrastructure
- Communications infrastructure

3 Description

The ADC32RF5x is a single core 14-bit, 2.6 GSPS to 3 GSPS, dual channel analog to digital converters (ADC) that supports RF sampling with input frequencies up to 3 GHz. The design maximizes signal-to-noise ratio (SNR) and delivers a noise spectral density of -155 dBFS/Hz. Using additional internal ADCs along with on-chip signal averaging, the noise density improves to -161 dBFS/Hz.

Each ADC channel can be connected to a quad-band digital down-converter (DDC) using a 48-bit NCO which supports phase coherent frequency hopping. Using the GPIO pins for NCO frequency control, frequency hopping can be achieved in less than 1 μ s.

The ADC32RF54 and ADC32RF55 supports the JESD204B serial data interface with subclass 1 deterministic latency using data rates up to 13 Gbps.

The power efficient ADC architecture consumes 2.1 W/ch at 3 Gbps and provides power scaling with lower sampling rates.

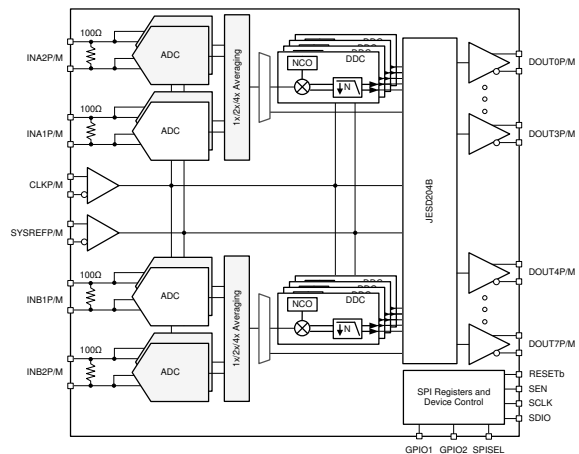
Package Information

| PART NUMBER | PACKAGE ⁽¹⁾ | PACKAGE SIZE ⁽²⁾ |
|-------------|------------------------|-----------------------------|
| ADC32RF5x | VQFN (64) | 9 mm x 9 mm |

- (1) For all available packages, see the package option addendum at the end of the data sheet.
- (2) The package size (length \times width) is a nominal value and includes pins, where applicable.

Table 3-1. Device Comparison

| PART NUMBER | SAMPLING RATE |
|-------------|---------------|
| ADC32RF55 | 3.0 GSPS |
| ADC32RF54 | 2.6 GSPS |



Block Diagram



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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (December 2022) to Revision B (August 2023) | Page |
|--|------|
| • Changed ADC32RF54 from product preview to <i>Production data</i> | 1 |
| • Added note 2 to the <i>Package Information</i> table | 1 |
| • Changed absolute maximum junction temperature from 115 to 125C..... | 5 |
| • Changed AVDD12 max current from 2120 to 2200 mA..... | 7 |
| • Changed CLKVDD max current from 175 to 190 mA..... | 7 |
| • Changed DVDD max current from 3600 to 4200 mA..... | 7 |
| • Changed the gain and offset error typical values..... | 8 |
| • Changed the Noise Figure (3 GSPS, 4x averaging, dither disabled) from 17.5 to 20.2 dB..... | 14 |
| • Changed the Noise Figure (3 GSPS, 4x averaging, dither enabled) from 18.1 to 20.8 dB..... | 16 |
| • Changed in 0x03 to 0x08 in the DATA column of Table 7-2 | 41 |
| • Changed register writes for OVR on GPIO pins..... | 43 |
| • Changed Figure 7-19 | 51 |
| • Changed the <i>ADC Switch</i> section..... | 52 |
| • Changed the <i>Calibration Configuration</i> section..... | 52 |
| • Added the <i>JESD204B Frame Assembly with Real Decimation - Single Band</i> topic..... | 67 |
| • Changed registers 0x2F and 0x30 for 1x averaging..... | 107 |
| • Changed register 0x5C from M-1 in ILA (M=2) to F-1 in ILA (F=2) in Table 8-6 | 109 |
| • Changed <i>Analog Trim Settings</i> for 2.7-2.9 GSPS..... | 110 |
| • Changed <i>STEP 8: SYSREF Synchronization</i> | 113 |
| • Changed <i>STEP 9: Run Power up Calibration</i> | 113 |

| Changes from Revision * (June 2022) to Revision A (December 2022) | Page |
|---|------|
| • Added ADC32RF55 to the document as <i>Production data</i> | 1 |

5 Pin Configuration and Functions

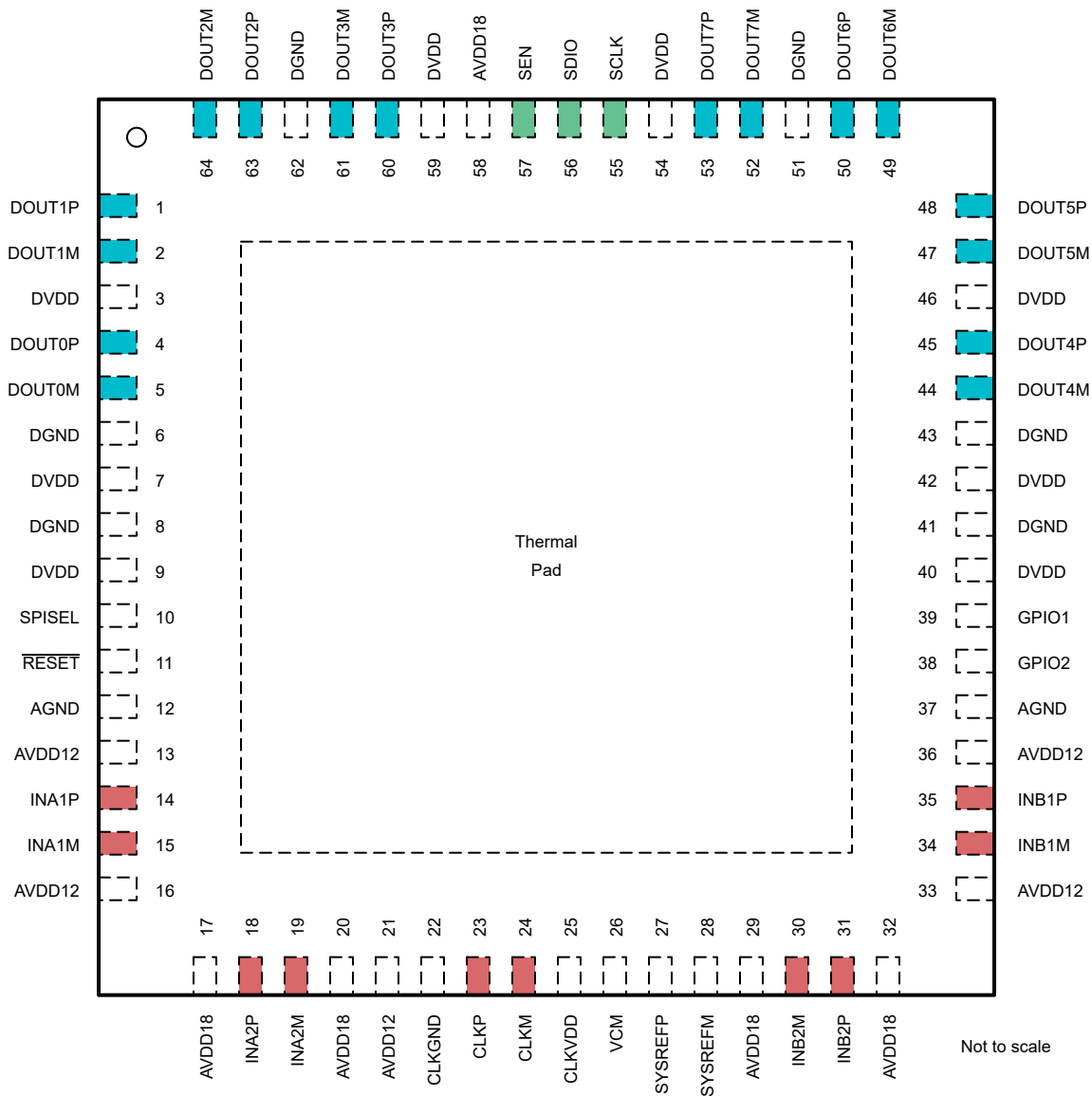


Figure 5-1. RTD Package, 64 Pin VQFN (Top View)

Table 5-1. Pin Functions

| PIN | | TYPE ⁽¹⁾ | DESCRIPTION |
|----------------------|-----|---------------------|--|
| NAME | NO. | | |
| ANALOG INPUTS | | | |
| INA1P | 14 | I | Differential analog input for channel A. 100 Ω (default) or 50 Ω differential internal termination. |
| INA1M | 15 | | |
| INA2P | 18 | I | Differential analog input for alternate channel A input. This input is used for additional ADC averaging for channel A. 100 Ω (default) or 50 Ω differential internal termination. Should be connected to GND if unused. |
| INA2M | 19 | | |

Table 5-1. Pin Functions (continued)

| PIN | | TYPE ⁽¹⁾ | DESCRIPTION |
|-------------------------------|-----------------------|---------------------|--|
| NAME | NO. | | |
| INB1P | 35 | I | Differential analog input for channel B. 100 Ω (default) or 50 Ω differential internal termination. |
| INB1M | 34 | | |
| INB2P | 31 | I | Differential analog input for alternate channel B input. This input is used for additional ADC averaging for channel B. 100 Ω (default) or 50 Ω differential internal termination. Should be connected to GND if unused. |
| INB2M | 30 | | |
| VCM | 26 | O | Common-mode voltage output for the analog inputs. |
| CLOCK, SYNCHRONIZATION | | | |
| CLKP | 23 | I | Differential sampling clock input. 100 Ω differential internal termination. |
| CLKM | 24 | | |
| SYSREFP | 27 | I | Differential external synchronization input. |
| SYSREFM | 28 | | |
| CONTROL | | | |
| RESET | 11 | I | Hardware reset. Active low. This pin has an internal 21 kΩ pullup resistor to AVDD18. |
| SEN | 57 | I | Serial interface enable. Active low. This pin has an internal 21 kΩ pull-up resistor to AVDD18. |
| SCLK | 55 | I | Serial interface clock input. This pin has an internal 21 kΩ pull-down resistor. |
| SDIO | 56 | I/O | Serial interface data input and output. This pin has an internal 21 kΩ pull-down resistor. |
| GPIO1 | 39 | I | GPIO control pin. This pin is configured through SPI interface for power down or NCO control function. |
| GPIO2 | 38 | I | GPIO control pin. This pin is configured through SPI interface for power down or NCO control function. |
| SPISEL | 10 | I | Determines SPI control: either normal SPI for register writes or fast access to NCO selection only for fast frequency hopping. |
| DIGITAL DATA INTERFACE | | | |
| DOUT0P | 4 | O | JESD204B high-speed serial data output interface pins for channel A. |
| DOUT0M | 5 | | |
| DOUT1P | 1 | | |
| DOUT1M | 2 | | |
| DOUT2P | 63 | | |
| DOUT2M | 64 | | |
| DOUT3P | 60 | | |
| DOUT3M | 61 | | |
| DOUT4P | 45 | O | JESD204B high-speed serial data output interface pins for channel B. |
| DOUT4M | 44 | | |
| DOUT5P | 48 | | |
| DOUT5M | 47 | | |
| DOUT6P | 50 | | |
| DOUT6M | 49 | | |
| DOUT7P | 53 | | |
| DOUT7M | 52 | | |
| POWER SUPPLY | | | |
| AVDD18 | 17,20,29,32, 58 | I | Analog 1.8-V power supply |
| AVDD12 | 13,16,21,33, 36 | I | Analog 1.2-V power supply |
| CLKVDD | 25 | I | Clock 1.2-V power supply. Very sensitive to power supply noise. Directly impacts close in aperture phase noise. |
| DVDD | 3,7,9,40,42, 46,54,59 | I | Digital 1.2-V power supply |
| AGND | 12,37 | I | Analog ground, shorted to thermal pad. |
| CLKGND | 22 | I | Clock ground. |
| DGND | 6,8,41,43,51,62 | I | Digital ground. |

(1) I = Input, O = Output, I/O = Input or Output.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| PARAMETER | TEST CONDITIONS | MIN | MAX | UNIT |
|--|--|------|--------------|------|
| Supply voltage range, AVDD18 | | -0.3 | 2.1 | V |
| Supply voltage range, AVDD12/CLKVDD/DVDD | | -0.3 | 1.4 | V |
| Voltage applied to input pins | INA1P/M, INB1P/M, INA2P/M, INB2P/M | -0.6 | 1.2 | V |
| | CLKP/M | -0.3 | VDDCLK + 0.3 | |
| | SYSREFP/M | -0.3 | AVDD12 + 0.6 | |
| | GPIO1/2, PDN, RESET, SCLK, SEN, SDIO, SPISEL | -0.3 | AVDD18 + 0.2 | |
| Peak RF input power (INx1P/M, INx2P/M) | Differential 100 Ω termination. | | 12 | dBm |
| Junction temperature, T _J | | | 125 | °C |
| Storage temperature, T _{stg} | | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|---|--------|------|
| V _(ESD) | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ± 1000 | V |
| | | Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾ | ± 500 | |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | NOM | MAX | UNIT |
|----------------|--------------------------------|--|-------|-----|--------------------|------|
| AVDD18 | 1.8 V analog supply | | 1.75 | 1.8 | 1.85 | V |
| AVDD12 | 1.2 V analog supply | | 1.175 | 1.2 | 1.225 | |
| CLKVDD | 1.2 V clock supply | | 1.175 | 1.2 | 1.225 | |
| DVDD | 1.2 V digital supply | | 1.175 | 1.2 | 1.225 | |
| T _A | Operating free-air temperature | | -40 | | 85 | °C |
| T _J | Operating junction temperature | | | | 105 ⁽¹⁾ | °C |

- (1) Prolonged use above this junction temperature may increase the device failure-in-time (FIT) rate.

6.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | ADC32RF5x | UNIT |
|-------------------------------|--|-----------|------|
| | | RTD (QFN) | |
| | | 64 Pins | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 20.1 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 6.8 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 5.2 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.1 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 5.1 | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | 0.5 | °C/W |

(1) For more information about thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, SPRA953.

6.5 Electrical Characteristics - Power Consumption

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------------|--------------------------------------|--|-----|------|------|------|
| FS = 3.0 GSPS | | | | | | |
| I _{AVDD18} | Supply current, 1.8 V analog supply | Bypass mode, 12-bit output, LMFS = 82820 | | 275 | | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 930 | | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 125 | | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 2050 | | |
| P _{DIS} | Power dissipation | | | 4.2 | | W |
| I _{AVDD18} | Supply current, 1.8 V analog supply | 2x averaging, LMFS = 82820 | | 370 | | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 1270 | | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 130 | | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 2440 | | |
| P _{DIS} | Power dissipation | | | 5.25 | | W |
| I _{AVDD18} | Supply current, 1.8 V analog supply | 4x averaging, LMFS = 82820 | | 560 | 620 | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 1920 | 2200 | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 150 | 190 | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 3020 | 4200 | |
| P _{DIS} | Power dissipation | | | 7.1 | | W |
| FS = 2.6 GSPS | | | | | | |
| I _{AVDD18} | Supply current, 1.8 V analog supply | Bypass mode, LMFS = 8224 | | 230 | | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 770 | | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 120 | | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 1550 | | |
| P _{DIS} | Power dissipation | | | 3.4 | | W |
| I _{AVDD18} | Supply current, 1.8 V analog supply | 2x averaging, LMFS = 8224 | | 320 | | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 1050 | | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 130 | | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 1700 | | |
| P _{DIS} | Power dissipation | | | 4.1 | | W |
| I _{AVDD18} | Supply current, 1.8 V analog supply | 4x averaging, LMFS = 8224 | | 490 | 600 | mA |
| I _{AVDD12} | Supply current, 1.2 V analog supply | | | 1600 | 1900 | |
| I _{CLKVDD} | Supply current, 1.2 V clock supply | | | 150 | 185 | |
| I _{DVDD} | Supply current, 1.2 V digital supply | | | 2100 | 3400 | |
| P _{DIS} | Power dissipation | | | 5.5 | | W |
| POWER DOWN MODES | | | | | | |
| P _{DIS} | Power down mode power consumption | | | 190 | | mW |

6.6 Electrical Characteristics - DC Specifications

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|---|-----------------|------------|------|------------------|
| DC ACCURACY | | | | | | |
| DNL | Differential nonlinearity | $F_{IN} = 10\text{ MHz}$ | | ± 0.85 | | LSB |
| INL | Integral nonlinearity | $F_{IN} = 10\text{ MHz}$ | | ± 3.5 | | LSB |
| V _{OS_ERR} | Offset error | | | ± 2 | | %FSR |
| GAIN _{ERR} | Gain error | | | ± 3 | | %FSR |
| GAIN _{Match} | Gain matching across channels | | | ± 0.2 | | dB |
| ADC ANALOG INPUTS (INA1P/M, INB1P/M, INA2P/M, INB2P/M) | | | | | | |
| FS | Input full scale | Differential, non-average mode | | 1.1 | | V _{pp} |
| | Input full scale | Differential, 2x or 4x average mode | | 1.35 | | |
| V _{ICM} | Input common mode voltage | | 250 | 350 | 450 | mV |
| Z _{IN} | Differential input impedance | Differential at 100 MHz | | 100 | | Ω |
| V _{OCM} | Output common mode voltage | | | 350 | | mV |
| BW | Analog Input Bandwidth (-3 dB) | 1x, 2x AVG, RSW=1 | | 2.75 | | GHz |
| | | 4x AVG, RSW=1 | | 2.1 | | |
| Phase imbalance, analog input | | | | ± 2 | | deg |
| Amplitude imbalance, analog input | | | | ± 0.5 | | dB |
| CMRR | Common mode rejection ratio | $F_{IN} = 100\text{ MHz}$ | | 25 | | dB |
| CLOCK INPUT (CLKP/M) | | | | | | |
| Input clock frequency | | ADC32RF54 | 500 | | 2600 | MHz |
| | | ADC32RF55 | 500 | | 3000 | MHz |
| V _{ID} | Differential input voltage | | | 1 | 2.4 | V _{pp} |
| V _{ICM} | Input common mode voltage | | 0.65 | 0.75 | 0.85 | V |
| Z _{IN} | Differential input impedance | Differential at 2.6 GHz | | 100 | | Ω |
| Clock duty cycle | | | 45 | 50 | 55 | % |
| SYSREF INPUT (SYSREFP/M) | | | | | | |
| V _{ID} | Differential input voltage | | 600 | 800 | 1000 | mV _{pp} |
| V _{ICM} | Input common mode voltage | Input common mode voltage | 1.05 | 1.2 | 1.4 | V |
| Z _{IN} | Differential input impedance | | | 100 | | Ω |
| DIGITAL INPUTS (RESET, PDN, SCLK, SEN, SDIO, GPIO1/2, SPISEL) | | | | | | |
| V _{IH} | High-level input voltage | | 0.8 | | | V |
| V _{IL} | Low-level input voltage | | | | 0.4 | V |
| C _I | Input capacitance | | | 0.6 | | pF |
| DIGITAL OUTPUT (SDIO) | | | | | | |
| V _{OH} | High-level output voltage | I _{LOAD} = $-400\text{ }\mu\text{A}$ | AVDD18 – 0.1 | AVDD18 | | V |
| V _{OL} | Low-level output voltage | I _{LOAD} = $400\text{ }\mu\text{A}$ | | | 0.1 | V |

6.6 Electrical Characteristics - DC Specifications (continued)

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V and –1-dBFS differential input, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|--|------|-----|-----|----------|
| CML SERDES OUTPUTS: DOUT[0:7]P/M | | | | | | |
| V_{OD} | Serdes transmitter output amplitude | differential peak-peak | | 700 | | mVpp |
| V_{OCM} | Serdes transmitter output common mode | | | 425 | | mV |
| Z_{TX} | Serdes transmitter single ended termination impedance | | | 50 | | Ω |
| | Transmitter short-circuit current | Transmitter pins shorted to any voltage between –0.25 V and 1.45 V | –100 | | 100 | mA |

6.7 Electrical Characteristics - ADC32RF54 AC Specifications (Dither DISABLED)

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, Bypass mode, No digital averaging, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and -1-dBFS differential input, Dither disabled, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | AIN = -1 dBFS | | | UNIT |
|-----------|--|--|--------------------|--------|-----|---------|
| | | | MIN ⁽¹⁾ | TYP | MAX | |
| NSD | Noise Spectral Density | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | -155.5 | | dBFS/Hz |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | -158.1 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | -160.9 | | |
| NF | Noise Figure | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | 20.4 | | dB |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | 19.5 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | 19.7 | | |
| SNR | Signal-to-noise ratio no (1x) averaging | $f_{IN} = 100\text{ MHz}$ | | 61.9 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 61.9 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 59.3 | 61.7 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | 62.0 | 64.4 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 60.6 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 60.0 | | |
| | Signal-to-noise ratio 2x averaging | $f_{IN} = 100\text{ MHz}$ | | 62.8 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 63.2 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 62.8 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | | 67.1 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 62.5 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 61.8 | | |
| | Signal-to-noise ratio 4x averaging | $f_{IN} = 100\text{ MHz}$ | | 65.5 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 65.9 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 65.6 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | | 69.8 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 65.4 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 64.9 | | |
| SINAD | Signal to noise and distortion ratio | $f_{IN} = 100\text{ MHz}$ | | 61.4 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 60.2 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 59.4 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 57.6 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 55.3 | | |
| ENOB | Effective number of bits | $f_{IN} = 100\text{ MHz}$ | | 9.9 | | Bits |
| | | $f_{IN} = 500\text{ MHz}$ | | 9.7 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 9.6 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 9.3 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 8.9 | | |

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, Bypass mode, No digital averaging, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and -1-dBFS differential input, Dither disabled, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | A _{IN} = -1 dBFS | | | UNIT |
|-----------|--|--|---------------------------|-----|-----|------|
| | | | MIN ⁽¹⁾ | TYP | MAX | |
| THD | Total Harmonic Distortion (First five harmonics) | f _{IN} = 100 MHz | | 67 | | dBc |
| | | f _{IN} = 500 MHz | | 63 | | |
| | | f _{IN} = 900 MHz | | 64 | | |
| | | f _{IN} = 1.8 GHz | | 60 | | |
| | | f _{IN} = 2.4 GHz | | 57 | | |
| HD2 | Second Harmonic Distortion | f _{IN} = 100 MHz | | 72 | | dBc |
| | | f _{IN} = 500 MHz | | 73 | | |
| | | f _{IN} = 900 MHz | 62 | 71 | | |
| | | f _{IN} = 1.8 GHz | | 62 | | |
| | | f _{IN} = 2.4 GHz | | 59 | | |
| HD3 | Third Harmonic Distortion | f _{IN} = 100 MHz | | 75 | | dBc |
| | | f _{IN} = 500 MHz | | 65 | | |
| | | f _{IN} = 900 MHz | 60 | 67 | | |
| | | f _{IN} = 1.8 GHz | | 66 | | |
| | | f _{IN} = 2.4 GHz | | 64 | | |
| Non HD2,3 | Spur free dynamic range (excluding HD2 and HD3) | f _{IN} = 100 MHz | | 76 | | dBFS |
| | | f _{IN} = 500 MHz | | 74 | | |
| | | f _{IN} = 900 MHz | | 77 | | |
| | | f _{IN} = 1.8 GHz | | 77 | | |
| | | f _{IN} = 2.4 GHz | | 74 | | |
| IMD3 | Two tone inter-modulation distortion | f ₁ = 700 MHz, f ₂ = 800 MHz, A _{IN} = -7 dBFS/tone | | 71 | | dBc |

(1) The minimum SNR values are specified by ATE, the HD2,3 by bench characterization

6.8 Electrical Characteristics - ADC32RF54 AC Specifications (Dither ENABLED)

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, Bypass mode, No digital averaging, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and -4-dBFS differential input, Dither enabled, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | AIN = -4 dBFS | | | UNIT |
|----------------------|---------------------------------------|--|--------------------|--------|-----|---------|
| | | | MIN ⁽²⁾ | TYP | MAX | |
| NSD | Noise Spectral Density | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | -155.1 | | dBFS/Hz |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | -157.6 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | -160.3 | | |
| NF | Noise Figure | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | 20.8 | | dB |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | 20.0 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | 19.9 | | |
| SNR ⁽¹⁾ | Signal-to-noise ratio no averaging | $f_{IN} = 100\text{ MHz}$ | | 62.4 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 62.2 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 62.7 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | | 64.5 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 62.0 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 61.5 | | |
| | Signal-to-noise ratio 2x averaging | $f_{IN} = 100\text{ MHz}$ | | 64.1 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 64.3 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 64.2 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | | 66.9 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 63.9 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 63.3 | | |
| | Signal-to-noise ratio 4x averaging | $f_{IN} = 100\text{ MHz}$ | | 67.2 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 67.7 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 64.5 | 67.3 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ | 67.4 | 69.6 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 67.0 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 66.8 | | |
| SINAD ⁽¹⁾ | Signal to noise and distortion ratio | $f_{IN} = 100\text{ MHz}$ | | 62.1 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 61.9 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 62.2 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 60.5 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 59.3 | | |
| ENOB ⁽¹⁾ | Effective number of bits | $f_{IN} = 100\text{ MHz}$ | | 10.0 | | Bits |
| | | $f_{IN} = 500\text{ MHz}$ | | 10.0 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 10.0 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 9.8 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 9.6 | | |

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, Bypass mode, No digital averaging, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and -4-dBFS differential input, Dither enabled, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | AIN = -4 dBFS | | | UNIT |
|--------------------------|--|---|--------------------|-----|-----|------|
| | | | MIN ⁽²⁾ | TYP | MAX | |
| THD ⁽¹⁾ | Total Harmonic Distortion (First five harmonics) | $f_{IN} = 100\text{ MHz}$ | | 71 | | dBc |
| | | $f_{IN} = 500\text{ MHz}$ | | 70 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 68 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 63 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 61 | | |
| HD2 ⁽¹⁾ | Second Harmonic Distortion | $f_{IN} = 100\text{ MHz}$ | | 74 | | dBc |
| | | $f_{IN} = 500\text{ MHz}$ | | 76 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 61 | 74 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 65 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 62 | | |
| HD3 ⁽¹⁾ | Third Harmonic Distortion | $f_{IN} = 100\text{ MHz}$ | | 76 | | dBc |
| | | $f_{IN} = 500\text{ MHz}$ | | 72 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 63 | 76 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 72 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 72 | | |
| Non HD2,3 ⁽¹⁾ | Spur free dynamic range (excluding HD2 and HD3) | $f_{IN} = 100\text{ MHz}$ | | 88 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 89 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 78 | 89 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 79 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 87 | | |
| IMD3 | Two tone inter-modulation distortion | $f_1 = 700\text{ MHz}, f_2 = 800\text{ MHz}, A_{IN} = -10\text{ dBFS/tone}$ | | 71 | | dBc |

- (1) Measured from 100 MHz to $F_S/2$ (ignoring DC to 100 MHz which contains the dither signal)
(2) SNR, HD3 minimum values are specified by ATE, HD2 and Non HD23 are specified by bench characterization.

6.9 Electrical Characteristics - ADC32RF55 AC Specifications (Dither DISABLED)

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V, -1-dBFS differential input and dither DISABLED, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|---|--|-----|--------|-----|---------|
| NSD | Noise Spectral Density | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | -155.6 | | dBFS/Hz |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | -158.1 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | -160.4 | | |
| NF | Noise Figure | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | 20.2 | | dB |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | 19.8 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | 20.2 | | |
| SNR | Signal-to-noise ratio no averaging | $f_{IN} = 100\text{ MHz}$ | | 62.1 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 61.8 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 61.7 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | | 63.8 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 61.1 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 60.2 | | |
| | Signal-to-noise ratio 2x averaging | $f_{IN} = 100\text{ MHz}$ | | 63.6 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 63.3 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 63.5 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | | 66.3 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 62.7 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 62.4 | | |
| | Signal-to-noise ratio 4x averaging | $f_{IN} = 100\text{ MHz}$ | | 66.7 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 65.0 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 65.7 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | | 68.6 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 64.7 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 64.5 | | |
| SINAD | Signal to noise and distortion ratio | $f_{IN} = 100\text{ MHz}$ | | 58.2 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 57.9 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 55.8 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 58.2 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 54.8 | | |
| ENOB | Effective number of bits | $f_{IN} = 100\text{ MHz}$ | | 10.0 | | Bits |
| | | $f_{IN} = 500\text{ MHz}$ | | 10.0 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 10.0 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 9.9 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 9.7 | | |
| THD | Total Harmonic Distortion (First five harmonics) | $f_{IN} = 100\text{ MHz}$ | | 61 | | dBc |
| | | $f_{IN} = 500\text{ MHz}$ | | 60 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 57 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 63 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 57 | | |

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V, -1-dBFS differential input and dither DISABLED, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|---|--|-----|-----|-----|------|
| HD2 | Second Harmonic Distortion | $f_{IN} = 100 \text{ MHz}$ | | 61 | | dBc |
| | | $f_{IN} = 500 \text{ MHz}$ | | 66 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | | 68 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 66 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 57 | | |
| HD3 | Third Harmonic Distortion | $f_{IN} = 100 \text{ MHz}$ | | 66 | | dBc |
| | | $f_{IN} = 500 \text{ MHz}$ | | 62 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | | 57 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 65 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 64 | | |
| Non HD2,3 | Spur free dynamic range (excluding HD2 and HD3) | $f_{IN} = 100 \text{ MHz}$ | | 78 | | dBFS |
| | | $f_{IN} = 500 \text{ MHz}$ | | 75 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | | 78 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 76 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 75 | | |
| IMD3 | Two tone inter-modulation distortion | $f_1 = 700 \text{ MHz}, f_2 = 800 \text{ MHz}, A_{IN} = -7 \text{ dBFS/ tone}$ | | 72 | | dBFS |
| | | $f_1 = 1.5 \text{ GHz}, f_2 = 1.6 \text{ GHz}, A_{IN} = -7 \text{ dBFS/ tone}$ | | 66 | | |

6.10 Electrical Characteristics - ADC32RF55 AC Specifications (Dither ENABLED)

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V, -4-dBFS differential input and dither ENABLED, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN ⁽²⁾ | TYP | MAX | UNIT |
|----------------------|---|--|--------------------|--------|-----|---------|
| NSD ⁽¹⁾ | Noise Spectral Density | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | -153.5 | -155.1 | | dBFS/Hz |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | -157.3 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | -158.5 | -159.8 | | |
| NF ⁽¹⁾ | Noise Figure | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ no averaging | | 20.7 | | dB |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 2x averaging | | 20.6 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{IN} = -20\text{ dBFS}$ 4x averaging | | 20.8 | | |
| SNR ⁽¹⁾ | Signal-to-noise ratio no averaging | $f_{IN} = 100\text{ MHz}$ | | 61.7 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 61.8 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 58.9 | 60.9 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | 62.0 | 63.3 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 61.4 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 61.2 | | |
| | Signal-to-noise ratio 2x averaging | $f_{IN} = 100\text{ MHz}$ | | 63.1 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 63.4 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 62.3 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | | 65.5 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 63.0 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 63.1 | | |
| | Signal-to-noise ratio 4x averaging | $f_{IN} = 100\text{ MHz}$ | | 66.7 | | |
| | | $f_{IN} = 500\text{ MHz}$ | | 66.2 | | |
| | | $f_{IN} = 900\text{ MHz}$ | 64.9 | 66.1 | | |
| | | $f_{IN} = 900\text{ MHz}$, $A_{in} = -20\text{ dBFS}$ | 67.1 | 68.0 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 65.5 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 65.4 | | |
| SINAD ⁽¹⁾ | Signal to noise and distortion ratio | $f_{IN} = 100\text{ MHz}$ | | 60.5 | | dBFS |
| | | $f_{IN} = 500\text{ MHz}$ | | 60.8 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 59.5 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 60.3 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 58.6 | | |
| ENOB ⁽¹⁾ | Effective number of bits | $f_{IN} = 100\text{ MHz}$ | | 10.0 | | Bits |
| | | $f_{IN} = 500\text{ MHz}$ | | 10.0 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 9.8 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 9.9 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 9.7 | | |
| THD ⁽¹⁾ | Total Harmonic Distortion (First five harmonics) | $f_{IN} = 100\text{ MHz}$ | | 67 | | dBc |
| | | $f_{IN} = 500\text{ MHz}$ | | 68 | | |
| | | $f_{IN} = 900\text{ MHz}$ | | 65 | | |
| | | $f_{IN} = 1.8\text{ GHz}$ | | 69 | | |
| | | $f_{IN} = 2.4\text{ GHz}$ | | 64 | | |

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, AVDDCLK, DVDD = 1.2 V, -4-dBFS differential input and dither ENABLED, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN ⁽²⁾ | TYP | MAX | UNIT |
|--------------------------|---|---|--------------------|-----|-----|------|
| HD2 ⁽¹⁾ | Second Harmonic Distortion | $f_{IN} = 100 \text{ MHz}$ | | 64 | | dBc |
| | | $f_{IN} = 500 \text{ MHz}$ | | 69 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | 61 | 68 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 68 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 60 | | |
| HD3 ⁽¹⁾ | Third Harmonic Distortion | $f_{IN} = 100 \text{ MHz}$ | | 71 | | dBc |
| | | $f_{IN} = 500 \text{ MHz}$ | | 67 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | 60 | 63 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 68 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 72 | | |
| Non HD2,3 ⁽¹⁾ | Spur free dynamic range (excluding HD2 and HD3) | $f_{IN} = 100 \text{ MHz}$ | | 91 | | dBFS |
| | | $f_{IN} = 500 \text{ MHz}$ | | 89 | | |
| | | $f_{IN} = 900 \text{ MHz}$ | 78 | 85 | | |
| | | $f_{IN} = 1.8 \text{ GHz}$ | | 86 | | |
| | | $f_{IN} = 2.4 \text{ GHz}$ | | 86 | | |
| IMD3 | Two tone inter-modulation distortion | $f_1 = 700 \text{ MHz}, f_2 = 800 \text{ MHz}, A_{IN} = -10 \text{ dBFS/ tone}$ | 73 | 80 | | dBFS |
| | | $f_1 = 1.5 \text{ GHz}, f_2 = 1.6 \text{ GHz}, A_{IN} = -10 \text{ dBFS/ tone}$ | | 75 | | |

(1) Measured from 100 MHz to Nyquist ($F_S/2$) excluding dither

(2) SNR, IMD3 minimum values are specified by ATE, HD2, HD3 and Non HD23 are specified by bench characterization.

6.11 Timing Requirements

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and –1-dBFS differential input, unless otherwise noted

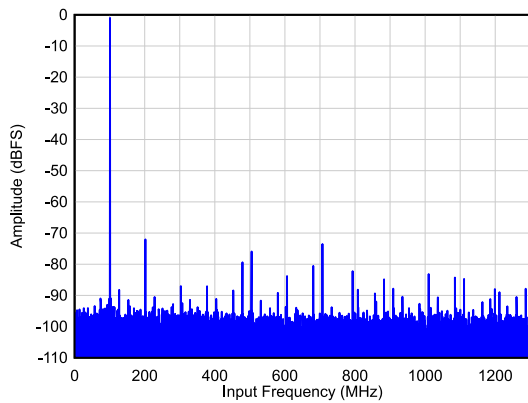
| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|----------------------------------|---|---|------|------|------|--------------|--------------|
| ADC TIMING SPECIFICATIONS | | | | | | | |
| T_{AD} | Aperture Delay | | | 0.17 | | ns | |
| | Aperture Delay variation | | | 0.07 | | ns | |
| T_A | Aperture Jitter | | | 50 | | fs | |
| Overload recovery time | | 3-dB overload condition | | 10 | | clock cycles | |
| | | 6-dB overload condition | | 50 | | | |
| t_{ADC} | ADC latency from sampling instant to internal hand-off to digital | | | 68 | | clock cycles | |
| | Internal propagation delay | | | 5 | | ns | |
| | Latency adder for 2x or 4x averaging | | | 4 | | clock cycles | |
| | Deterministic delay from digital block (DDC (if used) and JESD interface) | LMFS = 8-2-8-20 | | | 260 | | clock cycles |
| | | LMFS = 8-2-2-4 | | | 280 | | |
| | | 4x complex decimation, LMFS = 8-4-2-2 | | | 456 | | |
| | | 4x real decimation, LMFS = 4-2-2-2 | | | 456 | | |
| | | 4x decimation, F (number of octets) = 2 | | | 394 | | |
| | | 4x decimation, F = 4 | | | 374 | | |
| | | 4x decimation, F = 8 | | | 367 | | |
| | | 8x decimation, F = 2 | | | 560 | | |
| | | 8x decimation, F = 4 | | | 520 | | |
| | | 8x decimation, F = 8 | | | 506 | | |
| | | 8x decimation, F = 16 | | | 491 | | |
| | | 16x decimation, F = 2 | | | 900 | | |
| | | 16x decimation, F = 4 | | | 820 | | |
| | | 16x decimation, F = 8 | | | 792 | | |
| | | 16x decimation, F = 16 | | | 762 | | |
| | | 16x decimation, F = 32 | | | 748 | | |
| | | 32x decimation, F = 2 | | | 1596 | | |
| | | 32x decimation, F = 4 | | | 1436 | | |
| | | 32x decimation, F = 8 | | | 1380 | | |
| | | 32x decimation, F = 16 | | | 1320 | | |
| | | 32x decimation, F = 32 | | | 1292 | | |
| | | 64x decimation, F = 2 | | | 2940 | | |
| | | 64x decimation, F = 4 | | | 2620 | | |
| | | 64x decimation, F = 8 | | | 2508 | | |
| 64x decimation, F = 16 | | | | 2388 | | | |
| 64x decimation, F = 32 | | | 2332 | | | | |
| 128x decimation, F = 2 | | | 5668 | | | | |
| 128x decimation, F = 4 | | | 5028 | | | | |
| 128x decimation, F = 8 | | | 4804 | | | | |
| 128x decimation, F = 16 | | | 4564 | | | | |
| 128x decimation, F = 32 | | | 4452 | | | | |

Maximum and minimum values are specified over the operating free-air temperature range and nominal supply voltages. Typical values are specified at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3.0 GSPS, Bypass mode, 50% clock duty cycle, AVDD18 = 1.8V, AVDD12, AVDDCLK, DVDD = 1.2V and –1-dBFS differential input, unless otherwise noted

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|-----------------|------|------|------|------|
| SERIAL PROGRAMMING INTERFACE (SCLK, SEN, SDIO) - Input | | | | | | |
| $f_{\text{CLK(SCLK)}}$ | Serial clock frequency | | 1 | | 20 | MHz |
| $t_{\text{SU(SEN)}}$ | SEN to rising edge of SCLK | | 10 | | | ns |
| $t_{\text{H(SEN)}}$ | SEN from rising edge of SCLK | | 10 | | | ns |
| $t_{\text{SU(SDIO)}}$ | SDIO to rising edge of SCLK | | 10 | | | ns |
| $t_{\text{H(SDIO)}}$ | SDIO from rising edge of SCLK | | 10 | | | ns |
| SERIAL PROGRAMMING INTERFACE (SDIO) - Output | | | | | | |
| $t_{\text{(OZD)}}$ | SDIO tri-state to driven | | | | 10 | ns |
| $t_{\text{(ODZ)}}$ | SDIO data to tri-state | | | | 14 | ns |
| $t_{\text{(OD)}}$ | SDIO valid from falling edge of SCLK | | | | 10 | ns |
| TIMING: SYSREFP/M | | | | | | |
| $t_{\text{s(SYSREF)}}$ | Setup time, SYSREFP/M valid to rising edge of CLKP/M | | 50 | | | ps |
| $t_{\text{h(SYSREF)}}$ | Hold time, SYSREFP/M valid to rising edge of CLKP/M | | 50 | | | ps |
| CML SERDES OUTPUTS: DA[0:3]P/M, DB[0:3]P/M | | | | | | |
| f_{Serdes} | Serdes bit rate | | 0.5 | 12.8 | 13.0 | Gbps |
| R_J | Random jitter, RMS | RPAT, 6.4 Gbps | 0.7 | | | ps |
| | | RPAT, 12.8 Gbps | 0.6 | | | |
| D_J | Deterministic jitter, peak to peak | RPAT, 6.4 Gbps | 8.9 | | | ps |
| | | RPAT, 12.8 Gbps | 14.7 | | | |
| T_J | Total jitter, peak to peak | RPAT, 6.4 Gbps | 19.5 | | | ps |
| | | RPAT, 12.8 Gbps | 24 | | | |

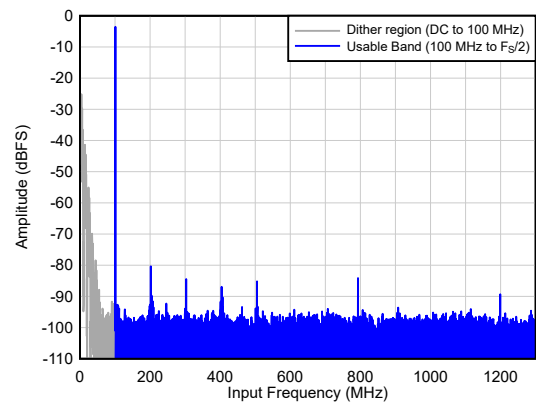
6.12 Typical Characteristics - ADC32RF54

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



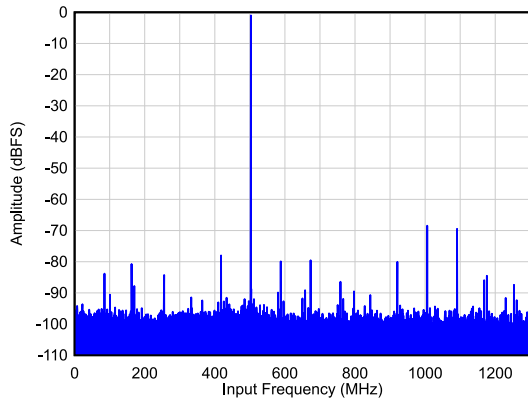
SNR = 62.1 dBFS, SFDR = 71 dBc, Non HD23 = 76 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-1. Single Tone FFT at $F_{IN} = 100$ MHz



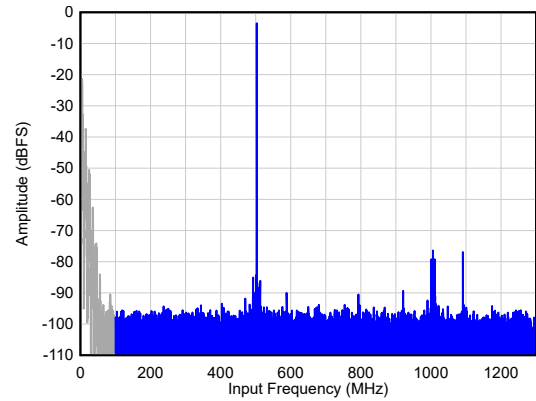
SNR = 63.2 dBFS¹, SFDR = 77 dBc, Non HD23 = 87 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-2. Single Tone FFT at $F_{IN} = 100$ MHz



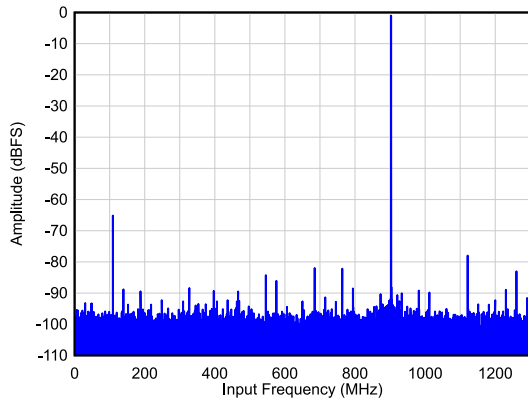
SNR = 62.1 dBFS, SFDR = 64 dBc, Non HD23 = 78 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-3. Single Tone FFT at $F_{IN} = 500$ MHz



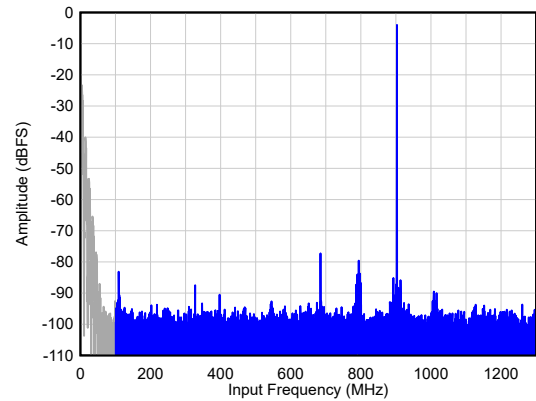
SNR = 62.4 dBFS¹, SFDR = 73 dBc, Non HD23 = 90 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-4. Single Tone FFT at $F_{IN} = 500$ MHz



SNR = 61.8 dBFS, SFDR = 64 dBc, Non HD23 = 81 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-5. Single Tone FFT at $F_{IN} = 900$ MHz



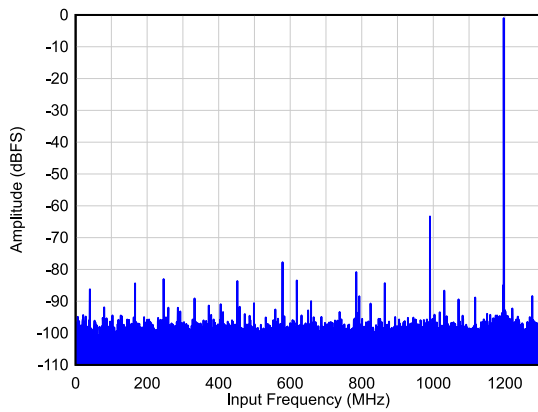
SNR = 63.1 dBFS¹, SFDR = 76 dBc, Non HD23 = 85 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-6. Single Tone FFT at $F_{IN} = 900$ MHz

¹ Measured from 100 MHz to $F_S/2$

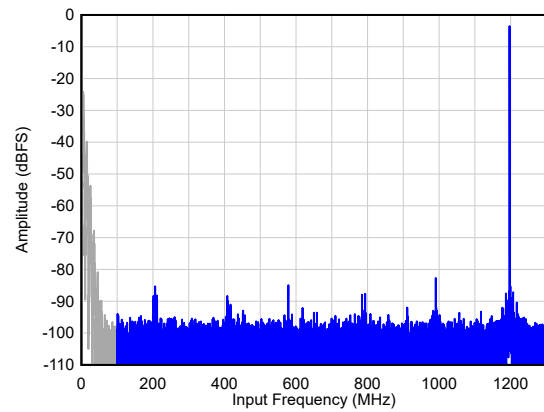
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



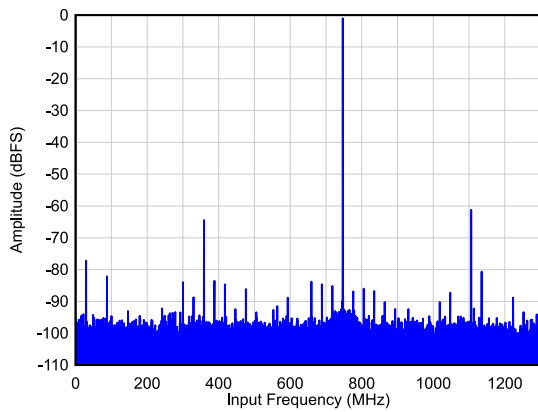
SNR = 61.0 dBFS, SFDR = 62 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-7. Single Tone FFT at $F_{IN} = 1400$ MHz



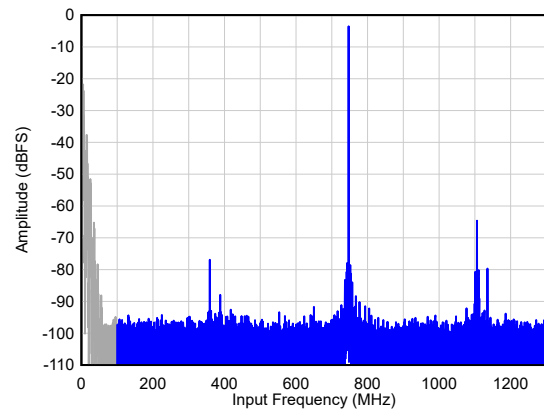
SNR = 62.5 dBFS¹, SFDR = 79 dBc, Non HD23 = 88 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-8. Single Tone FFT at $F_{IN} = 1400$ MHz



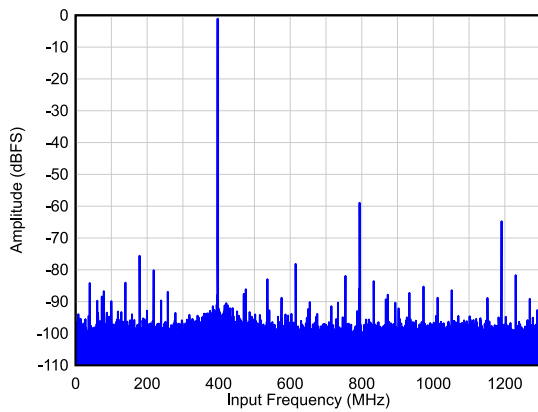
SNR = 60.9 dBFS, SFDR = 60 dBc, Non HD23 = 77 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-9. Single Tone FFT at $F_{IN} = 1900$ MHz



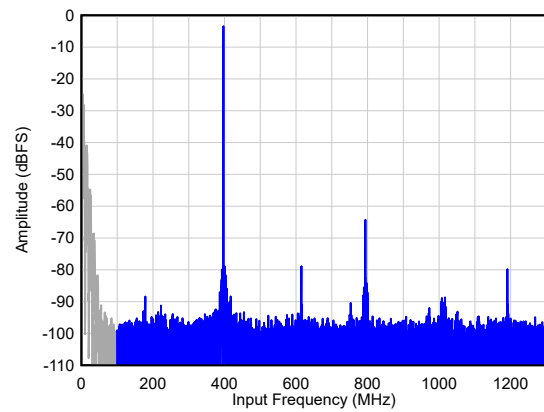
SNR = 62.3 dBFS¹, SFDR = 61 dBc, Non HD23 = 79 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-10. Single Tone FFT at $F_{IN} = 1900$ MHz



SNR = 60.2 dBFS, SFDR = 58 dBc, Non HD23 = 76 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-11. Single Tone FFT at $F_{IN} = 2200$ MHz

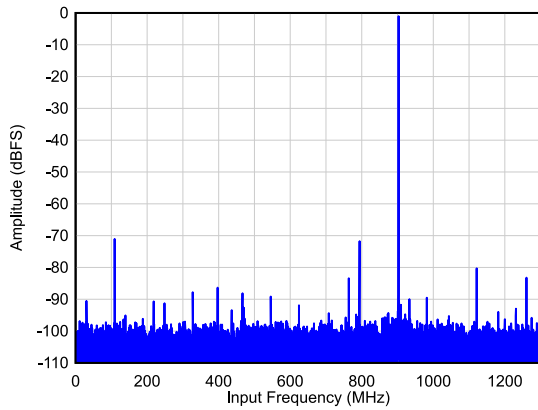


SNR = 62.6 dBFS¹, SFDR = 61 dBc, Non HD23 = 79 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-12. Single Tone FFT at $F_{IN} = 2200$ MHz

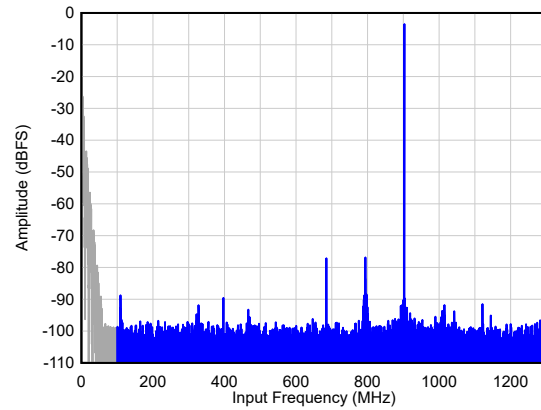
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



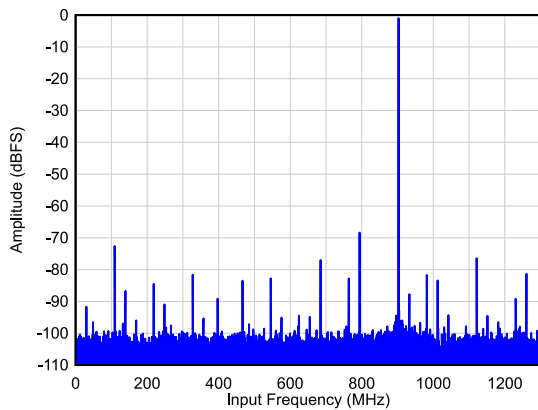
SNR = 62.8 dBFS, SFDR = 70 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -1$ dBFS, 2x AVG, Dither = DIS

Figure 6-13. Single Tone FFT at $F_{IN} = 900$ MHz



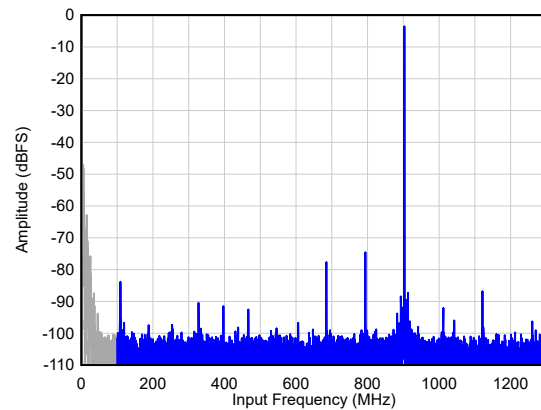
SNR = 65.4 dBFS¹, SFDR = 73 dBc, Non HD23 = 78 dBFS
 $A_{IN} = -4$ dBFS, 2x AVG, Dither = EN

Figure 6-14. Single Tone FFT at $F_{IN} = 900$ MHz



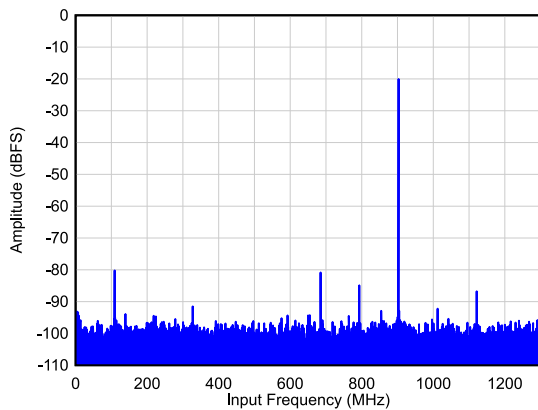
SNR = 65.6 dBFS, SFDR = 67 dBc, Non HD23 = 73 dBFS
 $A_{IN} = -1$ dBFS, 4x AVG, Dither = DIS

Figure 6-15. Single Tone FFT at $F_{IN} = 900$ MHz



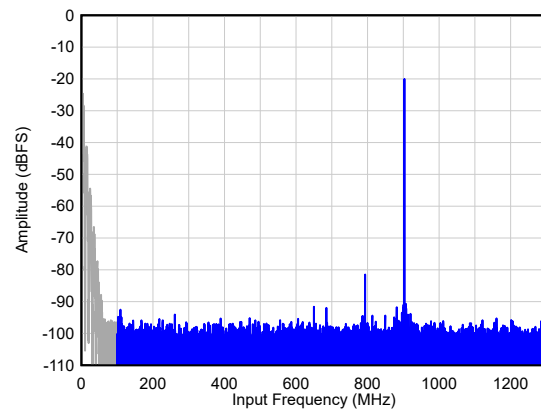
SNR = 67.8 dBFS¹, SFDR = 71 dBc, Non HD23 = 76 dBFS
 $A_{IN} = -4$ dBFS, 4x AVG, Dither = EN

Figure 6-16. Single Tone FFT at $F_{IN} = 900$ MHz



SNR = 64.4 dBFS, SFDR = 60 dBc, Non HD23 = 81 dBFS
 $A_{IN} = -20$ dBFS, 1x AVG, Dither = DIS

Figure 6-17. Single Tone FFT at $F_{IN} = 900$ MHz

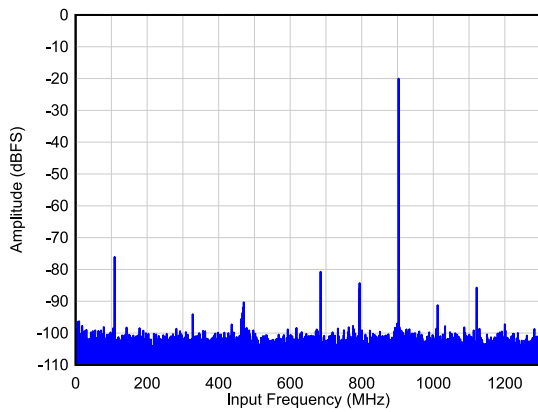


SNR = 64.6 dBFS¹, SFDR = 73 dBc, Non HD23 = 92 dBFS
 $A_{IN} = -20$ dBFS, 1x AVG, Dither = EN

Figure 6-18. Single Tone FFT at $F_{IN} = 900$ MHz

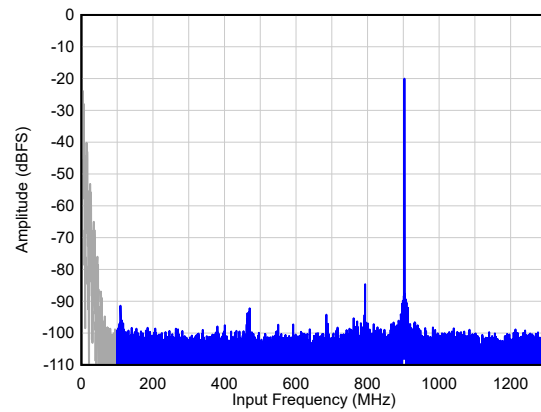
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



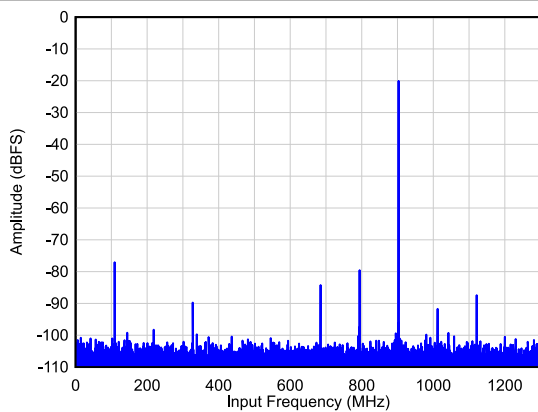
SNR = 67.1 dBFS, SFDR = 56 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -20$ dBFS, 2x AVG, Dither = DIS

Figure 6-19. Single Tone FFT at $F_{IN} = 900$ MHz



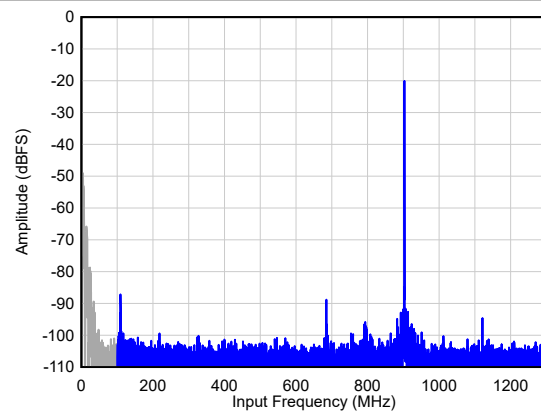
SNR = 66.8 dBFS¹, SFDR = 65 dBc, Non HD23 = 93 dBFS
 $A_{IN} = -20$ dBFS, 2x AVG, Dither = EN

Figure 6-20. Single Tone FFT at $F_{IN} = 900$ MHz



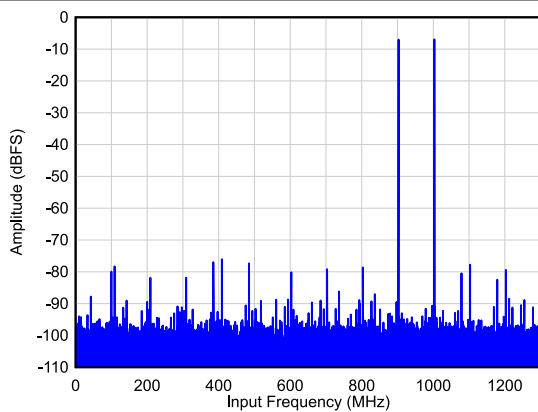
SNR = 70.0 dBFS, SFDR = 58 dBc, Non HD23 = 85 dBFS
 $A_{IN} = -20$ dBFS, 4x AVG, Dither = DIS

Figure 6-21. Single Tone FFT at $F_{IN} = 900$ MHz



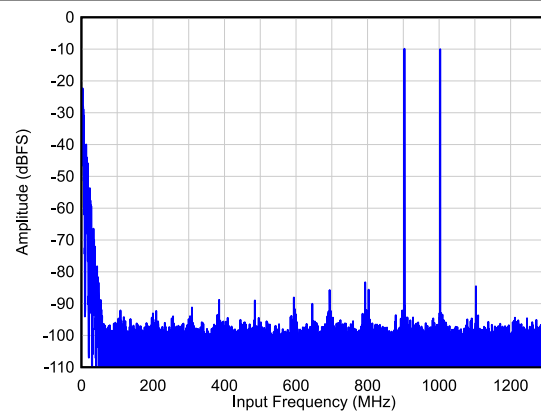
SNR = 69.5 dBFS¹, SFDR = 67 dBc, Non HD23 = 88 dBFS
 $A_{IN} = -20$ dBFS, 4x AVG, Dither = EN

Figure 6-22. Single Tone FFT at $F_{IN} = 900$ MHz



IMD3 = 72 dBc
 $A_{IN} = -7$ dBFS/tone, 1x AVG, Dither = DIS

Figure 6-23. Two Tone FFT at $F_{IN} = 900/1000$ MHz

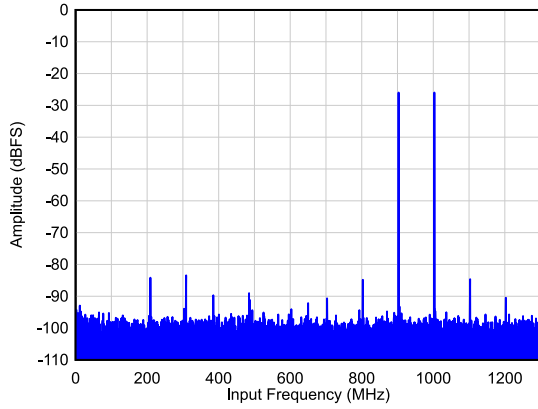


IMD3 = 74 dBc
 $A_{IN} = -10$ dBFS/tone, 1x AVG, Dither = EN

Figure 6-24. Two Tone FFT at $F_{IN} = 900/1000$ MHz

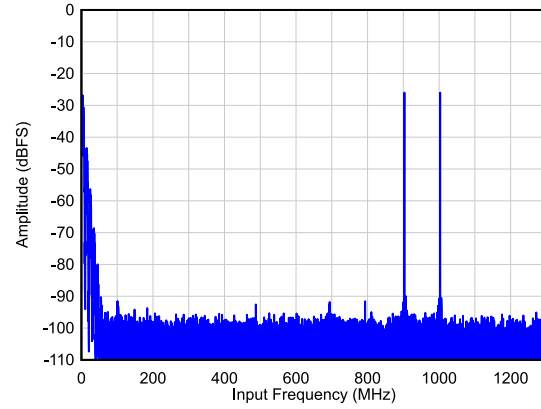
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



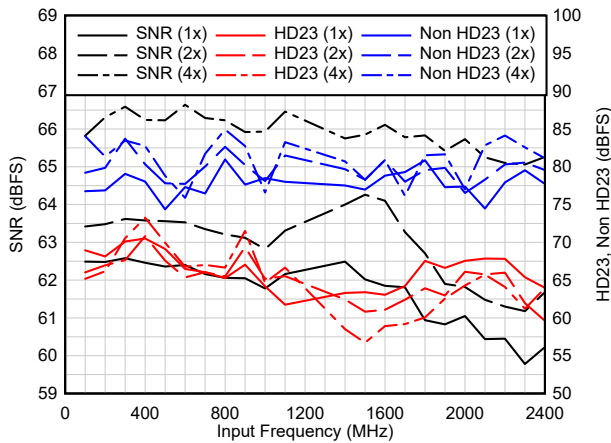
IMD3 = 60 dBc
 $A_{IN} = -26$ dBFS/tone, 1x AVG, Dither = DIS

Figure 6-25. Two Tone FFT at $F_{IN} = 900/1000$ MHz



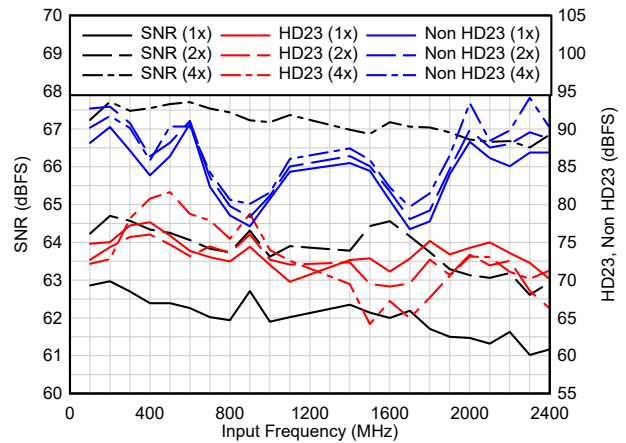
IMD3 = 72 dBc
 $A_{IN} = -26$ dBFS/tone, 1x AVG, Dither = EN

Figure 6-26. Two Tone FFT at $F_{IN} = 900/1000$ MHz



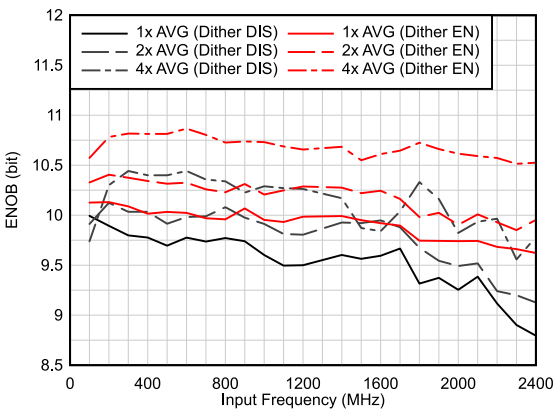
$A_{IN} = -1$ dBFS, Dither = DIS

Figure 6-27. AC Performance vs F_{IN}



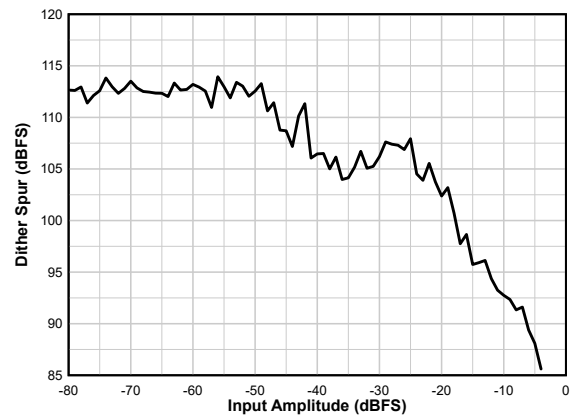
$A_{IN} = -4$ dBFS, Dither = EN

Figure 6-28. AC Performance vs F_{IN}



$A_{IN} = -1$ dBFS (Dither = DIS)
 $A_{IN} = -4$ dBFS (Dither = EN)

Figure 6-29. ENOB Performance vs F_{IN}



$F_{IN} = 900$ MHz,

Figure 6-30. Dither Spur vs A_{IN}

6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

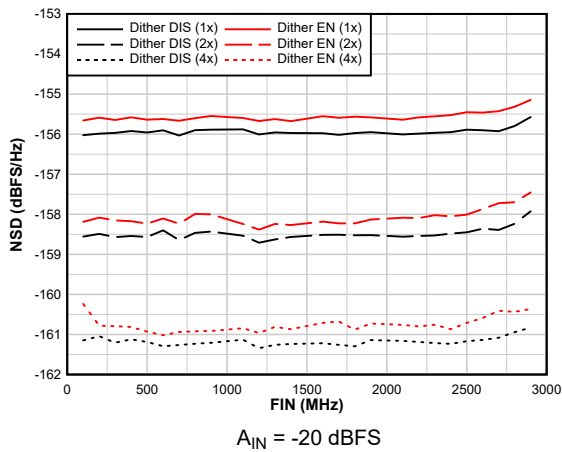


Figure 6-31. NSD Performance vs F_{IN}

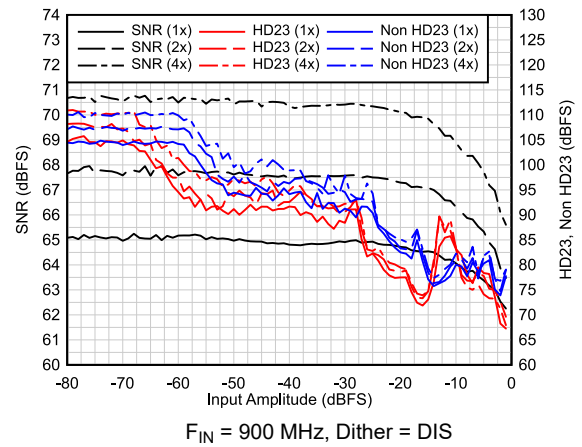


Figure 6-32. AC Performance vs A_{IN}

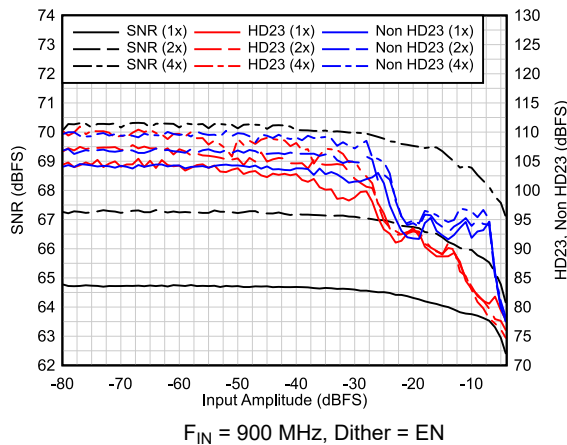


Figure 6-33. AC Performance vs A_{IN}

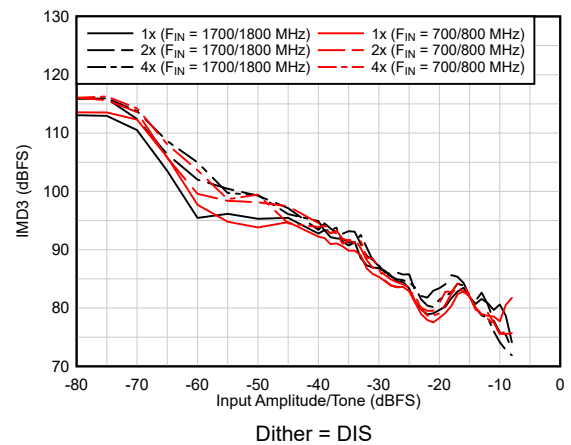


Figure 6-34. IMD3 Performance vs A_{IN}

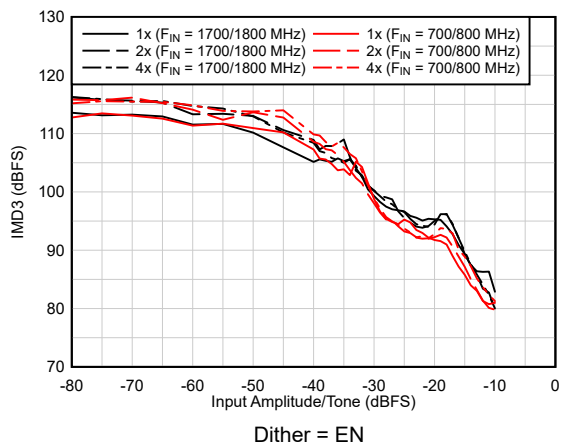


Figure 6-35. IMD3 Performance vs A_{IN}

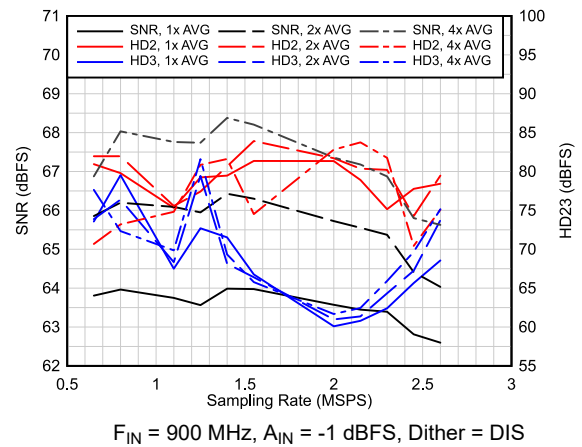
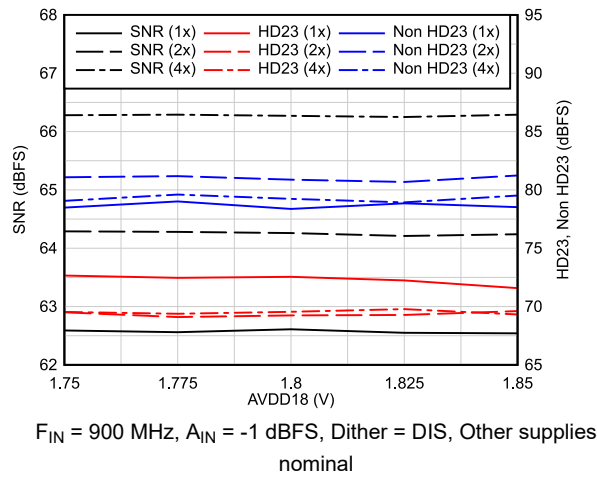
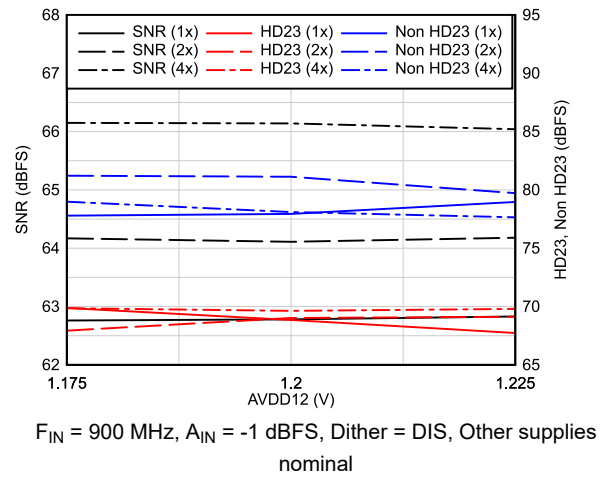
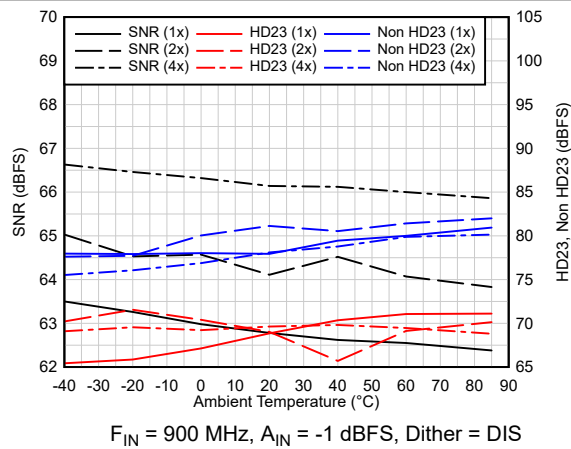
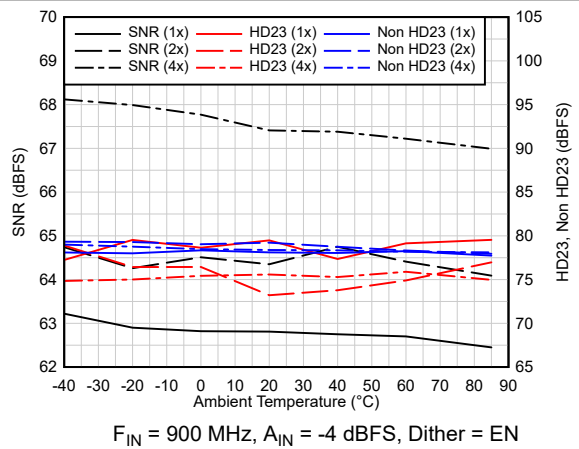
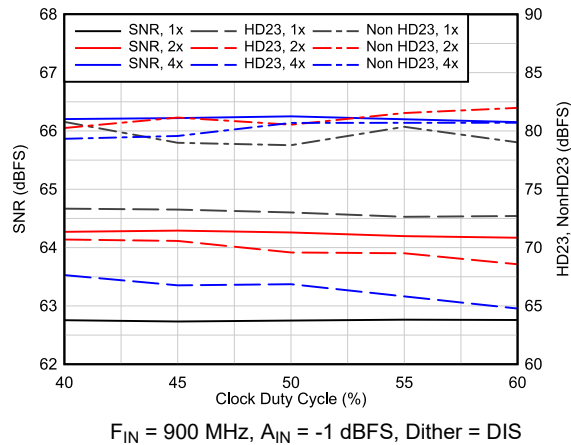
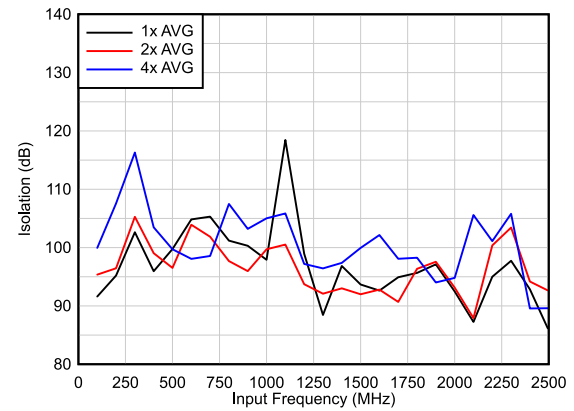


Figure 6-36. AC Performance vs F_S

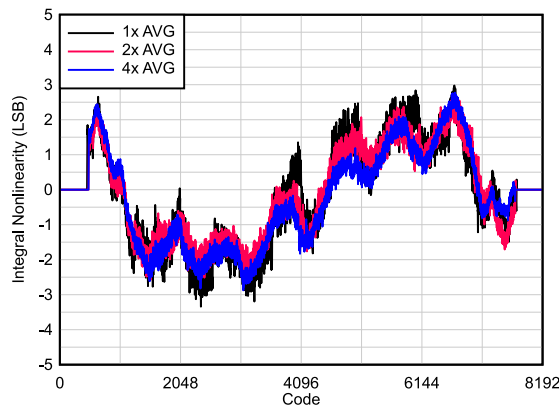
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted


Figure 6-37. AC Performance vs AVDD18

Figure 6-38. AC Performance vs AVDD12

Figure 6-39. AC Performance vs Temperature

Figure 6-40. AC Performance vs Temperature

Figure 6-41. AC Performance vs Clock Duty Cycle

Figure 6-42. Isolation vs Input Frequency

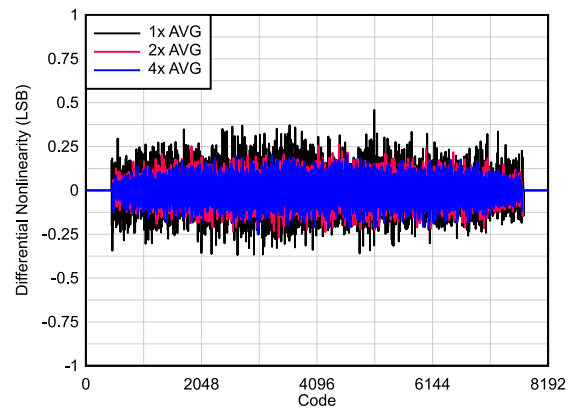
6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



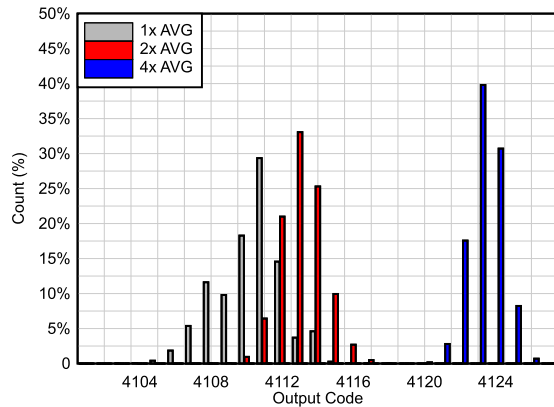
$F_{IN} = 900\text{ MHz}$, Dither = DIS

Figure 6-43. INL vs Code



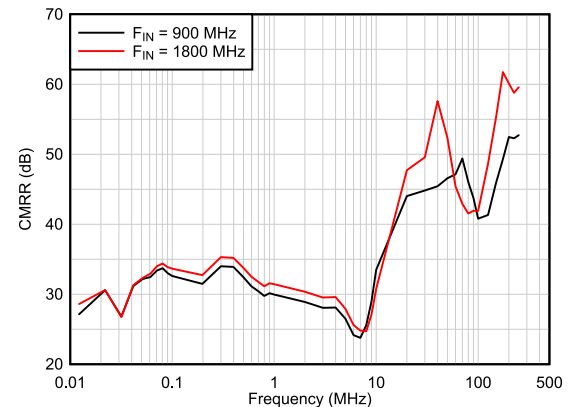
$F_{IN} = 900\text{ MHz}$, Dither = DIS

Figure 6-44. DNL vs Code



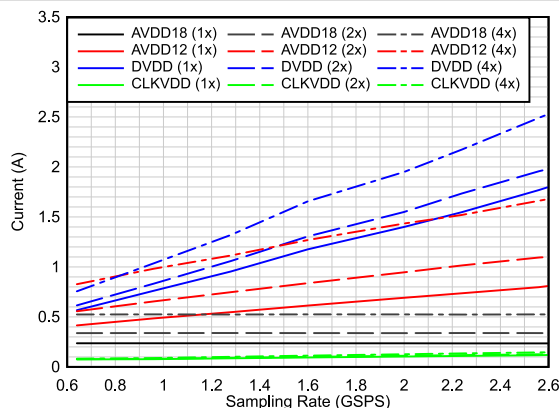
Dither = DIS

Figure 6-45. DC Offset Histogram



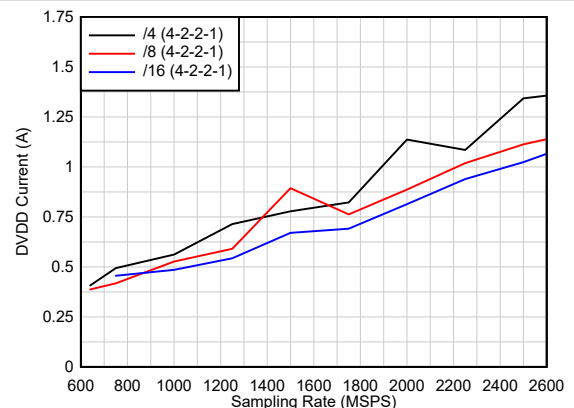
$A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-46. CMRR



$A_{IN} = -1\text{ dBFS}$, Dither = DIS, DDC Bypass

Figure 6-47. Current vs Sampling Rate vs Averaging



$A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Real Decimation

Figure 6-48. Current vs Sampling Rate vs Decimation

6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

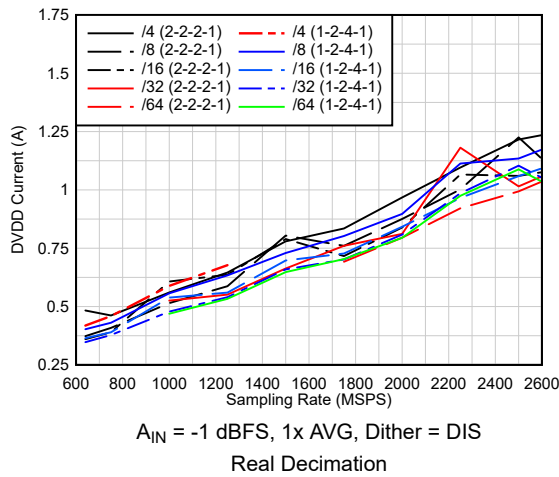


Figure 6-49. Current vs Sampling Rate vs Decimation

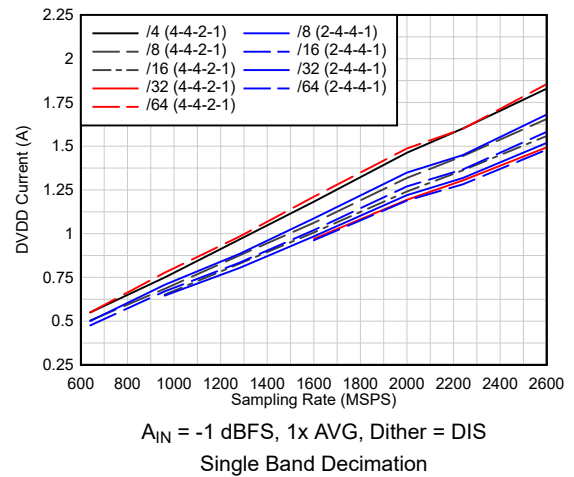


Figure 6-50. Current vs Sampling Rate vs Decimation

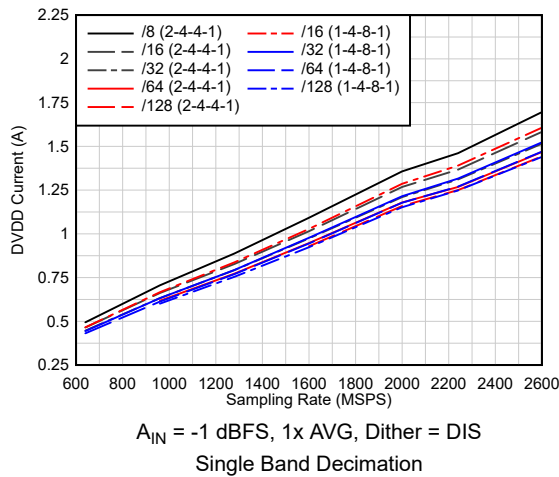


Figure 6-51. Current vs Sampling Rate vs Decimation

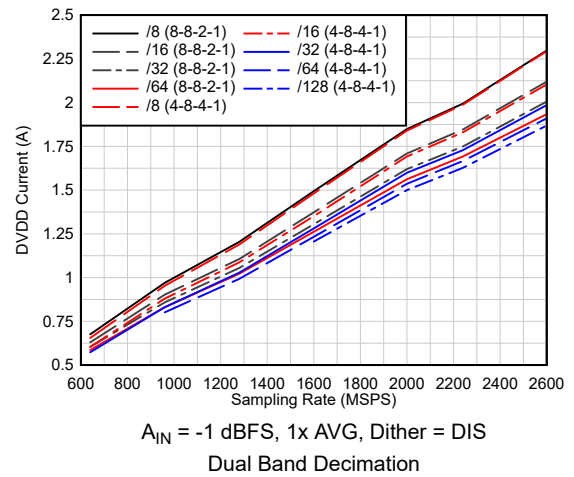


Figure 6-52. Current vs Sampling Rate vs Decimation

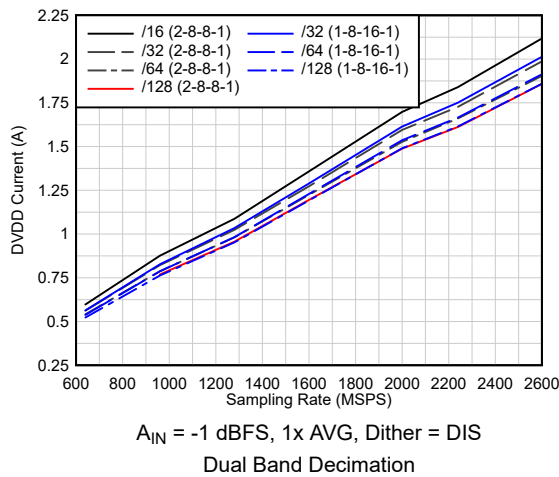


Figure 6-53. Current vs Sampling Rate vs Decimation

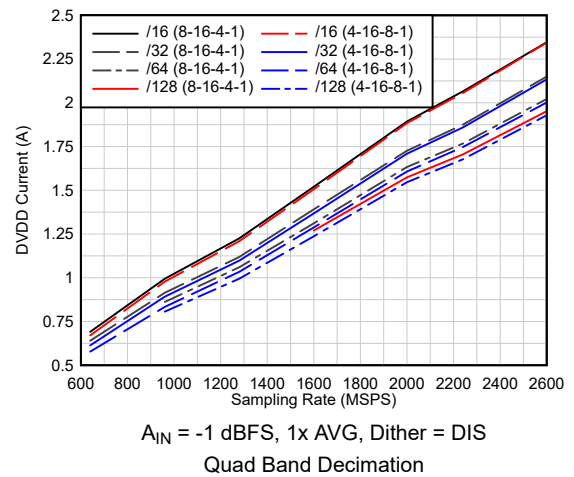


Figure 6-54. Current vs Sampling Rate vs Decimation

6.12 Typical Characteristics - ADC32RF54 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 2.6 GSPS, LMFS = 8224, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

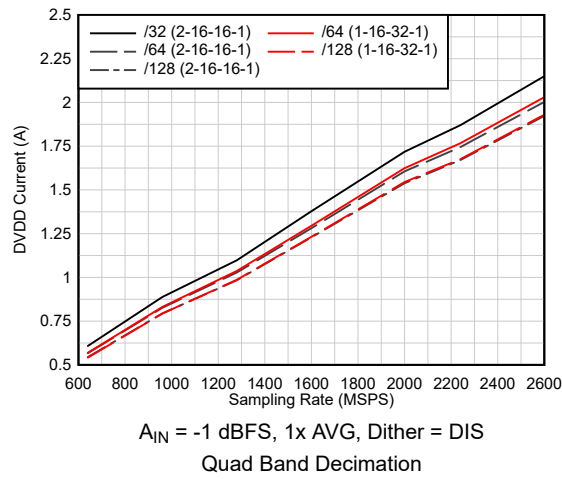
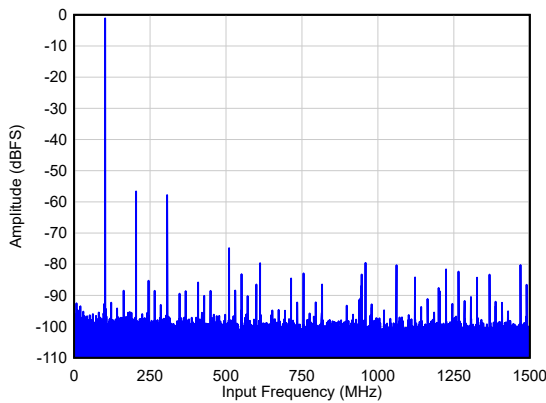


Figure 6-55. Current vs Sampling Rate vs Decimation

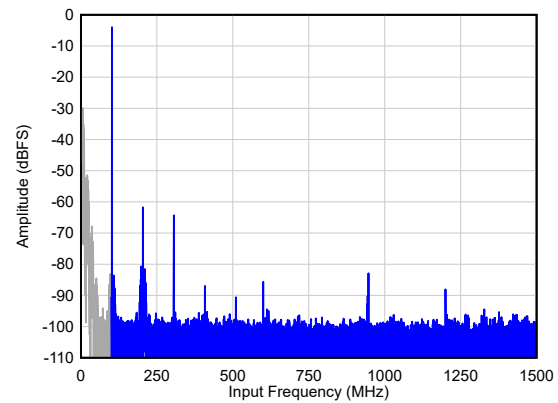
6.13 Typical Characteristics - ADC32RF55

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



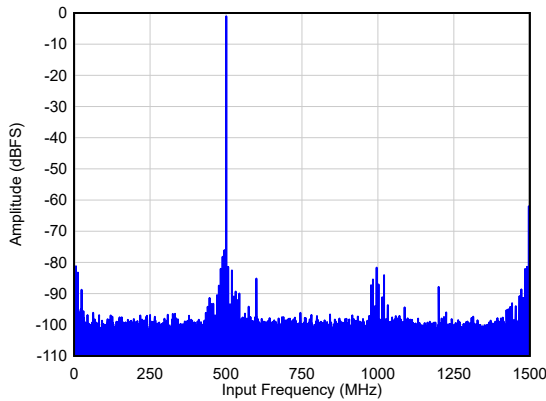
SNR = 62.1 dBFS, SFDR = 57 dBc, Non HD23 = 75 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-56. Single Tone FFT at $F_{IN} = 100$ MHz



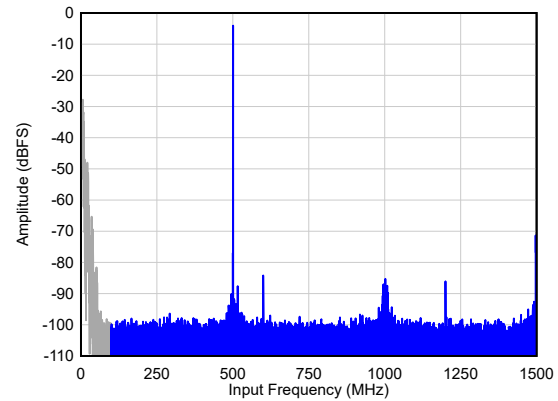
SNR = 61.7 dBFS², SFDR = 58 dBc, Non HD23 = 83 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-57. Single Tone FFT at $F_{IN} = 100$ MHz



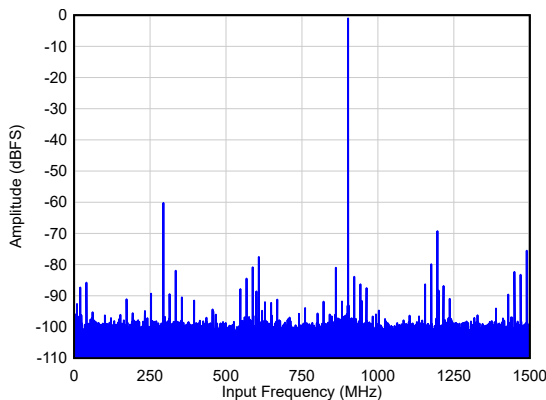
SNR = 61.9 dBFS, SFDR = 63 dBc, Non HD23 = 77 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-58. Single Tone FFT at $F_{IN} = 500$ MHz



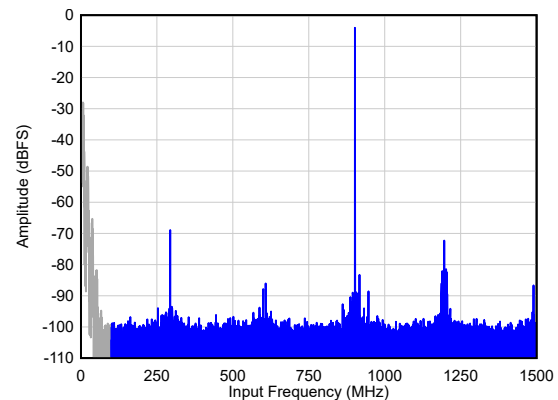
SNR = 61.8 dBFS¹, SFDR = 68 dBc, Non HD23 = 84 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-59. Single Tone FFT at $F_{IN} = 500$ MHz



SNR = 61.8 dBFS, SFDR = 60 dBc, Non HD23 = 76 dBFS
 $A_{IN} = -1$ dBFS, 1x AVG, Dither = DIS

Figure 6-60. Single Tone FFT at $F_{IN} = 900$ MHz



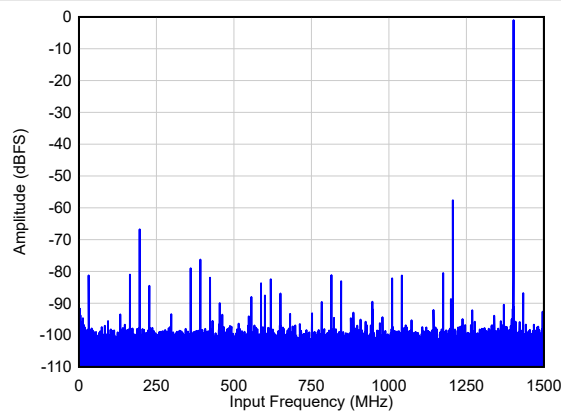
SNR = 60.9 dBFS¹, SFDR = 64 dBc, Non HD23 = 82 dBFS
 $A_{IN} = -4$ dBFS, 1x AVG, Dither = EN

Figure 6-61. Single Tone FFT at $F_{IN} = 900$ MHz

² Measured from 100 MHz to $F_S/2$

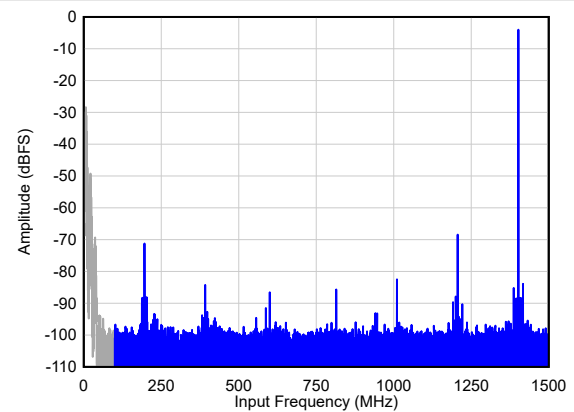
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



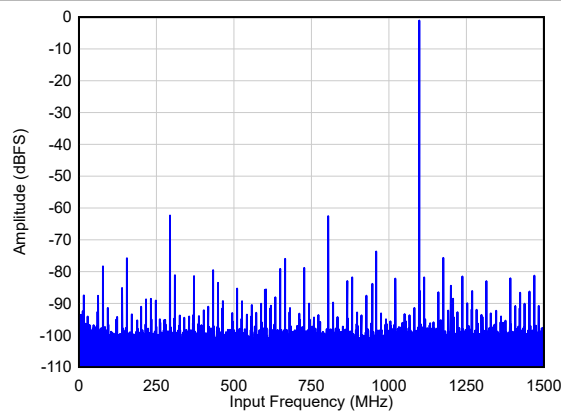
SNR = 62.1 dBFS, SFDR = 57 dBc, Non HD23 = 76 dBFS
 $A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-62. Single Tone FFT at $F_{IN} = 1400\text{ MHz}$



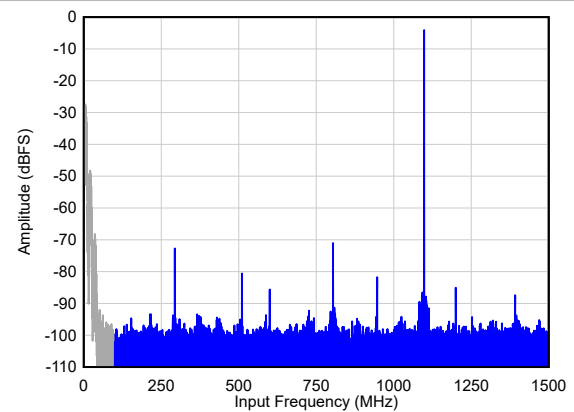
SNR = 62.2 dBFS¹, SFDR = 63 dBc, Non HD23 = 83 dBFS
 $A_{IN} = -4\text{ dBFS}$, 1x AVG, Dither = EN

Figure 6-63. Single Tone FFT at $F_{IN} = 1400\text{ MHz}$



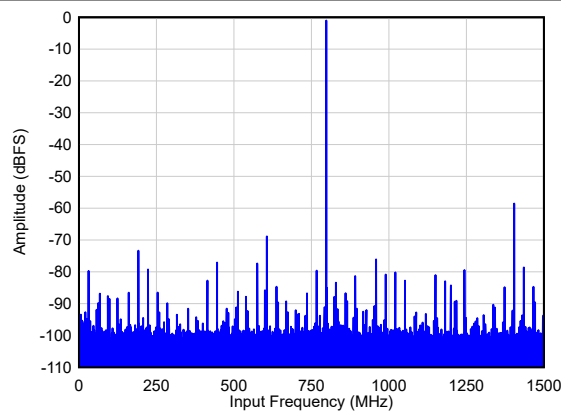
SNR = 60.9 dBFS, SFDR = 62 dBc, Non HD23 = 74 dBFS
 $A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-64. Single Tone FFT at $F_{IN} = 1900\text{ MHz}$



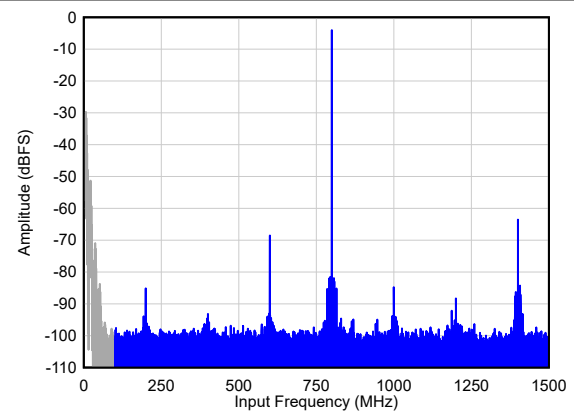
SNR = 61.2 dBFS¹, SFDR = 67 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -4\text{ dBFS}$, 1x AVG, Dither = EN

Figure 6-65. Single Tone FFT at $F_{IN} = 1900\text{ MHz}$



SNR = 60.4 dBFS, SFDR = 58 dBc, Non HD23 = 73 dBFS
 $A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-66. Single Tone FFT at $F_{IN} = 2200\text{ MHz}$

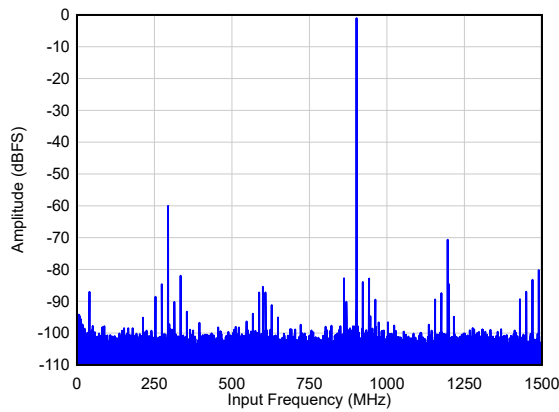


SNR = 61.1 dBFS¹, SFDR = 60 dBc, Non HD23 = 82 dBFS
 $A_{IN} = -4\text{ dBFS}$, 1x AVG, Dither = EN

Figure 6-67. Single Tone FFT at $F_{IN} = 2200\text{ MHz}$

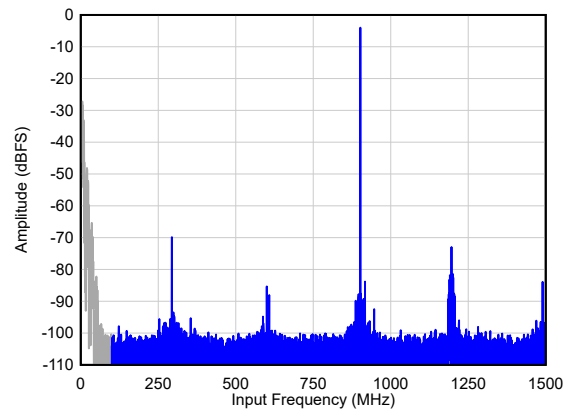
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



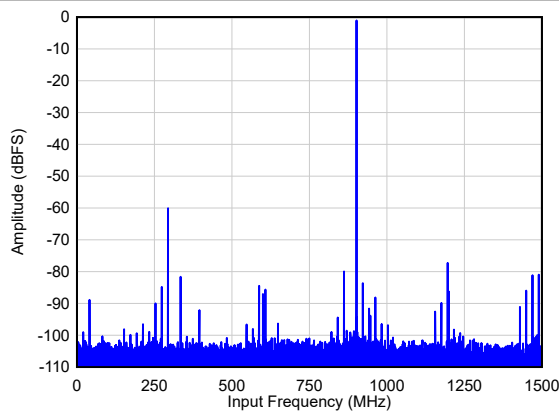
SNR = 63.5 dBFS, SFDR = 59 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -1\text{ dBFS}$, 2x AVG, Dither = DIS

Figure 6-68. Single Tone FFT at $F_{IN} = 900\text{ MHz}$



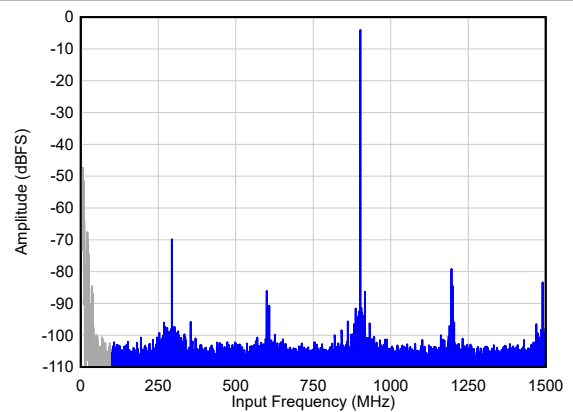
SNR = 62.3 dBFS¹, SFDR = 66 dBc, Non HD23 = 82 dBFS
 $A_{IN} = -4\text{ dBFS}$, 2x AVG, Dither = EN

Figure 6-69. Single Tone FFT at $F_{IN} = 900\text{ MHz}$



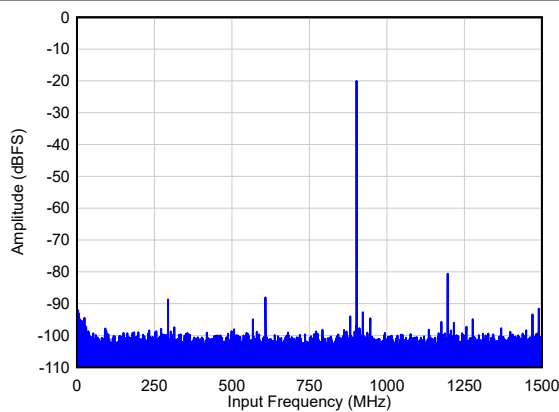
SNR = 65.6 dBFS, SFDR = 60 dBc, Non HD23 = 80 dBFS
 $A_{IN} = -1\text{ dBFS}$, 4x AVG, Dither = DIS

Figure 6-70. Single Tone FFT at $F_{IN} = 900\text{ MHz}$



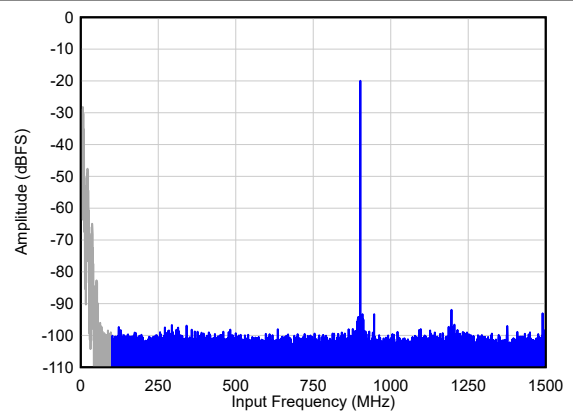
SNR = 66.2 dBFS¹, SFDR = 66 dBc, Non HD23 = 83 dBFS
 $A_{IN} = -4\text{ dBFS}$, 4x AVG, Dither = EN

Figure 6-71. Single Tone FFT at $F_{IN} = 900\text{ MHz}$



SNR = 63.9 dBFS, SFDR = 60 dBc, Non HD23 = 87 dBFS
 $A_{IN} = -20\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-72. Single Tone FFT at $F_{IN} = 900\text{ MHz}$

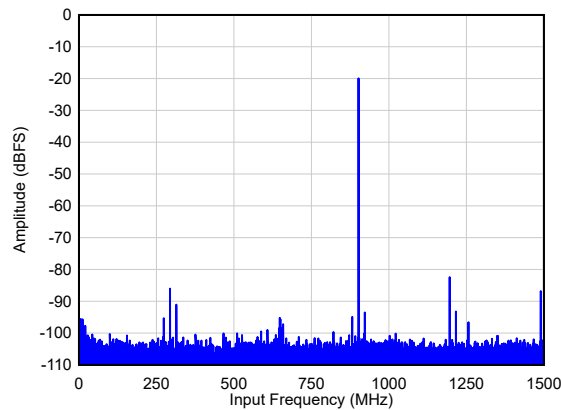


SNR = 63.4 dBFS¹, SFDR = 73 dBc, Non HD23 = 92 dBFS
 $A_{IN} = -20\text{ dBFS}$, 1x AVG, Dither = EN

Figure 6-73. Single Tone FFT at $F_{IN} = 900\text{ MHz}$

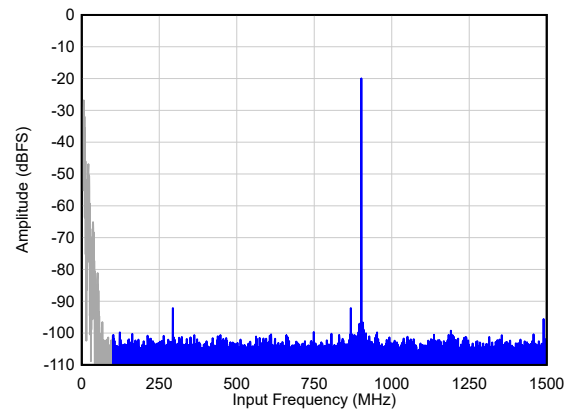
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



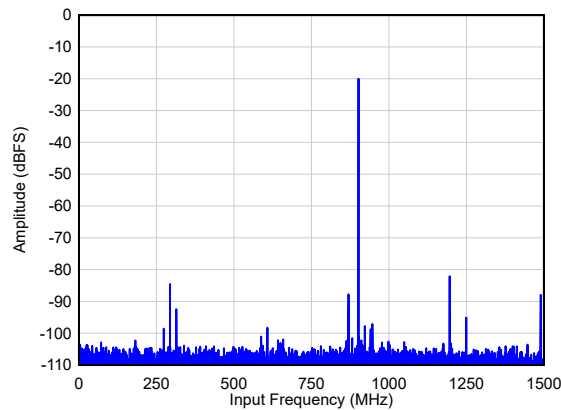
SNR = 66.4 dBFS, SFDR = 63 dBc, Non HD23 = 86 dBFS
 $A_{IN} = -20$ dBFS, 2x AVG, Dither = DIS

Figure 6-74. Single Tone FFT at $F_{IN} = 900$ MHz



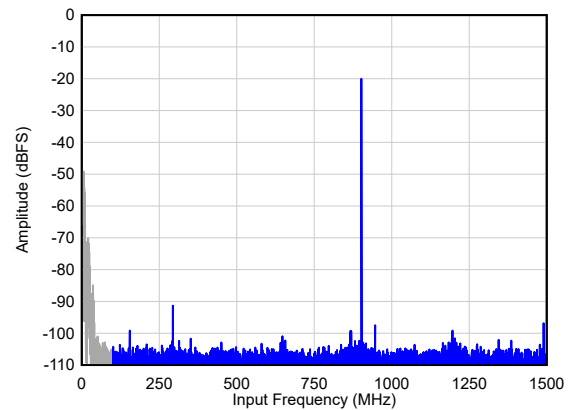
SNR = 65.5 dBFS¹, SFDR = 73 dBc, Non HD23 = 95 dBFS
 $A_{IN} = -20$ dBFS, 2x AVG, Dither = EN

Figure 6-75. Single Tone FFT at $F_{IN} = 900$ MHz



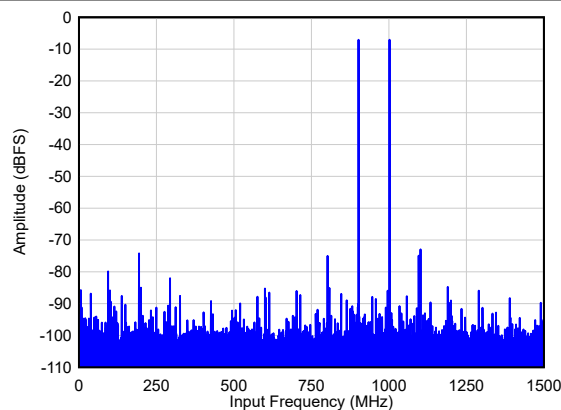
SNR = 68.7 dBFS, SFDR = 62 dBc, Non HD23 = 87 dBFS
 $A_{IN} = -20$ dBFS, 4x AVG, Dither = DIS

Figure 6-76. Single Tone FFT at $F_{IN} = 900$ MHz



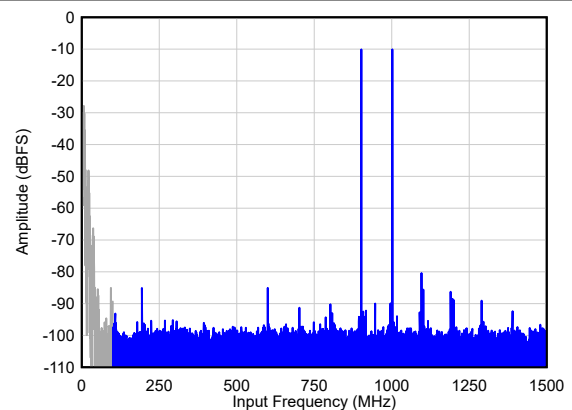
SNR = 68.1 dBFS¹, SFDR = 71 dBc, Non HD23 = 78 dBFS
 $A_{IN} = -20$ dBFS, 4x AVG, Dither = EN

Figure 6-77. Single Tone FFT at $F_{IN} = 900$ MHz



IMD3 = 68 dBc
 $A_{IN} = -7$ dBFS/tone, 1x AVG, Dither = DIS

Figure 6-78. Two Tone FFT at $F_{IN} = 900/1000$ MHz

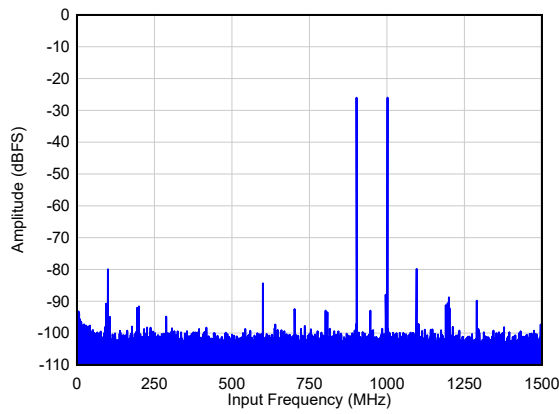


IMD3 = 70 dBc
 $A_{IN} = -10$ dBFS/tone, 1x AVG, Dither = EN

Figure 6-79. Two Tone FFT at $F_{IN} = 900/1000$ MHz

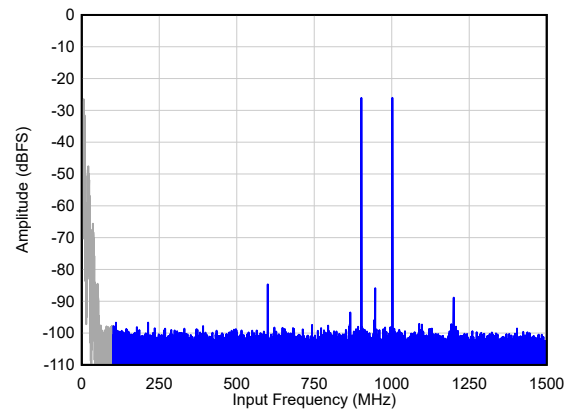
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



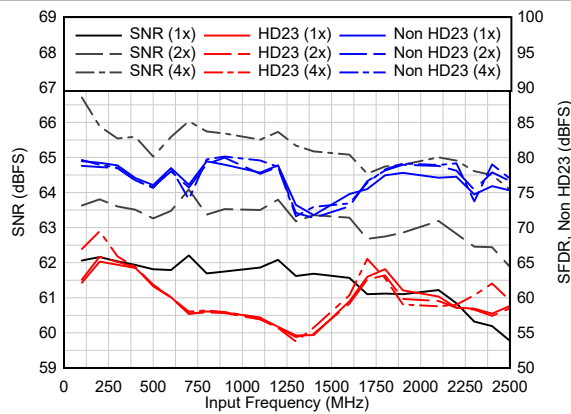
IMD3 = 54 dBc
 $A_{IN} = -26$ dBFS/tone, 1x AVG, Dither = DIS

Figure 6-80. Two Tone FFT at $F_{IN} = 900/1000$ MHz



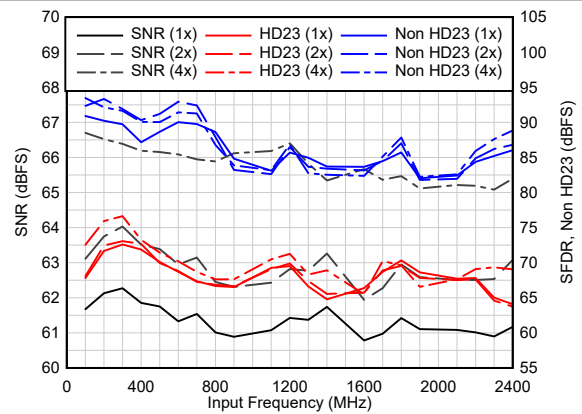
IMD3 = 71 dBc
 $A_{IN} = -26$ dBFS/tone, 1x AVG, Dither = EN

Figure 6-81. Two Tone FFT at $F_{IN} = 900/1000$ MHz



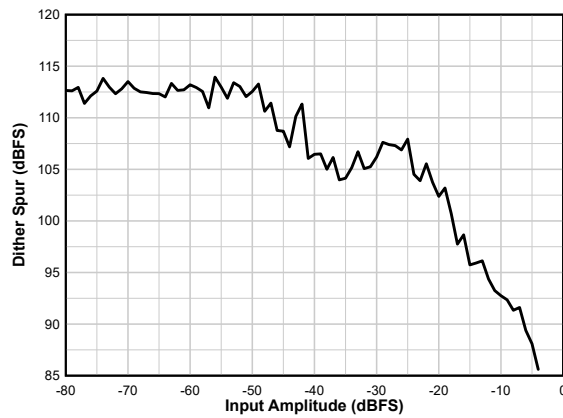
$A_{IN} = -1$ dBFS, Dither = DIS

Figure 6-82. AC Performance vs F_{IN}

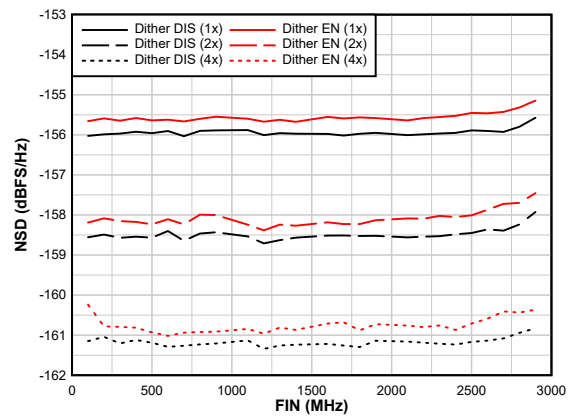


$A_{IN} = -4$ dBFS, Dither = EN

Figure 6-83. AC Performance vs F_{IN}



$F_{IN} = 900$ MHz,
Figure 6-84. Dither Spur vs A_{IN}

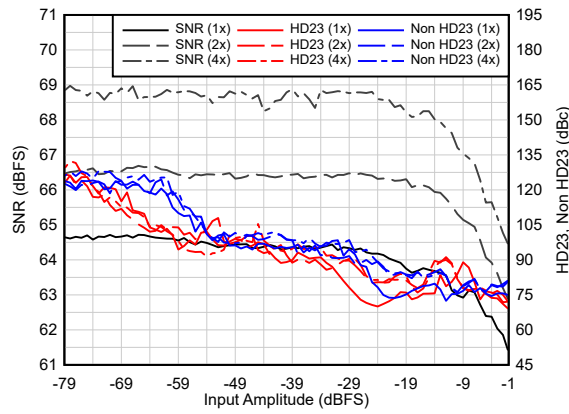


$A_{IN} = -20$ dBFS

Figure 6-85. NSD Performance vs F_{IN}

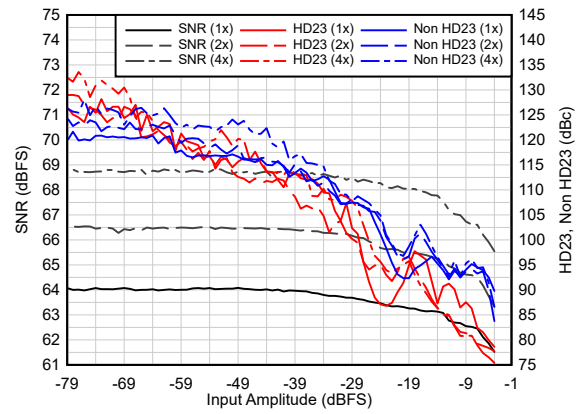
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



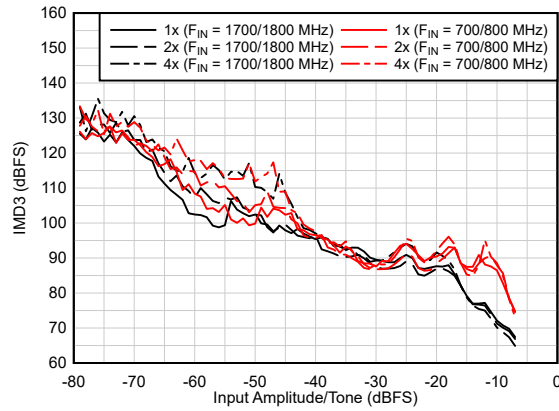
$F_{IN} = 900\text{ MHz}$, Dither = DIS

Figure 6-86. AC Performance vs A_{IN}



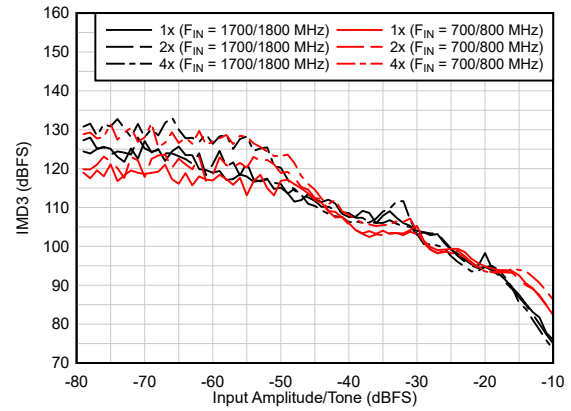
$F_{IN} = 900\text{ MHz}$, Dither = EN

Figure 6-87. AC Performance vs A_{IN}



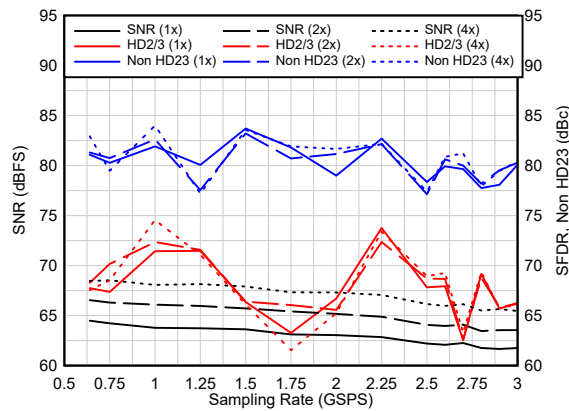
Dither = DIS

Figure 6-88. IMD3 Performance vs A_{IN}



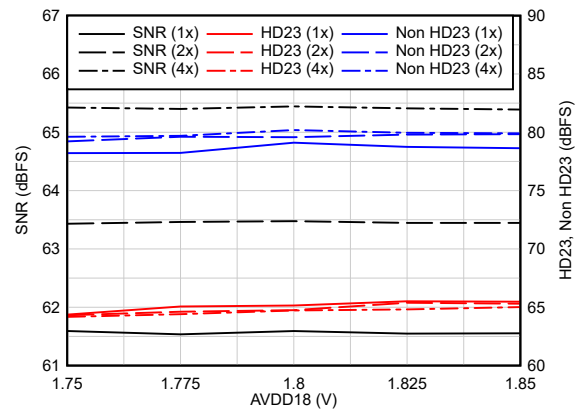
Dither = EN

Figure 6-89. IMD3 Performance vs A_{IN}



$F_{IN} = 900\text{ MHz}$, $A_{IN} = -1\text{ dBFS}$, Dither = DIS

Figure 6-90. AC Performance vs F_S

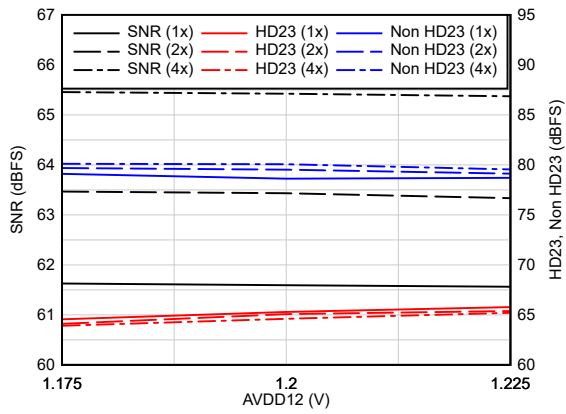


$F_{IN} = 900\text{ MHz}$, $A_{IN} = -1\text{ dBFS}$, Dither = DIS, Other supplies nominal

Figure 6-91. AC Performance vs AVDD18

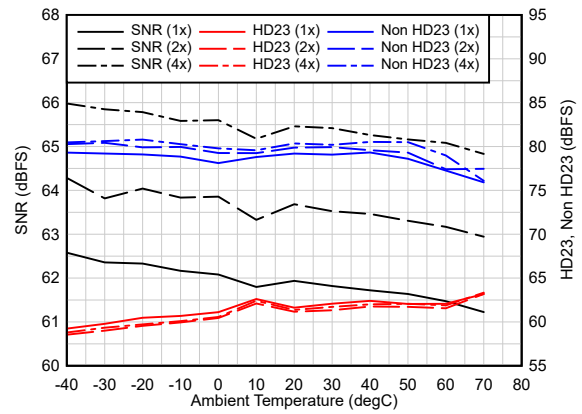
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



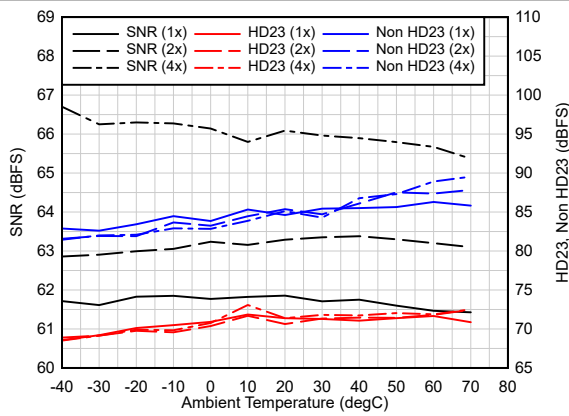
$F_{IN} = 900\text{ MHz}$, $A_{IN} = -1\text{ dBFS}$, Dither = DIS, Other supplies nominal

Figure 6-92. AC Performance vs AVDD12



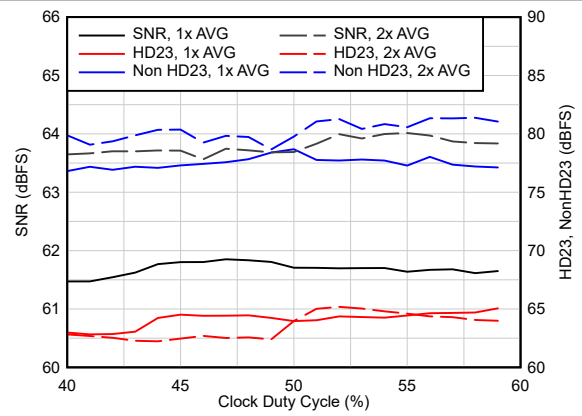
$F_{IN} = 900\text{ MHz}$, $A_{IN} = -1\text{ dBFS}$, Dither = DIS

Figure 6-93. AC Performance vs Temperature



$F_{IN} = 900\text{ MHz}$, $A_{IN} = -4\text{ dBFS}$, Dither = EN

Figure 6-94. AC Performance vs Temperature



$F_{IN} = 900\text{ MHz}$, $A_{IN} = -1\text{ dBFS}$, Dither = DIS

Figure 6-95. AC Performance vs Clock Duty Cycle

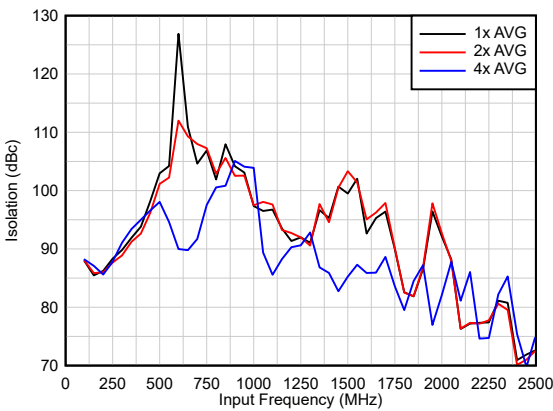
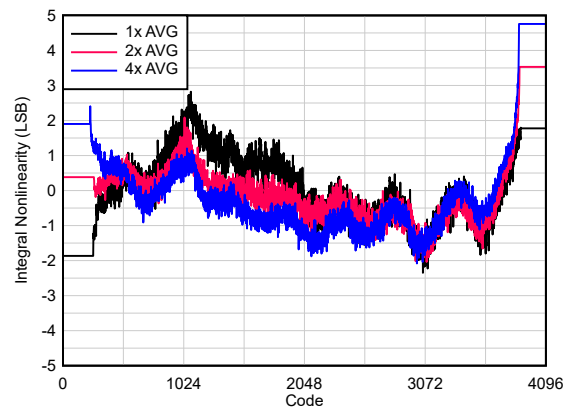


Figure 6-96. Isolation vs Input Frequency

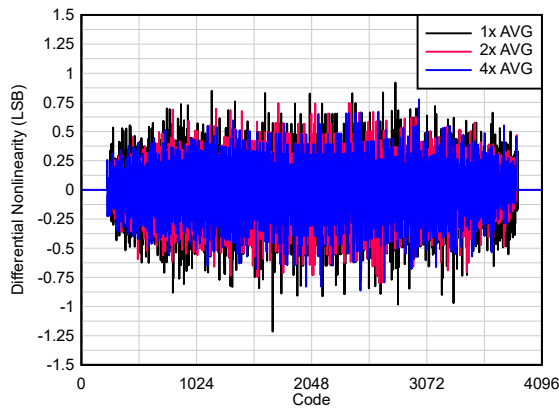


$F_{IN} = 900\text{ MHz}$, Dither = DIS

Figure 6-97. INL vs Code

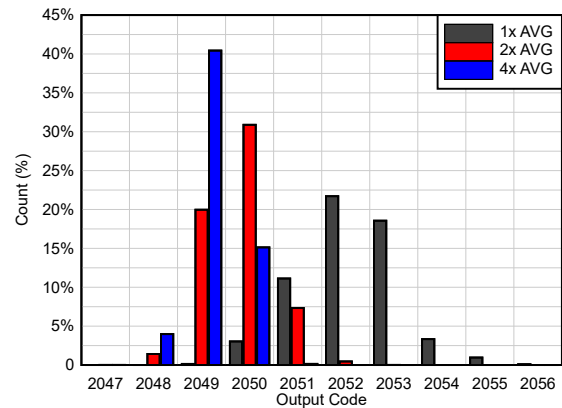
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



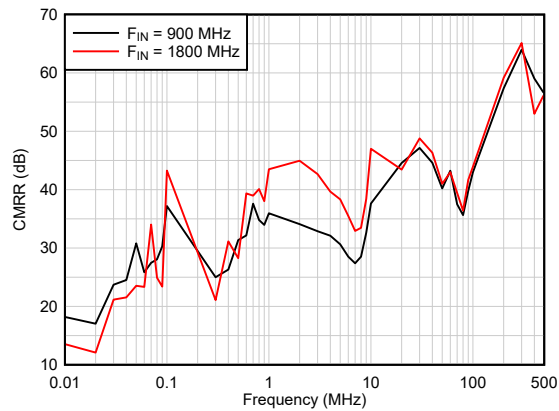
$F_{IN} = 900\text{ MHz}$, Dither = DIS

Figure 6-98. DNL vs Code



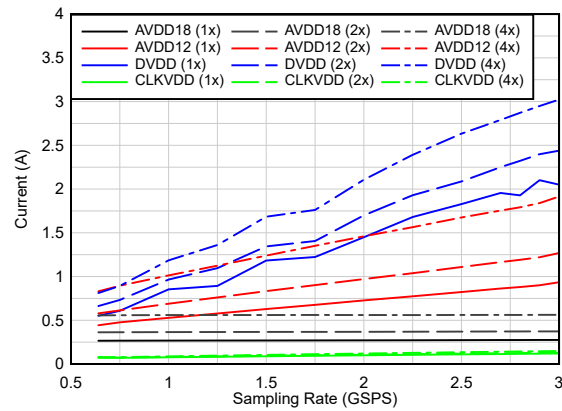
Dither = DIS

Figure 6-99. DC Offset Histogram



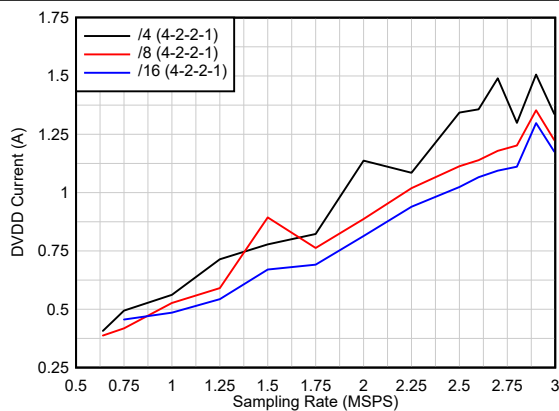
$A_{IN} = -1\text{ dBFS}$, 1x AVG, Dither = DIS

Figure 6-100. CMRR



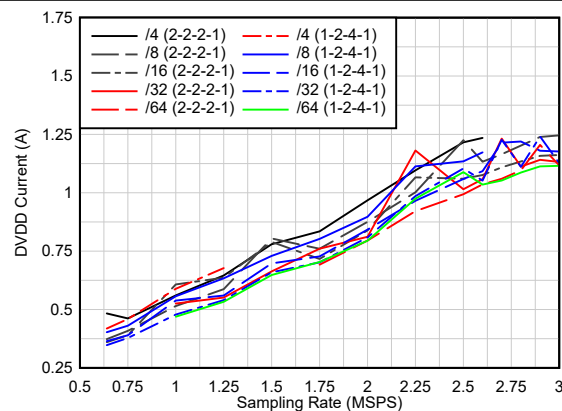
$A_{IN} = -1\text{ dBFS}$, Dither = DIS, DDC Bypass

Figure 6-101. Current vs Sampling Rate vs Averaging



$A_{IN} = -1\text{ dBFS}$, 1x AVG

Figure 6-102. Current vs Sampling Rate vs Real Decimation



$A_{IN} = -1\text{ dBFS}$, 1x AVG

Figure 6-103. Current vs Sampling Rate vs Real Decimation

6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted

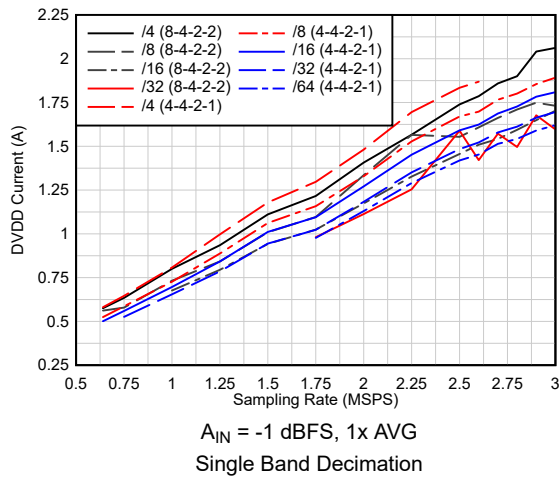


Figure 6-104. Current vs Sampling Rate vs Complex Decimation

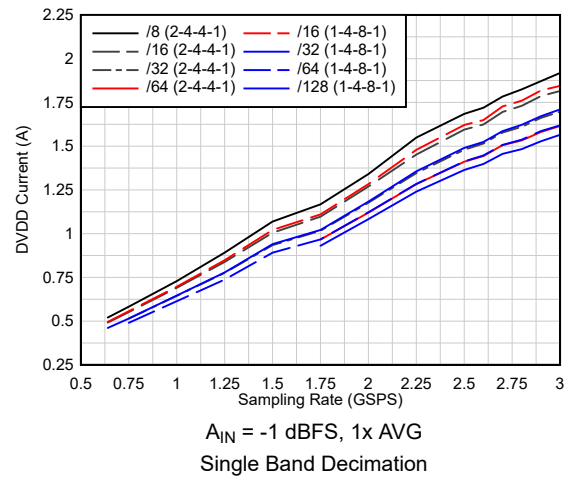


Figure 6-105. Current vs Sampling Rate vs Complex Decimation

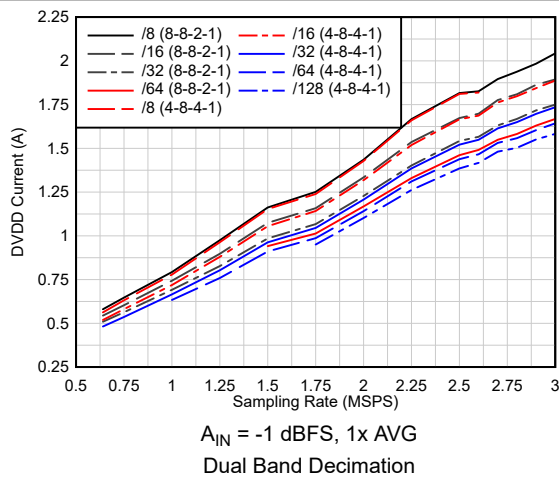


Figure 6-106. Current vs Sampling Rate vs Complex Decimation

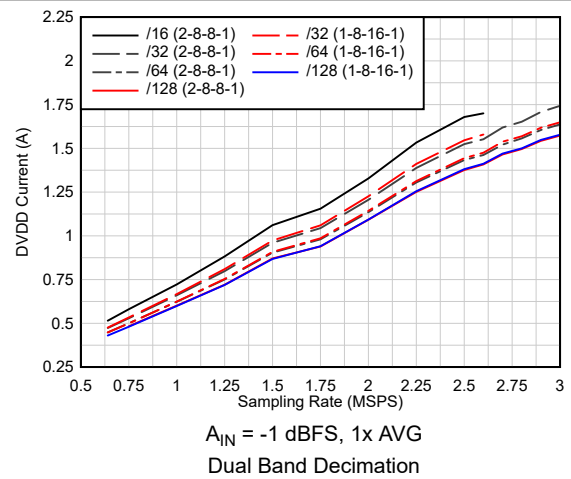


Figure 6-107. Current vs Sampling Rate vs Complex Decimation

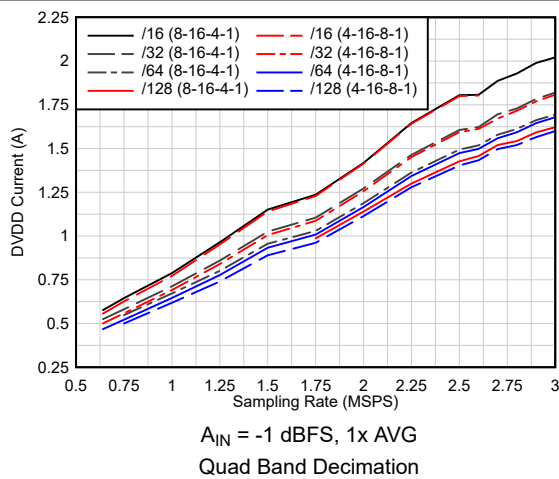


Figure 6-108. Current vs Sampling Rate vs Complex Decimation

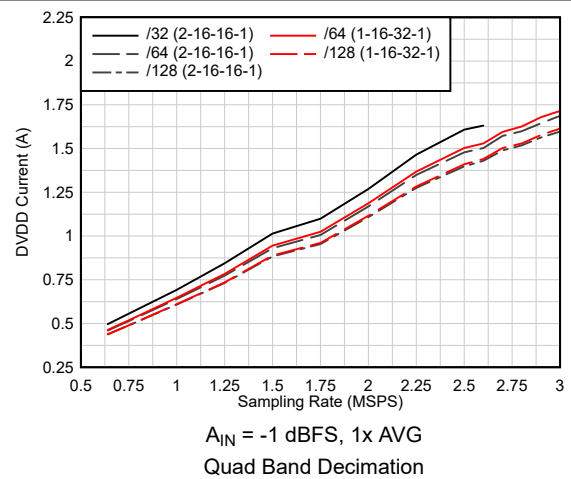
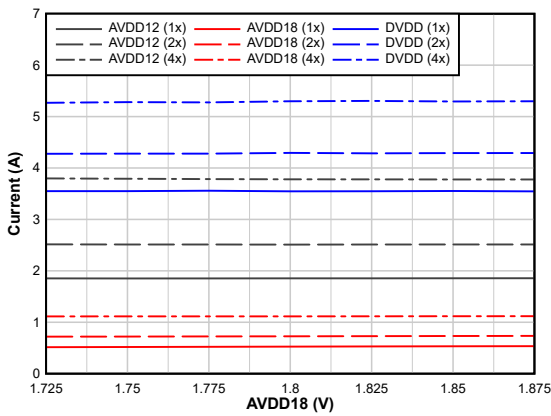


Figure 6-109. Current vs Sampling Rate vs Complex Decimation

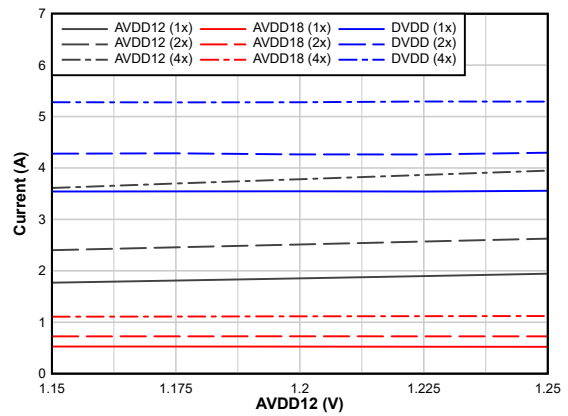
6.13 Typical Characteristics - ADC32RF55 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 3 GSPS, LMFS = 82820, 50% clock duty cycle, AVDD18 = 1.8 V, AVDD12, CLKVDD, DVDD = 1.2 V and -1-dBFS differential input, unless otherwise noted



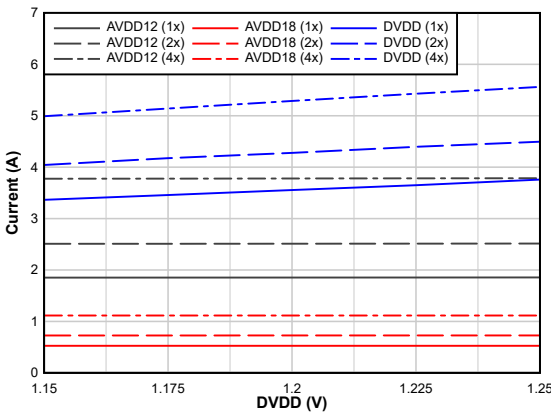
$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-110. I_{AVDD18} vs Supply



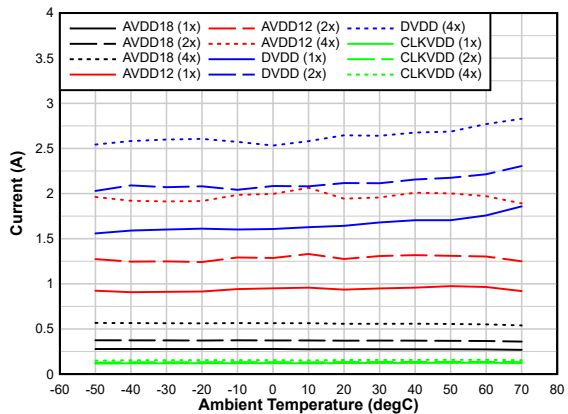
$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-111. I_{AVDD12} vs Supply



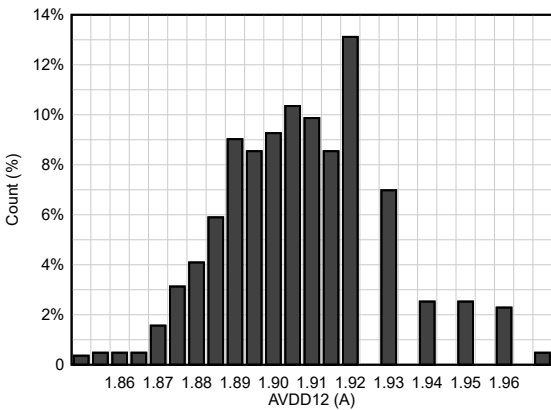
$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-112. I_{DVDD} vs Supply



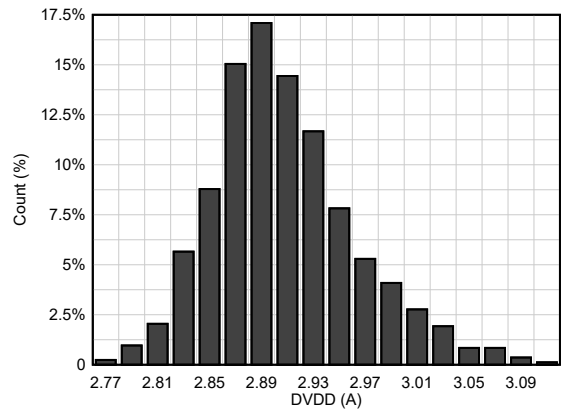
$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-113. Current vs Temperature



$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-114. AVDD12 Distribution



$A_{IN} = -1$ dBFS, DDC Bypass

Figure 6-115. DVDD Distribution

7 Detailed Description

7.1 Overview

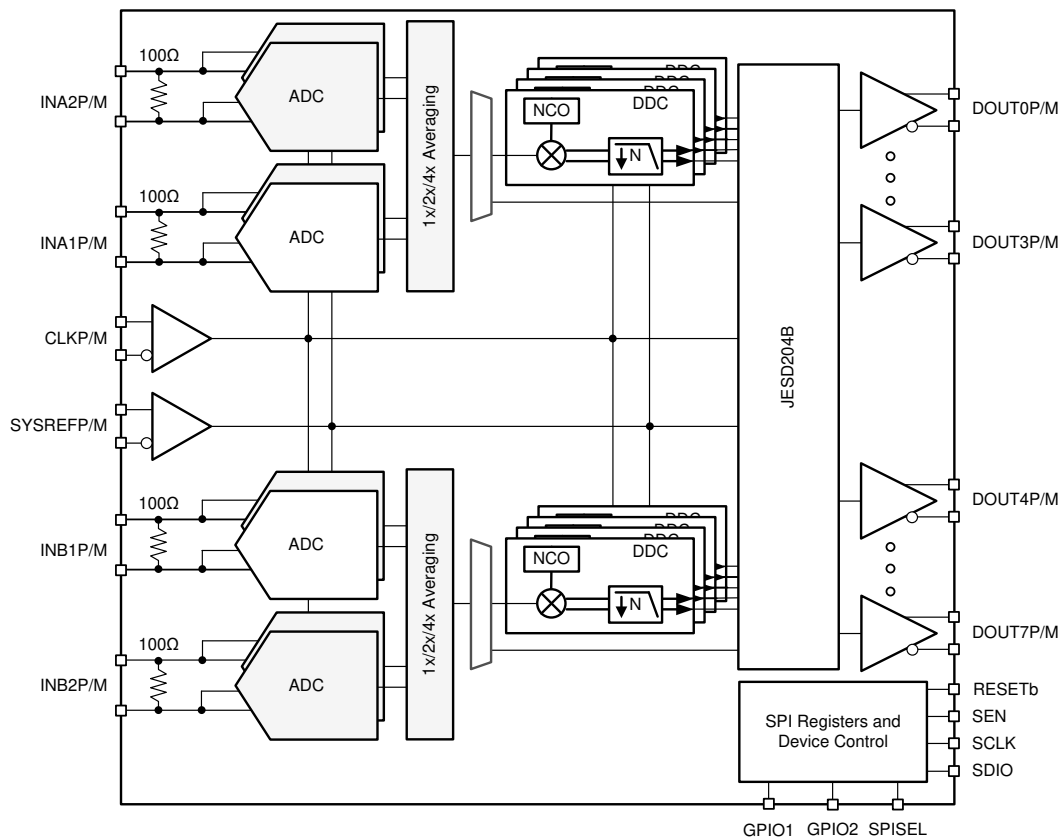
The ADC32RF5x is a single core (non-interleaved) 14-bit, 2.6 GSPS to 3 GSPS, dual channel analog to digital converter (ADC). The design maximizes signal-to-noise ratio (SNR) and delivers a noise spectral density of -155 dBFS/Hz. Additional internal ADCs can be used for on-chip averaging (2x and 4x) to further improve the noise density to as low as -161 dBFS/Hz.

The analog signal input is non-buffered to save power consumption with a nominal differential input impedance of 100 Ω. The full power input bandwidth is 2.75 GHz (-3 dB) and the device supports direct RF sampling with input frequencies in the through the L-band. The device is designed for low residual phase noise to support high performance radar applications. The sampling clock input has a dedicated power supply input which requires a very clean power supply.

Each ADC channel can be connected to a quad-band digital down-converter (DDC) using a 48-bit NCO which supports phase coherent frequency hopping. Using the GPIO pins for NCO frequency control, frequency hopping can be achieved in less than 1 μs. The digital down converters support a wide range of instantaneous bandwidth (IBW) coverage - from single wide band mode with 4x complex decimation to up to four narrow bandwidth channels with as high as 128x complex decimation.

The ADC32RF5x supports the JESD204B serial data interface with subclass 1 deterministic latency using data rates up to 13.0 Gbps. In bypass mode, 14-bit output is supported up to a sampling rate of 2.6 Gsps. From 2.6 to 3 Gsps a 12-bit interface with more efficient data packing can be used at expense of quantization noise. When using decimation the output is 16-bit.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Analog Inputs

The ADC32RF5x provides up to four internal ADCs per channel for purpose of averaging in order to improve the noise performance. Two ADCs internally are connected to the same differential input pins as shown in the equivalent input schematic (see Figure 7-1). The analog inputs have a differential 100 Ω split termination with internal biasing. This can be changed to differential 50 Ω termination via SPI register write. When only a single ADC is used, there is a minor parasitic capacitance remaining from the unused ADC.

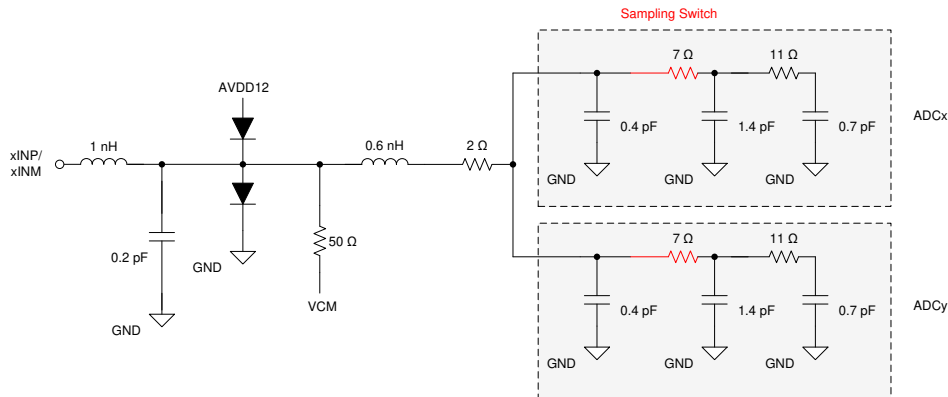


Figure 7-1. Equivalent Input Schematic

7.3.1.1 Input Bandwidth and Full-Scale

The input bandwidth (-3 dB) and input fullscale are dependent on what input termination and averaging mode are chosen as shown in the summary in Table 7-1. With 4x averaging enabled, the -3 dB bandwidth reduces to ~ 2.1 GHz and 100 Ω differential termination - the bandwidth can be increased by changing the input termination to 50 Ω differential.

Table 7-1. Digital averaging vs Full Power Input Bandwidth (-3 dB)

| # of ADCs averaged | ADC inputs used for averaging | Input Bandwidth (-3 dB) | Selected differential input termination | Effective differential input termination | Input Full-scale |
|--------------------|-------------------------------|-------------------------|---|--|------------------|
| Default | INx1 | 2.75 GHz | 100 Ω | 100 Ω | + 2 dBm |
| 2 | INx1 | 2.75 GHz | 100 Ω | 100 Ω | + 3.5 dBm |
| 4 | INx1, INx2 | 2.1 GHz | 100 Ω | 50 Ω | + 6.6 dBm |

The full power input bandwidth plots with input RESET switch disabled (RSW0) and enabled (RSW1) are shown in Figure 7-2.

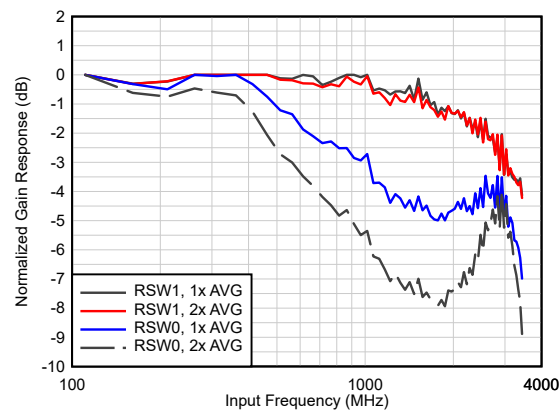


Figure 7-2. Input Bandwidth - Reset switch DIS

The RESET switch is enabled by default and can be disabled with the following register writes:

Table 7-2. Register Write Example for Configuring the RESET Switch

| ADDR | DATA | DESCRIPTION |
|------|------|--|
| 0x05 | 0x40 | Select ANALOG page |
| 0x6D | 0xC0 | Disable RESET Switch (to enable: 0x00) |
| 0x6E | 0x08 | Disable RESET Switch (to enable: 0x00) |

7.3.1.2 Input Imbalance

The AC performance is sensitive to amplitude and phase imbalance of the analog inputs, as shown in Figure 7-3 and Figure 7-4 for 1x and 2x internal averaging ($F_S = 2.6$ GSPS, $F_{IN} = 0.9$ GHz, $A_{IN} = -1$ dBFS, dither = DIS) and Figure 7-5 and Figure 7-6 ($F_S = 3.0$ GSPS, $F_{IN} = 0.9$ GHz, $A_{IN} = -1$ dBFS, dither = DIS).

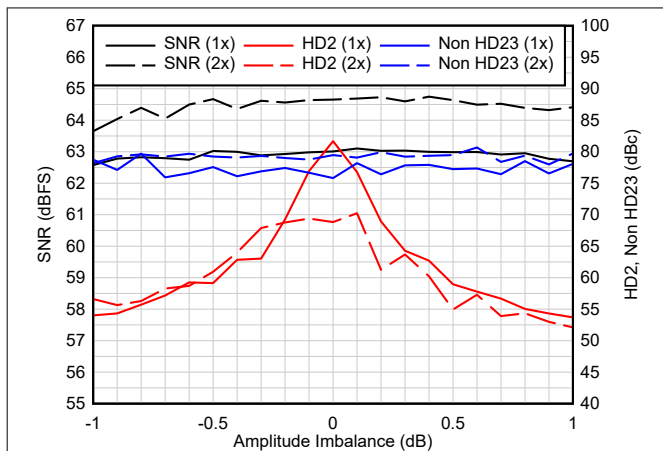


Figure 7-3. Amplitude Imbalance - 2.6 GSPS

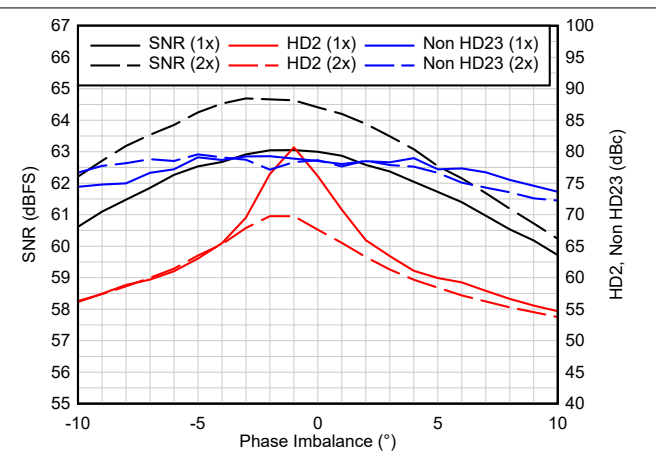


Figure 7-4. Phase Imbalance - 2.6 GSPS

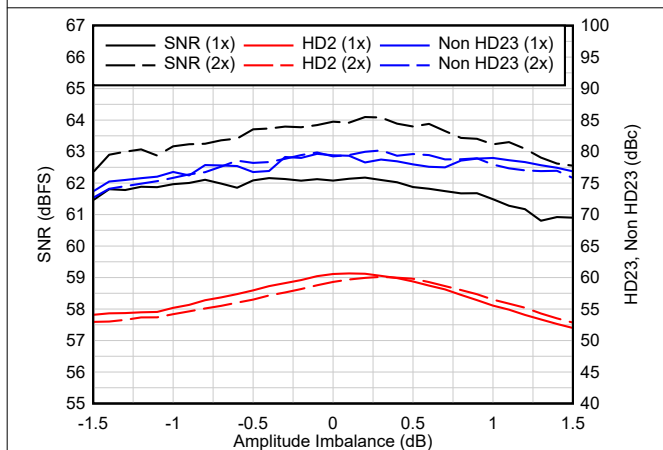


Figure 7-5. Amplitude Imbalance - 3.0 GSPS

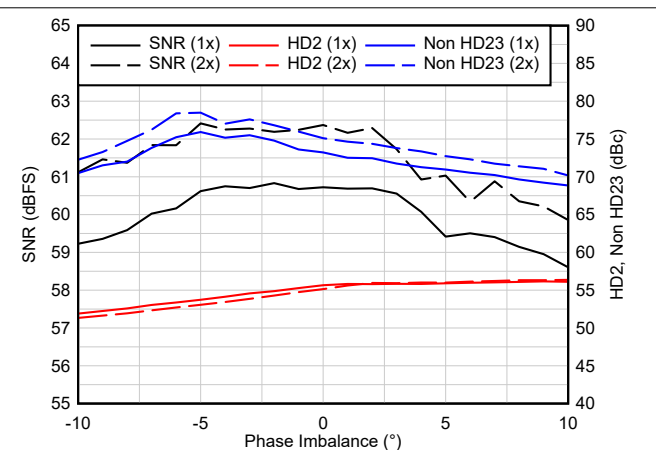


Figure 7-6. Phase Imbalance - 3.0 GSPS

7.3.1.3 Overrange Indication

The ADC provides two options (configured using SPI) to indicate if input fullscale overrange occurred:

- Fast Overrange on GPIO1/2 pins: indication is available after ~ 6 clock cycles and the overrange indication flag stays high (sticky) until it is cleared via SPI register writes. Note: OVRA and OVRB or OR-ed together and given on GPIO1 and 2.
- Overrange embedded in JESD stream: in this configuration the overrange indicator replaces the LSB of the output data of the corresponding channel. The indicator is output ahead of the data and is updated every clock cycle.

Table 7-3. JESD OVR Latency

| Decimation | # of Bands | OVR Latency (incl JESD, in sampling clock cycles) |
|------------|---------------------------------|---|
| DDC Bypass | - | 140-144 |
| 8 | Single (real and complex), dual | 44 |
| | Quad | 33 |
| 16 | Single (real and complex), dual | 80 |
| | Quad | 58 |
| 32 | Single (real and complex), dual | 152 |
| | Quad | 108 |
| 64 | Single (real and complex), dual | 296 |
| | Quad | 208 |
| 128 | Single (real and complex), dual | 584 |
| | Quad | 408 |

The overrange output flag (GPIO or JESD) is the output of individual overrange flags of all ADCs per channel being used. For example, in non-averaged mode the overrange indication per channel is for a single ADC while in 4x average mode the overrange flag of all 4 ADCs are OR-ed together. [Table 7-4](#) shows how to configure the OVR using SPI registers.

Table 7-4. Programming example to configure the OVR to GPIO or JESD

| ADDR | DATA | DESCRIPTION | ADDR | DATA | DESCRIPTION |
|---|------|-------------------------------|---|------|--------------------------------------|
| OVRA on GPIO1 and OVRB on GPIO2, OVR sticky | | | OVR on JESD | | |
| 0x05 | 0x02 | Select DIGITAL page | 0x05 | 0x02 | Select DIGITAL page |
| 0x238 | 0xF0 | | 0x2E | D0 | Set D0 = 1 to enable OVR on JESD |
| 0x383 | 0x02 | Enable individual OVR on GPIO | 0x05 | 0x00 | |
| Clear OVR | | | These extra writes are only needed using decimation | | |
| 0x05 | 0x40 | Select ANALOG page | 0x05 | 0x18 | Select DDCA & DDCB page at same time |
| 0x74 | 0x04 | Clear OVR flag chA | 0x20 | 0x06 | Enable OVR on JESD |
| 0x74 | 0x00 | | | | |
| 0x84 | 0x04 | Clear OVR flag chB | | | |
| 0x84 | 0x00 | | | | |
| Change OVR from sticky to non sticky (self clear) | | | | | |
| 0x05 | 0x40 | Select ANALOG page | | | |
| 0x31 | 0x06 | Set OVR to non-sticky | | | |

7.3.1.4 Analog out-of-band dither

The ADC32RF5x provides optional (enabled via SPI writes) analog out-of-band, large amplitude dither. It has a bandwidth of ~ 20 MHz located at DC and an adjustable amplitude with a maximum dither power of ~ -20 dBFS (PAR ~ 9 dB). The dither is completely rolled-off into the noise floor within ~ 100 MHz as illustrated in Figure 7-7. Since the dither is large amplitude, it is recommended for the signal input not to exceed -2.5 dBFS to avoid input saturation. The dither signal also couples to the input signal and, depending on input frequency, can degrade the close in phase noise.

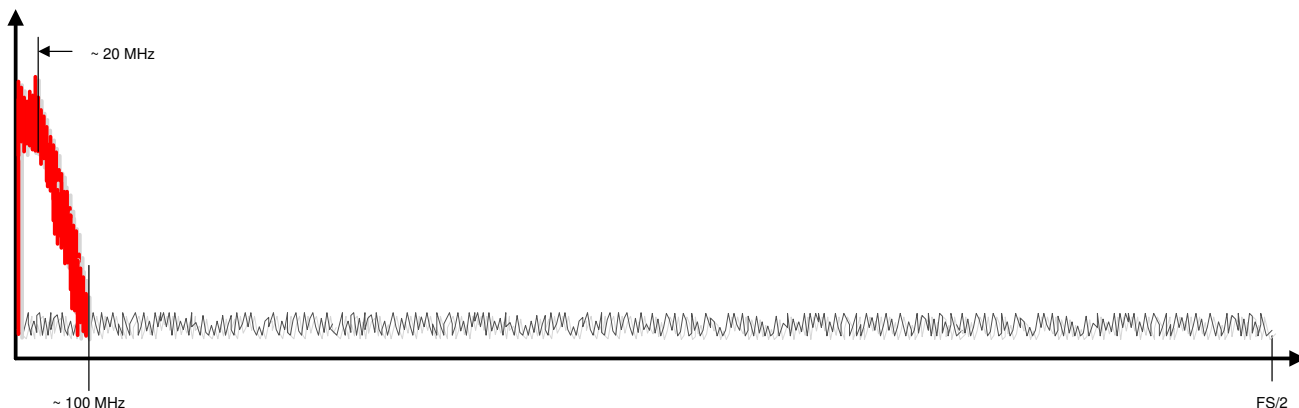


Figure 7-7. Analog out-of-band dither

In the frequency domain the dither signal shows up like individual tones as shown in Figure 7-8. The dither update frequency can be adjusted with the dither divider setting. The dither update frequency is: $F_S / 4 / 2047 /$ 'Dither Divider'. In the frequency spectrum there will be 2 larger dither spurs at $F_{IN} \pm F_S / 4 /$ 'Dither Divider'.

By default, the divider is set to 50, which translates to a dither spur spacing of ~ 7 kHz. A divider setting of 32 translates to a dither spacing of ~ 11 kHz as shown in Figure 7-9. The lower the divider setting, the higher the dither tone frequency. Figure 7-9 also shows that the dither energy reduces as the offset frequency increases - less dither energy reduces the higher harmonic spur improvement.

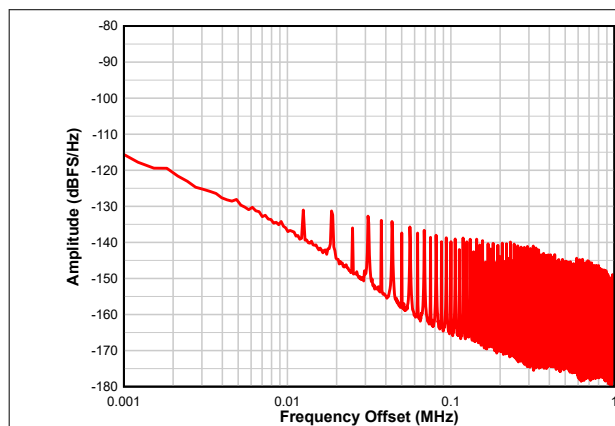


Figure 7-8. Dither Close-Up

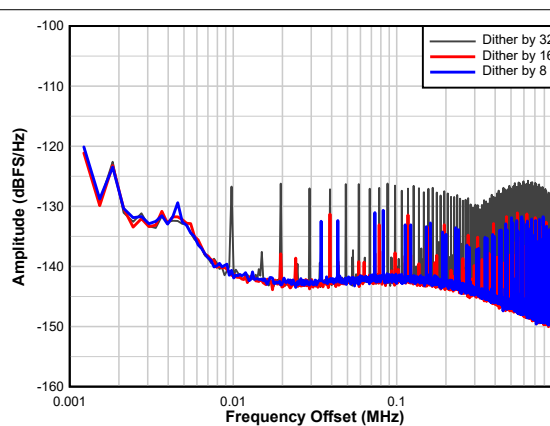


Figure 7-9. Dither vs Dither Divider Setting

The analog dither needs to be enabled in multiple locations. Different dither amplitudes should be used depending on internal averaging used as shown in [Table 7-5](#).

Table 7-5. Recommended Dither Amplitude Settings

| Mode | Amplitude | Dither Amp1 | Dither Amp2 |
|-----------|---------------|-------------|-------------|
| 1x AVG | +/-1024 codes | 0 | 0 |
| 1x AVG | +/-768 codes | 0 | -4 |
| 2x/4x AVG | +/-1024 codes | 3 | 0 |
| 2x/4x AVG | +/-768 codes | 0 | 0 |

The internal analog dither can be enabled via the following register writes. The dither divider is set in register 0xB1 as actual -1 (e.g. a divider of 48 would be programmed as 47, default is 0x00 which is divider = 50). See [Table 7-6](#).

Table 7-6. Register Write Example for Configuring the Internal Dither

| ADDR | DATA | DESCRIPTION | ADDR | DATA | DESCRIPTION |
|------|------|----------------------------------|------|------|---|
| 0x05 | 0x40 | Select ANALOG page | 0xB1 | 0x00 | Sets dither divider. 0x00 = /50 |
| 0xA8 | 0x00 | DITHER AMP1: 3 = 0x80, 0 = 0x00 | 0xB2 | 0x00 | |
| 0xCD | 0x00 | DITHER AMP2: -4 = 0x40, 0 = 0x00 | 0xAF | 0x18 | |
| 0x04 | 0x01 | | 0xAF | 0x10 | 0x10 = dither ENABLED, 0x90 = dither DISABLED |
| 0x20 | 0x04 | | 0x04 | 0x01 | |
| 0x91 | 0x40 | | 0x20 | 0x00 | |
| 0xAF | 0x10 | | 0x04 | 0x00 | |

7.3.2 Sampling Clock Input

The internal sampling clock path was designed for lowest residual phase noise contribution. The sampling clock circuitry requires a dedicated low noise power supply for best performance. The internal residual clock phase noise is also sensitive to clock amplitude. For best performance, the clock amplitude should be larger than 1 V_{PP}. The phase noise ideally improves by 3 dB per 2x averaging, however at higher input frequencies the clock path contribution reduces the improvement.

**Table 7-7. Internal Aperture Clock Phase Noise
(F_S = 3 Gsps, V_{IN} = 1 V_{PP})**

| Frequency Offset (MHz) | Amplitude (dBc/Hz) |
|------------------------|--------------------|
| 0.001 | -117 |
| 0.01 | -127 |
| 0.1 | -137 |
| 1 | -147 |
| 10 | -154 |
| 250 | -160 |

The clock input and ADC sampling circuitry also have an amplitude noise component which modulates on to the sampled input signal. Unlike phase noise, the amplitude noise does not scale with input frequency, it is only affected by the sampling reset switch as shown in Figure 7-10 and Figure 7-11. This noise component can dominate the close in noise performance at lower input frequencies.

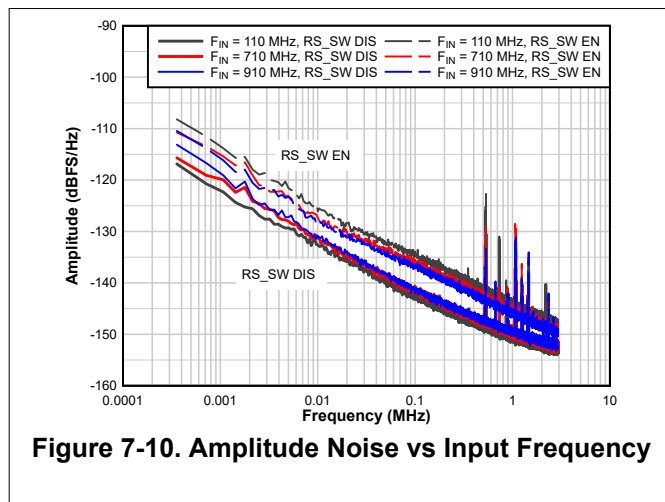


Figure 7-10. Amplitude Noise vs Input Frequency

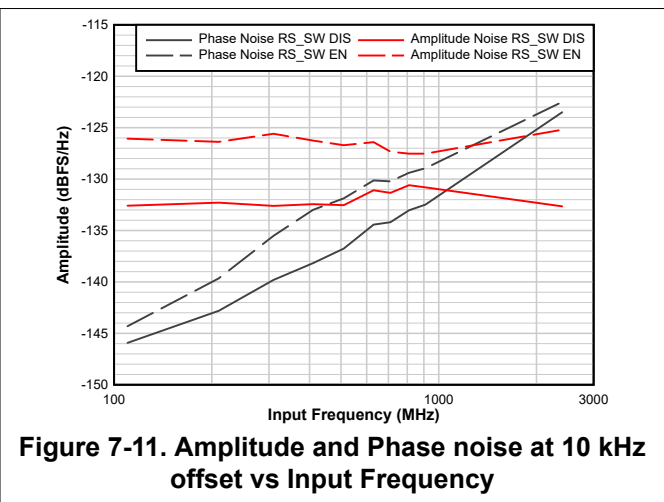
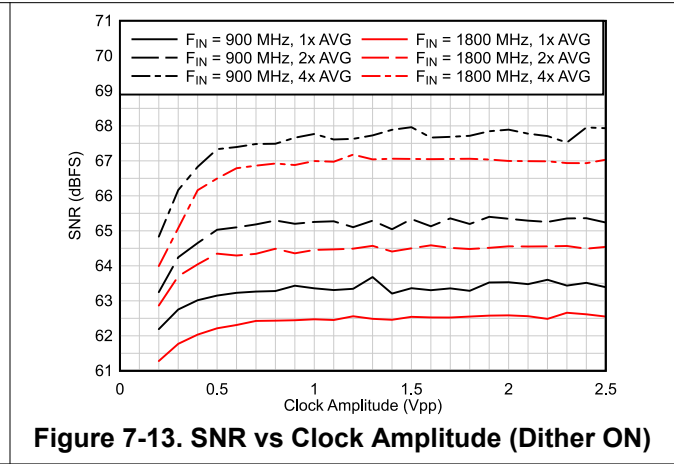
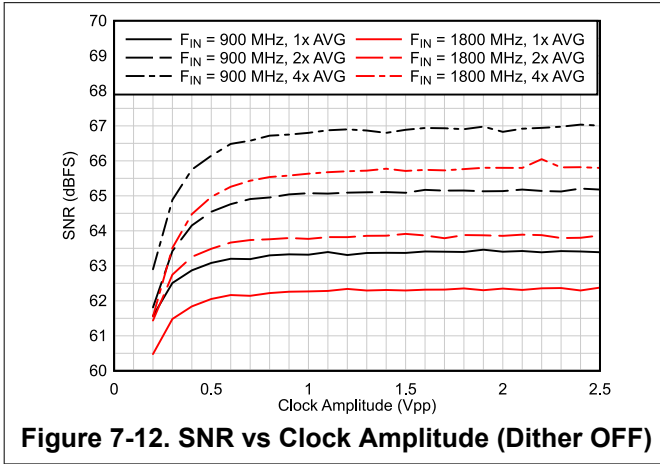


Figure 7-11. Amplitude and Phase noise at 10 kHz offset vs Input Frequency

The internal aperture jitter is also dependent on the amplitude of the external clock input signal. Figure 7-12 and Figure 7-13 show the expected SNR performance with dither on/off across clock amplitude ($F_S = 2.6$ GSPS).



The sampling clock input is internally terminated to $100\ \Omega$ differentially and provides a return loss better than 10 dB at 3 GHz (see Figure 7-14). The clock input consists of a single clock input buffer followed by a dedicated clock buffer for ADCA1/2 as well as ADCB1/2. When averaging multiple ADCs, there are some close in clock buffer noise which is correlated; and thus, does not improve with averaging.

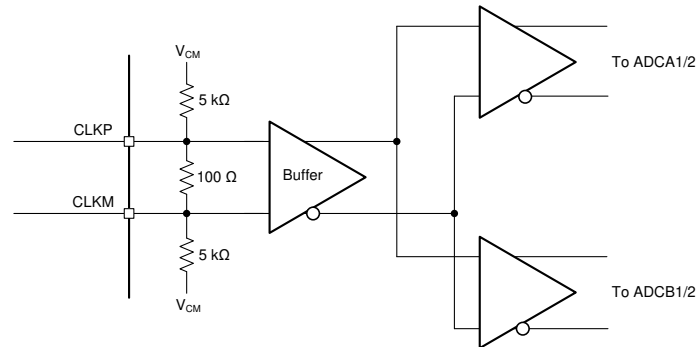


Figure 7-14. Internal Clock Input Routing

7.3.3 SYSREF

The SYSREF input signal is used to reset internal digital blocks and align them to the internal multi-frame clock in order to achieve deterministic latency subclass 1. The SYSREF input signal can be AC or DC coupled (selected via SPI register option) as shown in [Figure 7-15](#). The ADC32RF5x has internal 100-Ω termination for DC coupling and internal biasing when using AC coupling.

A register mask can be used to only give SYSREF to the NCO (see NCO section) in the decimation filter block, and leave all other blocks such as JESD interface unaffected.

When giving a periodic SYSREF signal, its frequency is required to be a sub-harmonic of the internal local multi-frame clock (LMFC). The LMFC frequency is determined by the selected decimation, frames per multi-frame setting (K), samples per frame (S) and the device sampling frequency (FS).

Table 7-8. LMFC and SYSREF settings for different operating modes

| Operating Mode | LMFS Mode | LMFC Clock Frequency | SYSREF Frequency |
|-----------------|-----------|----------------------|------------------------|
| DDC Bypass Mode | 82820 | $FS / (20 * K)$ | $FS / (N * 20 * K)$ |
| | 8224 | $FS / (4 * K)$ | $FS / (N * 4 * K)$ |
| Decimation | Various | $FS / (D * S * K)$ | $FS / (N * D * S * K)$ |

where N is an integer value (1, 2, 3...)

After enabling SYSREF input, the internal SYSREF input ignores any incoming SYSREF pulse after the first 16 pulses.

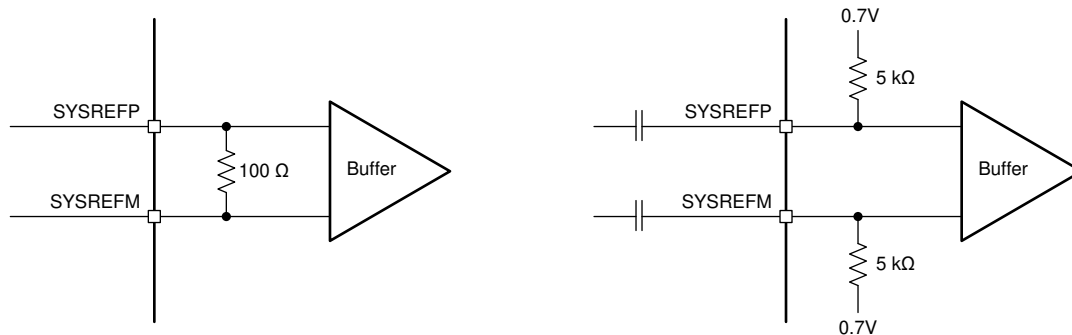


Figure 7-15. SYSREF Input Circuitry and Edge Alignment

The internal synchronization using the external SYSREF signal can be enabled with the following register writes (see [Table 7-9](#))

Table 7-9. Register Write Example for Enabling SYSREF Synchronization

| ADDR | DATA | DESCRIPTION |
|-------|------|---|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x236 | 0x02 | Enable internal SYSREF input and clear SYSREF pulse counter |
| 0x236 | 0x03 | Starts internal SYSREF counter |

AC coupling with internal biasing of the SYSREF input can be enabled with the following SPI register writes (see [Table 7-10](#))

Table 7-10. Register Write Example for Enabling SYSREF AC Coupling

| ADDR | DATA | DESCRIPTION |
|------|------|---|
| 0x05 | 0x40 | Select ANALOG page |
| 0xB4 | 0x01 | Enable external AC coupling with internal biasing on SYSREF |

7.3.3.1 SYSREF Capture Detection

The SYSREF input signal rising edge should be edge aligned with the rising edge of the sampling clock in order to maximize the setup and hold times. The ADC32RF5x includes an internal SYSREF monitoring circuitry to detect possible metastability resulting in a clock cycle slip; and thus, misalignment across devices.

The sampling clock gets delayed by ~160 ps and then captures the SYSREF signal. The SYSREF monitoring circuitry captures the SYSREF signal ± 50 ps (-50, -25, +16, +32, +48 ps) around the main SYSREF capture. In ideal conditions no SYSREF transition happens within the 100 ps SYSREF capture window and all XOR flags show "0". If a SYSREF/clock misalignment happens and the SYSREF transition falls within the SYSREF monitoring window, then one of the XOR flags (which monitor adjacent SYSREF captures within the window) shows a "1" and the SYSREF can be adjusted externally.

The SYSREF monitor registers are not *sticky* registers, which are updated at every rising edge of SYSREF.

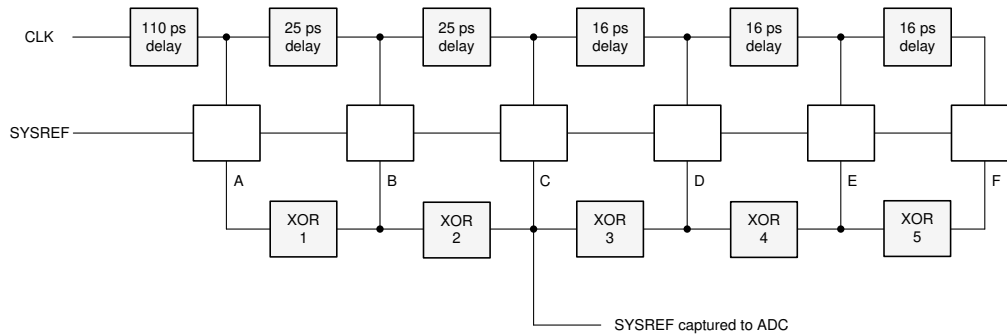


Figure 7-16. SYSREF Detection Circuitry

Figure 7-17 shows a misaligned SYSREF signal where the SYSREF signal arrives much later than the sampling clock rising edge. The SYSREF window feature checks if the SYSREF transition is within ± 50 ps of the instant when the SYSREF signal gets captured by the sampling clock.

In this example, the delayed SYSREF signal transitions between the "B" and "C" flip flop which raises the XOR2 flag. The XOR flags get reported in register 0x22F in the digital page. In this example, Register 0x22F reads back 0x8B, as shown in Table 7-11.

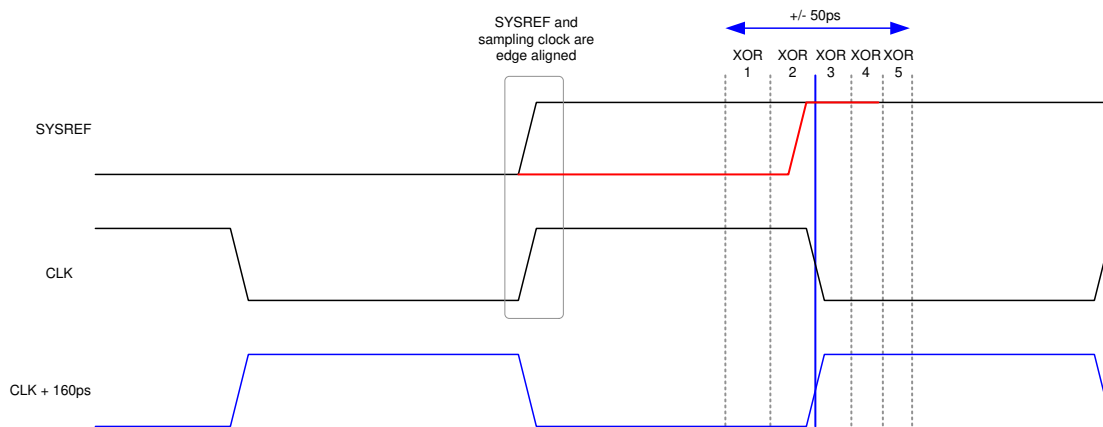


Figure 7-17. Detection of SYSREF Transition Within Capture Window

Table 7-11. SYSREF Window Register Example (0x22F)

| ADDR | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-------|----|-----------|-----------|-----------|-----------|-----------|-----------|----|
| 0x22F | 1 | SYSREF X5 | SYSREF X4 | SYSREF X3 | SYSREF X2 | SYSREF X1 | SYSREF OR | 1 |
| | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 |

7.3.4 ADC Foreground Calibration

The internal ADC architecture is sensitive to temperature changes. The devices contains two additional internal ADC cores. One for channel A1/2, and one for channel B1/2 which are used when one of the ADCs is in calibration. The ADCs are calibrated as pairs where one ADC at a time is connected to the internal calibration DAC. The calibration is configured via SPI register writes and can be executed using SPI register writes or using the GPIO1 pin. When executed, the calibration takes $\sim 23 \text{ ms} \times 3 \text{ GSPS} / F_S$ per ADC pair ($\sim 11.5 \text{ ms} \times 3 \text{ GSPS} / F_S$ per ADC). The example in [Figure 7-18](#) shows 2x internal averaging where 4 ADC cores (#1, #2 for chA1 and #6, #7 for chB1) are used in operation and ADCs #5 and #10 for calibration.

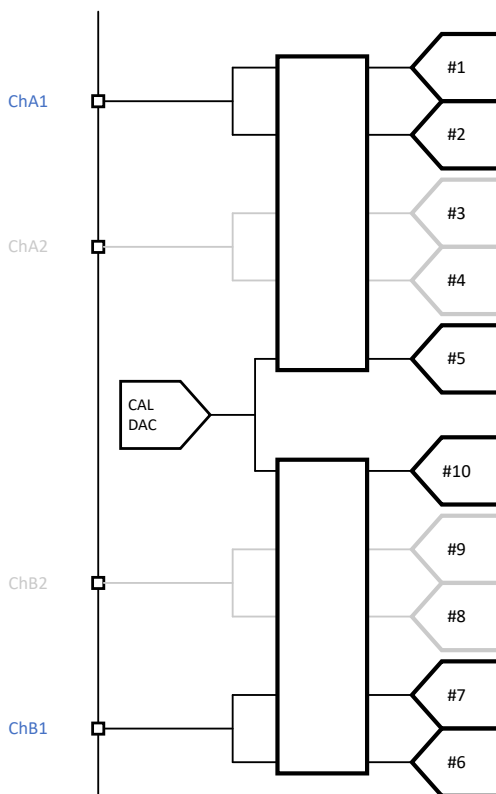


Figure 7-18. Internal ADC setup for 2x averaging mode

7.3.4.1 Calibration Control

Figure 7-19 shows a timing diagram of the calibration control using GPIO1 pin.

When GPIO1 transitions to LOW logic state:

- an ADC pair gets swapped out within ~ 120 ns
- a new calibration gets triggered immediately

If GPIO1 is being held low when the calibration of an ADC pair is completed, the next ADC pair is switched and a new calibration is triggered. The order in which ADC pair are calibrated is configured via SPI to serial or random.

When using 2x averaging for example, the calibration is executed for 3 ADC pairs to make sure all ADCs in use have been recently calibrated.

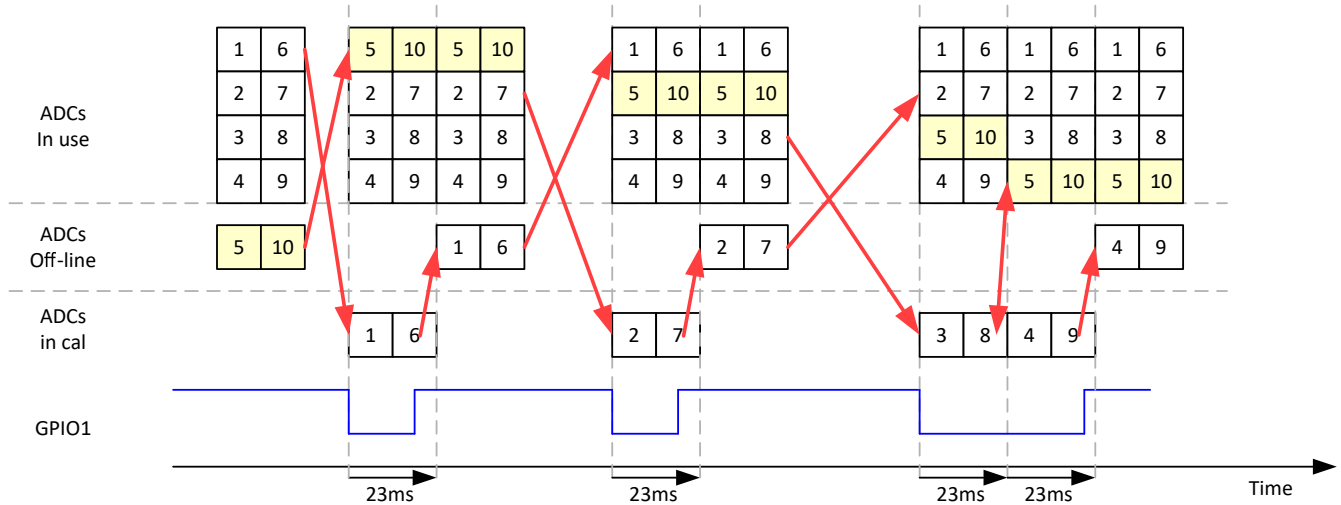


Figure 7-19. Timing Diagram - Calibration (4x AVG Example)

Figure 7-20 shows the ADC switch happens approximate 120 ns after the logic level change on GPIO1 is detected.

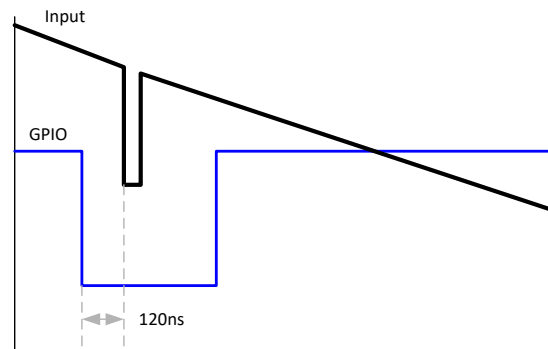
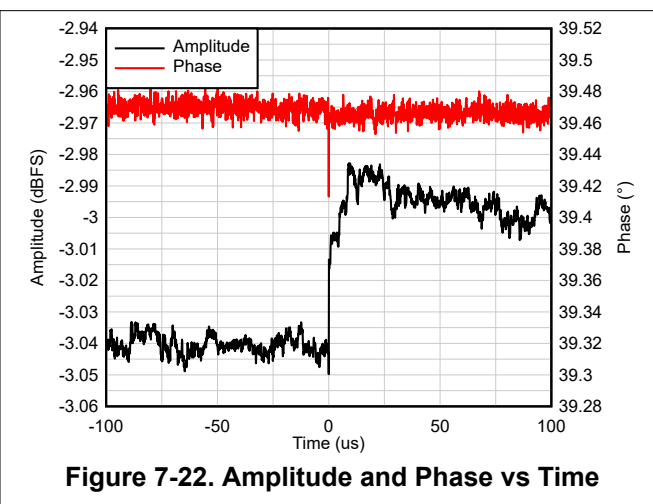
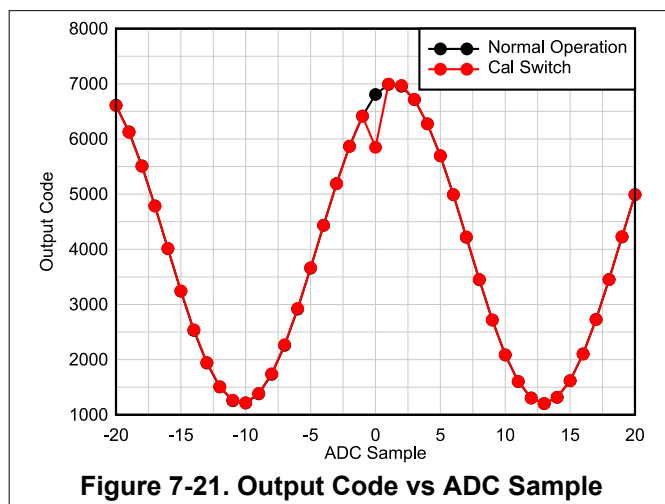


Figure 7-20. Timing Diagram Shows the ADC Switch

7.3.4.2 ADC Switch

During the ADC transition, the amplitude drops for 1-2 samples as shown in [Figure 7-21](#). The gain variation from one ADC to the next is $\sim < 0.05$ dB while the phase change is less 0.01 deg as shown in [Figure 7-22](#).



7.3.4.3 Calibration Configuration

The ADC32RF5x provides 3 different options to configure the internal foreground calibration:

- Calibrate all ADCs one time using SPI trigger (after initial power up or during operation) - see [Table 7-12](#)
- Continuous calibration - see [Table 7-13](#)
- Calibrate 2 ADC pairs at a time using GPIO trigger - see [Table 7-14](#)

The status of the calibration can be read back from register 0x298 (CALIBRATION page). Successful calibration reads back 0x0E on the 4 LSB of that register.

Table 7-12. Register Writes for power up calibration or SINGLE calibration of all ADCs Using SPI

| ADDR | DATA | DESCRIPTION |
|------|------|---------------------------------------|
| 0x05 | 0x20 | Select CALIBRATION page |
| 0x46 | 0x02 | |
| 0x45 | 0x8A | Toggle calibration start |
| 0x45 | 0x0A | |
| wait | | 1.3 seconds x 3 GSPS / F _S |

Table 7-13. Register Writes to Trigger CONTINUOUS Calibration of all ADCs Using SPI

| ADDR | DATA | DESCRIPTION |
|------|------|-------------------------|
| 0x05 | 0x20 | Select CALIBRATION page |
| 0x46 | 0x03 | |
| 0x45 | 0x0A | |

Table 7-14. Register Writes to Trigger ADC Pair Calibration Using the GPIO Pin

| ADDR | DATA | DESCRIPTION |
|-------|------|--|
| 0x05 | 0x20 | Select CALIBRATION page |
| 0x46 | 0x02 | |
| 0x45 | 0x4A | |
| 0x05 | 0x02 | Select DIGITAL page |
| 0x234 | 0x04 | Use GPIO1 pin to freeze calibration switch |

7.3.5 Decimation Filter

The ADC32RF5x provides up to four digital down converters per ADC channel, see [Figure 7-23](#). The decimation filters provide a flexible option to cover a wide range of instantaneous bandwidths (IBW) as shown in [Table 7-15](#). Single band decimation supports a wide bandwidth up to complex decimation by 4x while up to four narrow band channels with up to 128x complex decimation are supported in quad band decimation mode.

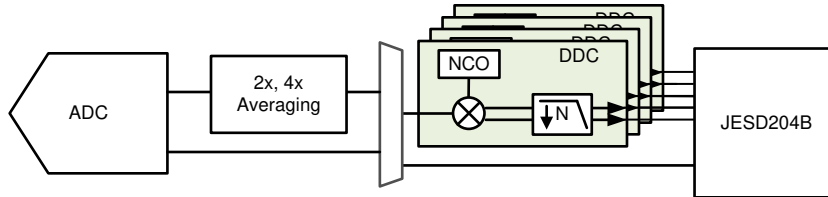


Figure 7-23. Digital Decimation Filter Options

Table 7-15. Summary of Different Decimation Filter Band Options

| # of DDCs | Minimum Complex Decimation | Maximum Complex Decimation |
|-----------|----------------------------|----------------------------|
| 1 | 4 | 128 |
| 2 | 8 | 128 |
| 4 | 16 | 128 |

The decimation filter can be configured to two different operating modes:

- **Complex Decimation:** This mode provides complex output with ~ 80% passband bandwidth using a 48-bit phase coherent NCO.
During the complex mixing operation the digital output is reduced by 6-dB. This reduces the fullscale from 0-dBFS to -6-dBFS. This 6-dB change applies to signals and noise and thus no dynamic range is lost.
- **Real Decimation:** In real decimation mode, the complex mixer is bypassed (NCO is set to 0 for lowest power consumption), and the digital filter acts as a low pass filter. There is no frequency shifting and the output passband bandwidth is ~ 40%.

Since the JESD204B interface is common across ADC channel A and B, the decimation ratio as well as the # of DDCs/ADC has to be the same across channels A and B.

By default, the output of values of the decimation filter are rounded to 16-bit resolution. In order to avoid quantization noise limitation when using high order of decimation (that is /64 or /128), a special 20-bit output mode can be enabled (see [20-bit Output Mode](#)).

[Table 7-16](#) provides an overview of the available complex decimation settings and resulting complex and real output bandwidths.

Table 7-16. Complex Decimation Setting vs Output Bandwidth

| Decimation Factor N (complex) | Complex Output Bandwidth per DDC | $F_S = 3 \text{ Gbps}$ | | Real Output Bandwidth per DDC | $F_S = 3 \text{ Gbps}$ | |
|-------------------------------|----------------------------------|-----------------------------|----------------------------------|-------------------------------|--------------------------|-------------------------------|
| | | Complex Output Rate per DDC | Complex Output Bandwidth per DDC | | Real Output Rate per DDC | Real Output Bandwidth per DDC |
| 4 | $0.8 \times F_S / 4$ | 750 Msps | 600 MHz | $0.4 \times F_S / 4$ | 750 Msps | 300 MHz |
| 8 | $0.8 \times F_S / 8$ | 375 Msps | 300 MHz | $0.4 \times F_S / 8$ | 375 Msps | 150 MHz |
| 16 | $0.8 \times F_S / 16$ | 187.5 Msps | 150 MHz | $0.4 \times F_S / 16$ | 187.5 Msps | 75 MHz |
| 32 | $0.8 \times F_S / 32$ | 93.75 Msps | 75 MHz | $0.4 \times F_S / 32$ | 93.75 Msps | 37.5 MHz |
| 64 | $0.8 \times F_S / 64$ | 46.875 Msps | 37.5 MHz | $0.4 \times F_S / 64$ | 46.875 Msps | 18.75 MHz |
| 128 | $0.8 \times F_S / 128$ | 23.4375 Msps | 18.75 MHz | $0.4 \times F_S / 128$ | 23.4375 Msps | 9.375 MHz |

7.3.5.1 Decimation Filter Response

This section provides the different decimation filter responses with a normalized ADC sampling rate. The complex filter pass band is ~ 80% (-1 dB) with a minimum of 85 dB stop band rejection.

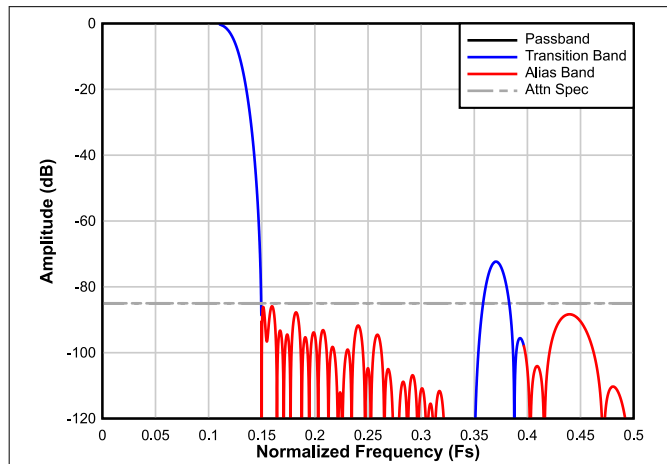


Figure 7-24. Complex Decimation by 4 Filter Response

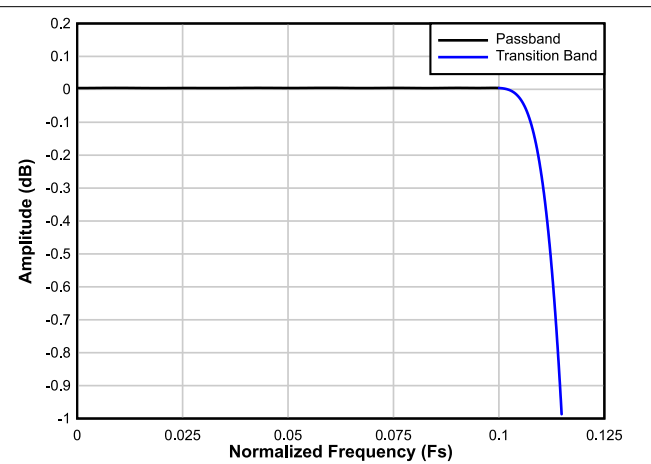


Figure 7-25. Decimation by 4 Passband Ripple Response

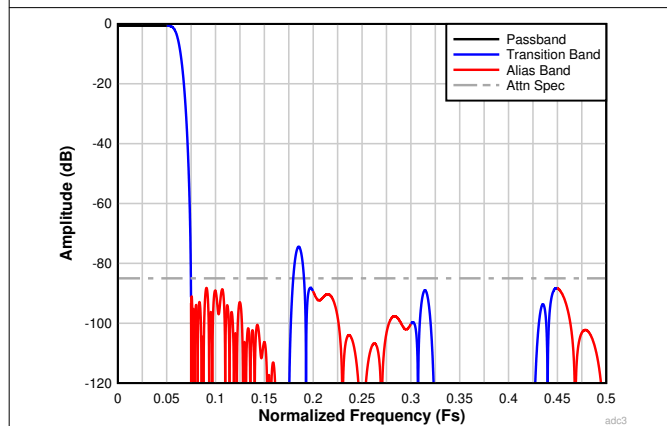


Figure 7-26. Complex Decimation by 8 Filter Response

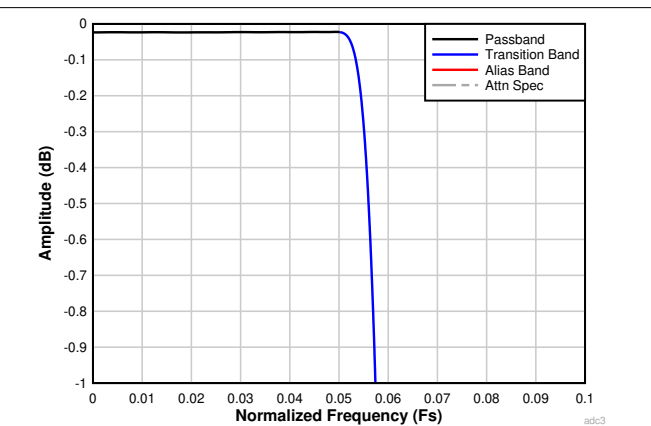


Figure 7-27. Decimation by 8 Passband Ripple Response

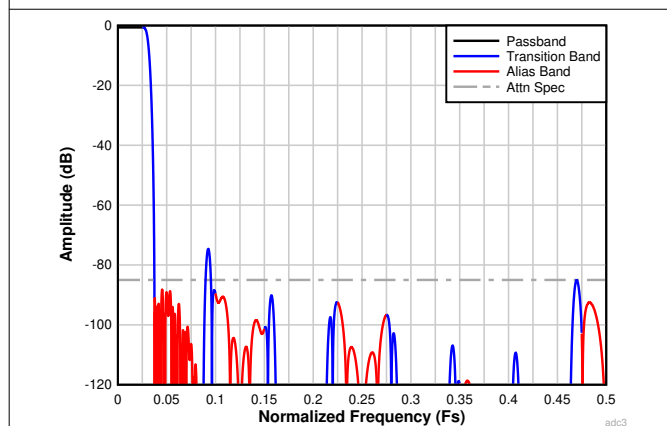


Figure 7-28. Complex Decimation by 16 Filter Response

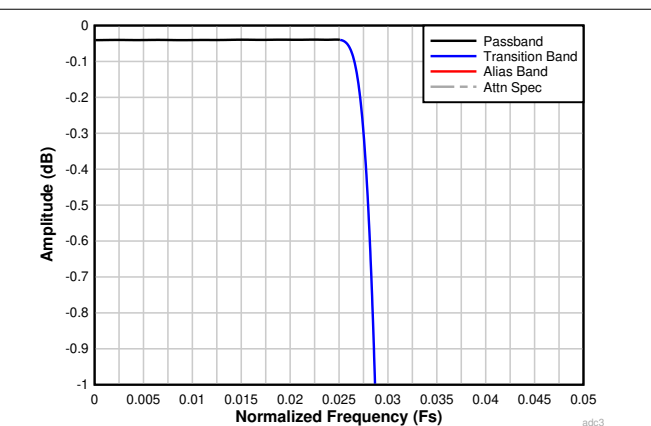


Figure 7-29. Decimation by 16 Passband Ripple Response

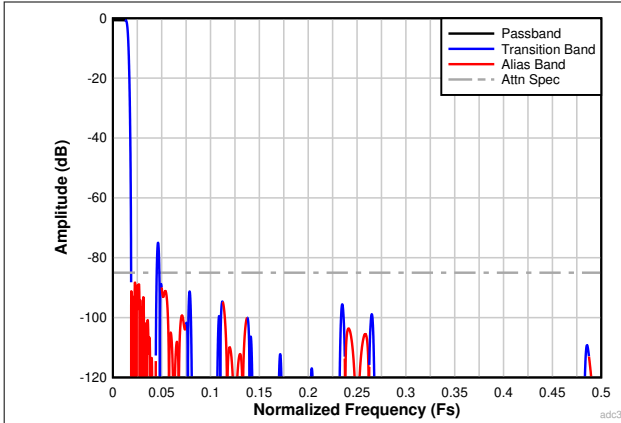


Figure 7-30. Complex Decimation by 32 Filter Response

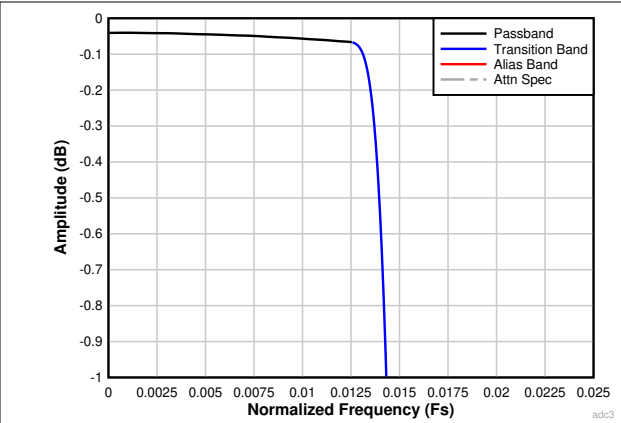


Figure 7-31. Decimation by 32 Passband Ripple Response

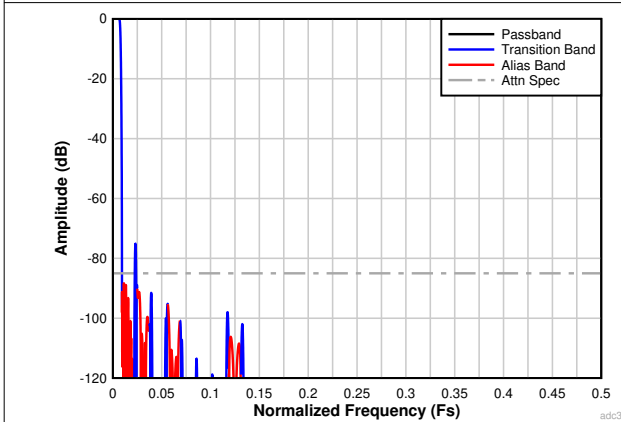


Figure 7-32. Complex Decimation by 64 Filter Response

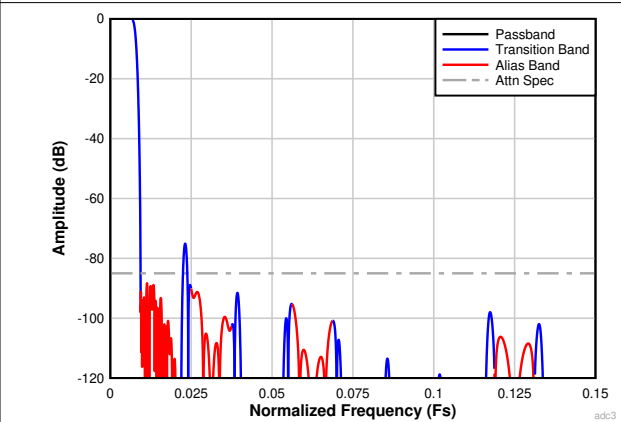


Figure 7-33. Complex Decimation by 64 Filter Response

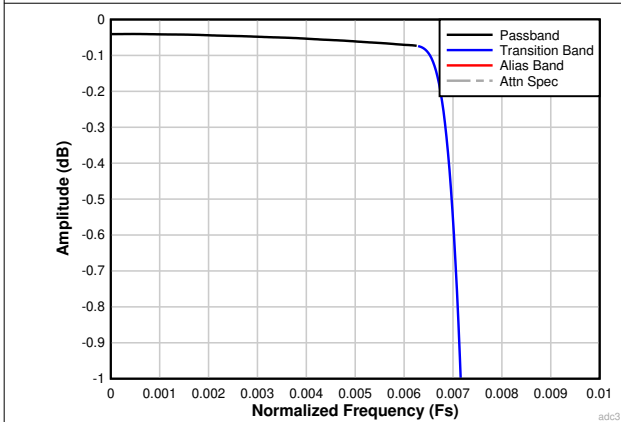


Figure 7-34. Decimation by 64 Passband Ripple Response

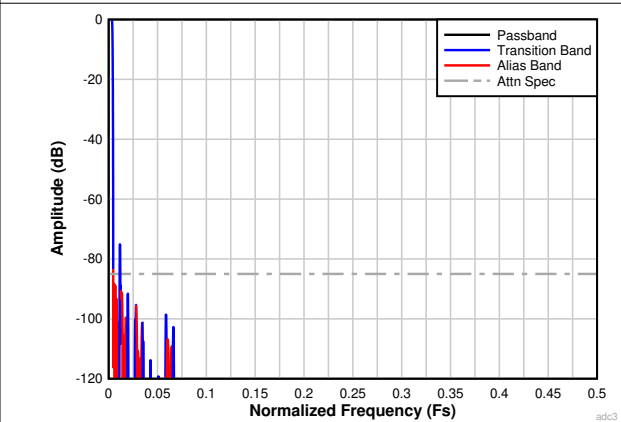
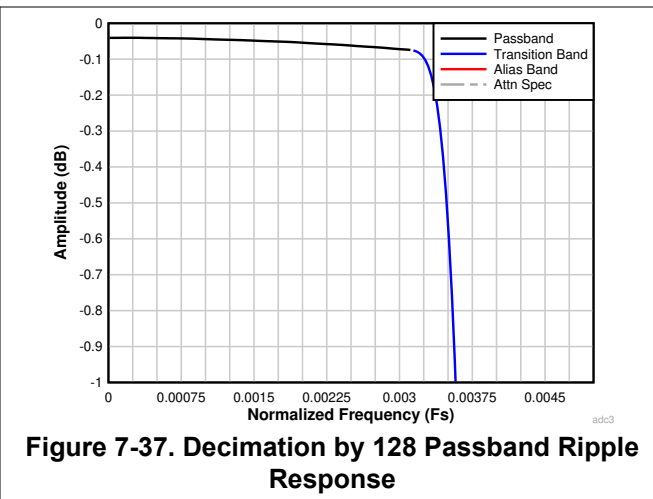
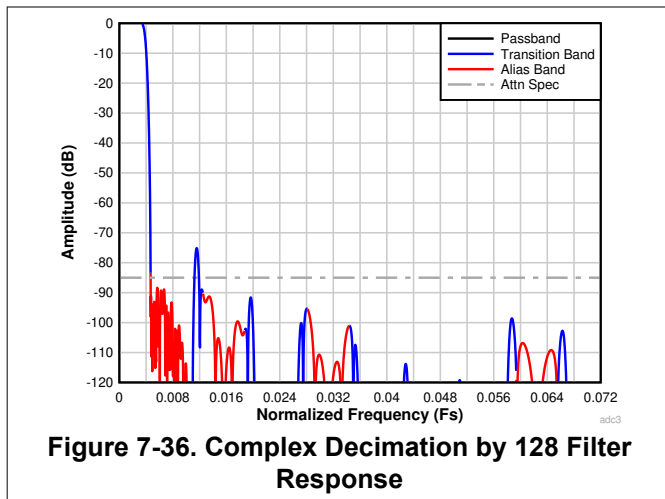


Figure 7-35. Complex Decimation by 128 Filter Response



7.3.5.2 Decimation Filter Configuration

The decimation filter is configured with these register writes.

Table 7-17. Register Writes to Enable the Internal Decimation Filter

| ADDR | DATA | DESCRIPTION |
|------|------|---------------------------------|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x2C | | Select single/dual/quad band |
| 0x2D | | Select decimation |
| 0x05 | 0x04 | Select JESD page |
| 0x22 | | Select LMFS mode |
| 0x24 | | Select DDC CLK setting |
| 0x25 | | Select JESD TX CLK DIV setting |
| 0x9F | | Select JESD PLL 1/2 settings |
| 0xA0 | | Select JESD PLL INPUT1 setting |
| 0xA1 | | Select JESD PLL INPUT2 settings |
| 0xA2 | | Select JESD PLL INPUT3 settings |

7.3.5.3 20-bit Output Mode

The device includes a 20-bit output resolution mode which can be used for high order decimation (that is. 64x, 128x) in order to avoid SNR degradation due to quantization noise limitation. In this mode the output data is transmitted at 2x the output rate. The 20-bit sample from the DDC gets expanded to 32-bit by adding 12x 0s, and occupies 2 consecutive 16-bit samples. This doubles the number of octets 'F' and the proper LMFS mode and JESD PLL settings have to be selected.

For example, a single band complex decimation would go from LMFS = 2441 (16-bit output mode) to LMFS = 2481 (20-bit output mode) as illustrated in [Table 7-18](#).

Table 7-18. JESD Frame Assembly Comparison between 16-bit and 20-bit Output Mode

| LMFS = 2441 | | | | LMFS = 2481 | | | | | | | | |
|------------------------|-----------------------|------------------------|-----------------------|-------------------------|-------------------------|------------------------|-----------------------|-------------------------|-------------------------|------------------------|-----------------------|--|
| xI ₀ [15:8] | xI ₀ [7:0] | xQ ₀ [15:8] | xQ ₀ [7:0] | xI ₀ [31:24] | xI ₀ [23:16] | xI ₀ [15:8] | xI ₀ [7:0] | xQ ₀ [31:24] | xQ ₀ [23:16] | xQ ₀ [15:8] | xQ ₀ [7:0] | |
| | | | | 20-bit sample I | | | | 0000 0000000 | 20-bit sample Q | | | |
| | | | | | | | | | | | 0000 0000000 | |

The 20-bit output mode is enabled by setting D7 in 0x2C (DIGITAL page) and selecting viable decimation and LMFS mode.

7.3.5.4 Dynamic Switching

The ADC32RF5x supports a dynamic switch mode between two decimation filter configurations without the need to resynchronize the JESD204B interface. This enables support for single, wideband DDC and 4 narrow band DDCs that can be switched in between with minimum impact on latency.

Two different configurations are supported in the dynamic switching mode. Each configuration maintains the # of serdes lanes and serdes output rate during the switch. [Table 7-19](#) shows the specific supported configurations for LMFS and decimation settings for a 2 lane and a 1 lane setup. Since the amount of output data in quad band mode is four times larger compared to single band, the decimation factor in quad band mode needs to be reduced by a factor of four compared to the single band case.

Table 7-19. Dynamic switch configuration modes

| | Single Band DDC | | Quad Band DDC | |
|---------|-----------------|--------------------|---------------|--------------------|
| | LMFS | Complex Decimation | LMFS | Complex Decimation |
| 2 lanes | 2-4-16-4 | /16 | 2-16-16-1 | /64 |
| 1 lane | 1-4-32-4 | /32 | 1-16-32-1 | /128 |

There is no information in the JESD204B output data stream indicating if the output data is quad band or single band. The JESD204B receiving device controls the switching and thus needs to decode the incoming data for quad band or single band mode. The LMFS value transmitted ILA when the JESD204B link is established is always from the quad band mode in order to avoid ILA errors at the start of the link.

The dynamic switch is configured with these register writes:

Table 7-20. Dynamic switch configuration writes

| 2 Lanes: 2-4-16-4 to 2-16-16-1 | | 1 Lane: 1-4-32-4 to 1-16-32-1 | |
|---|---|---|--|
| Configure ADC 2-16-16-1, Decimation by 64 | | Configure ADC to 1-16-32-1, Decimation by 128 | |
| 0x05, 0x02 | Select DIGITAL page | 0x05, 0x02 | Select DIGITAL page |
| 0x373, 0x04 | Configures internal clockings | 0x373, 0x05 | Configures internal clockings |
| 0x388, 0x12 | | 0x388, 0x16 | |
| 0x388, 0x32 | Bit D5 enables dynamic switch: 0x32: LMFS = 2-4-16-4, /16 0x12: LMFS = 2-16-16-1, /64 | 0x388, 0x36 | Bit D5 enables dynamic switch: 0x36: LMFS = 1-4-32-4, /32 0x16: LMFS = 1-16-32-1, /128 |

7.3.5.4.1 2 Lane Mode

JESD transmit (TX) will operate in LMFS = 2-16-16-1 in both the quad and single band modes. The JESD receiver should be configured to and switched between 2-4-16-4 and 2-16-16-1.

Table 7-21. 2 Lane Dynamic Switch Frame Assembly

| LMFS | FRAME ASSEMBLY | | | | | | | | | | | | | | | |
|-----------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|
| 2-16-16-1 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] | A4Q ₀ [7:0] |
| | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] |
| 2-4-16-4 | AI ₀ [15:8] | AI ₀ [7:0] | AI ₁ [15:8] | AI ₁ [7:0] | AI ₂ [15:8] | AI ₂ [7:0] | AI ₃ [15:8] | AI ₃ [7:0] | AQ ₀ [15:8] | AQ ₀ [7:0] | AQ ₁ [15:8] | AQ ₁ [7:0] | AQ ₂ [15:8] | AQ ₂ [7:0] | AQ ₃ [15:8] | AQ ₃ [7:0] |
| | BI ₀ [15:8] | BI ₀ [7:0] | BI ₁ [15:8] | BI ₁ [7:0] | BI ₂ [15:8] | BI ₂ [7:0] | BI ₃ [15:8] | BI ₃ [7:0] | BQ ₀ [15:8] | BQ ₀ [7:0] | BQ ₁ [15:8] | BQ ₁ [7:0] | BQ ₂ [15:8] | BQ ₂ [7:0] | BQ ₃ [15:8] | BQ ₃ [7:0] |

7.3.5.4.2 1 Lane Mode

JESD transmit (TX) will operate in LMFS = 1-16-32-1 in both the quad and single band modes. The JESD receiver should be configured, and switched between 1-4-32-4 and 1-16-32-1.

Table 7-22. 2 Lane Dynamic Switch Frame Assembly

| LMFS | FRAME ASSEMBLY | | | | | | | | | | | | | | | | |
|-----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|---------------------------|
| 1-16-32-1 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] | A4Q ₀ [7:0] | ... |
| | ... | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] |
| 1-4-32-4 | AI ₀ [15:8] | AI ₀ [7:0] | AI ₁ [15:8] | AI ₁ [7:0] | AI ₂ [15:8] | AI ₂ [7:0] | AI ₃ [15:8] | AI ₃ [7:0] | AQ ₀ [15:8] | AQ ₀ [7:0] | AQ ₁ [15:8] | AQ ₁ [7:0] | AQ ₂ [15:8] | AQ ₂ [7:0] | AQ ₃ [15:8] | AQ ₃ [7:0] | ... |
| | ... | BI ₀ [15:8] | BI ₀ [7:0] | BI ₁ [15:8] | BI ₁ [7:0] | BI ₂ [15:8] | BI ₂ [7:0] | BI ₃ [15:8] | BI ₃ [7:0] | BQ ₀ [15:8] | BQ ₀ [7:0] | BQ ₁ [15:8] | BQ ₁ [7:0] | BQ ₂ [15:8] | BQ ₂ [7:0] | BQ ₃ [15:8] | BQ ₃ [7:0] |

7.3.5.5 Numerically Controlled Oscillator (NCO)

Each digital down-converter (DDC) uses a 48-bit numerically controlled oscillator (NCO) to fine tune the frequency placement prior to the digital filtering. Different NCO frequencies for each DDC are programmed using SPI register writes and the desired NCO frequency can be selected using SPI or the GPIO pins. When using the GPIO pins for NCO frequency control, frequency hopping can be achieved in less than 1 μ s. The digital NCO is designed to have a SFDR of at least 100 dB. The number of available, programmable NCO frequencies depends on # of DDC bands used as illustrated in Table 7-23.

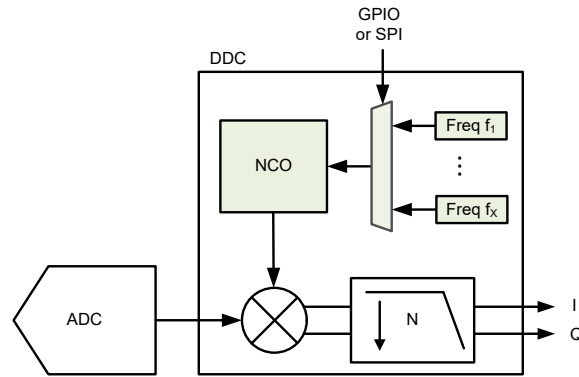


Figure 7-38. NCO Block Diagram

Table 7-23. Available # of Frequencies per NCO Depending on # of DDCs Used

| # of DDCs used | # of Frequencies per NCO |
|----------------|--------------------------|
| 1 | 8 |
| 2 | 4 |
| 4 | 4 |

There are two NCO operating modes (0x180 in DDC page): phase continuous and infinite phase coherent.

Phase Continuous NCO: During a NCO frequency change, the NCO phase gradually adjusts to the new frequency as shown in Figure 7-39. The *dashed* line shows the phase of original f_1 frequency.

Infinite Phase Coherent NCO: With a phase coherent NCO, all frequencies are synchronized to a single event using SYSREF. This enables an infinite amount of frequency hops without the need to reset the NCO as phase coherency is maintained between frequency hops. This is illustrated in Figure 7-39 (right). When returning to the original frequency f_1 , the NCO phase appears as if the NCO had never changed frequencies.

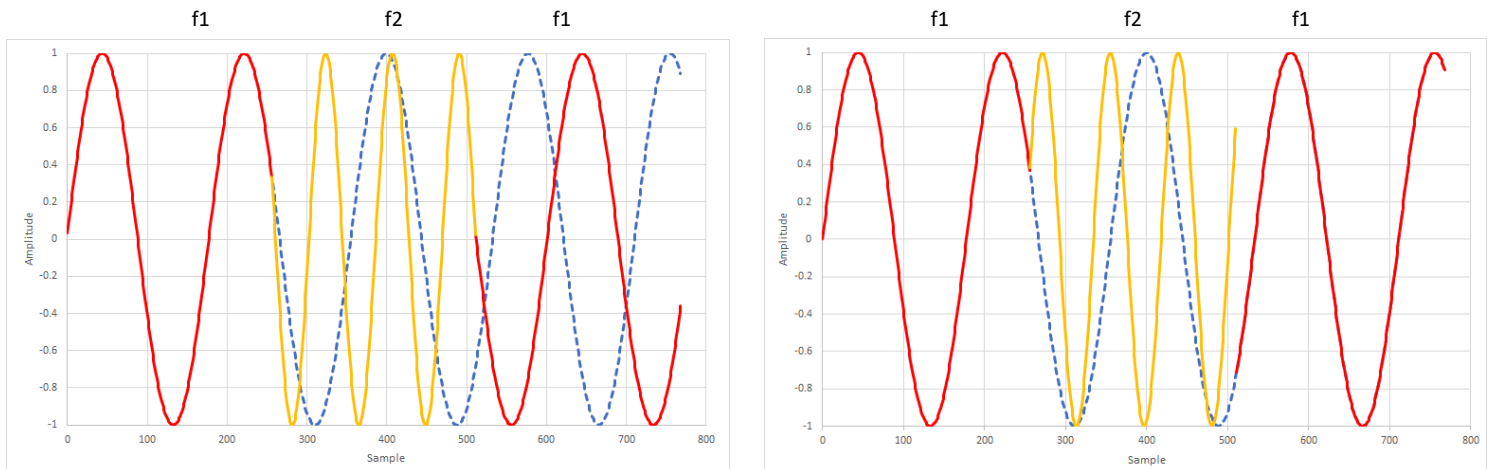


Figure 7-39. Phase Continuous (left) and Infinite Phase Coherent (right) NCO Frequency Switching

The oscillator generates a complex exponential sequence of:

$$e^{j\omega n} \text{ (default) or } e^{-j\omega n} \quad (1)$$

where: frequency (ω) is specified as a signed number by the 48-bit register setting

The complex exponential sequence is multiplied with the real input from the ADC to mix the desired carrier to a frequency equal to $f_{IN} + f_{NCO}$. The NCO frequency can be tuned from $-F_S/2$ to $+F_S/2$ and is processed as a signed, 2s complement number.

The NCO frequency setting is set by the 48-bit register value given and calculated as:

$$\text{NCO frequency (0 to } +F_S/2\text{): } NCO = f_{NCO} \times 2^{48} / F_S \quad (2)$$

$$\text{NCO frequency } (-F_S/2 \text{ to } 0\text{): } NCO = (f_{NCO} + F_S) \times 2^{48} / F_S \quad (3)$$

where:

- NCO = NCO register setting (decimal value)
- f_{NCO} = Desired NCO frequency (MHz)
- F_S = ADC sampling rate (MSPS)

The NCO programming is illustrated with this example:

- ADC sampling rate $F_S = 3000$ MSPS
- Desired NCO frequency = 920 MHz

$$\text{NCO frequency setting} = f_{NCO} \times 2^{48} / F_S = 920 \text{ MHz} \times 2^{48} / 3000 \text{ MSPS} = 86,318,992,857,935 \quad (4)$$

Table 7-24 shows the register writes to set frequency 1 of NCO1 of DDCA to that frequency:

Table 7-24. Example Register Writes to Change NCO Frequency

| ADDR | DATA | DESCRIPTION |
|-------|------|---|
| 0x05 | 0x08 | Select DDCA page |
| 0x105 | 0x4E | Set frequency to 920 MHz (86,318,992,857,935) which is 0x4E81B4E81B4E starting MSB in 0x105. |
| 0x104 | 0x81 | |
| 0x103 | 0xB4 | |
| 0x102 | 0xE8 | |
| 0x101 | 0x1B | |
| 0x100 | 0x4E | |
| 0x180 | 0x01 | Enable phase coherent NCO mode |
| 0x181 | 0x00 | Load and update NCO1 with the new frequency. 0x30 updates the NCO values, 0x00 clears the register for the next update. |
| 0x181 | 0x30 | |

7.3.5.6 NCO Frequency Programming

There are 4 separate NCOs per channel - one for each band (such as, NCO1 = band 1) and 4 different frequencies can be programmed per NCO as shown in [Figure 7-40](#). The NCO frequencies are located in the DDCA/B pages (0x05 0x08 for channel A and 0x05 0x10 for channel B) in registers 0x100 to 0x17D. Depending on # of bands used, the frequencies for each NCO are selected in registers 0x3B and 0x41 (DIGITAL page) as shown in [Table 7-25](#). If the NCO frequencies are the same for channel A and channel B, they can be written to both DDCA and DDCB pages simultaneously by selecting both pages (0x05 0x18).

Channel A Channel B

| | | | |
|-----------------|-----------------|-----------------|-----------------|
| NCO1 | NCO3 | NCO1 | NCO3 |
| 1: 0x100..0x105 | 1: 0x140..0x145 | 1: 0x100..0x105 | 1: 0x140..0x145 |
| 2: 0x108..0x10D | 2: 0x148..0x14D | 2: 0x108..0x10D | 2: 0x148..0x14D |
| 3: 0x110..0x115 | 3: 0x150..0x155 | 3: 0x110..0x115 | 3: 0x150..0x155 |
| 4: 0x118..0x11D | 4: 0x158..0x15D | 4: 0x118..0x11D | 4: 0x158..0x15D |
| NCO2 | NCO4 | NCO2 | NCO4 |
| 1: 0x120..0x125 | 1: 0x160..0x165 | 1: 0x120..0x125 | 1: 0x160..0x165 |
| 2: 0x128..0x12D | 2: 0x168..0x16D | 2: 0x128..0x12D | 2: 0x168..0x16D |
| 3: 0x130..0x135 | 3: 0x170..0x175 | 3: 0x130..0x135 | 3: 0x170..0x175 |
| 4: 0x138..0x13D | 4: 0x178..0x17D | 4: 0x138..0x13D | 4: 0x178..0x17D |

Figure 7-40. Multi-Band NCO

Single band DDC uses the frequencies of both NCO1 and NCO2 for a combined 8 different frequencies for NCO1 using 3 bit control (NCO2 CHx [1] and NCO1 CHx [1:0]). The NCO2 selection bit (D3) decides if frequencies from NCO1 or NCO2 are being used. In dual and quad band DDC operating mode, there are 4 frequencies per NCO available and selected using 2 register bits (NCOx CHx [1:0]). The NCO frequency selection registers are shown in [Table 7-25](#).

Table 7-25. NCO Frequency Selection SPI Interface Registers

| # OF BANDS | ADDR | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------|------|----------------|----|----------------|----|----------------|----|----------------|----|
| SINGLE | 0x3B | 0 | 0 | 0 | 0 | NCO2 CHA [1] | 0 | NCO1 CHA [1:0] | |
| | 0x41 | 0 | 0 | 0 | 0 | NCO2 CHB [1] | 0 | NCO1 CHB [1:0] | |
| DUAL | 0x3B | 0 | 0 | 0 | 0 | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | 0x41 | 0 | 0 | 0 | 0 | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |
| QUAD | 0x3B | NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | 0x41 | NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |

To select a different frequency for the NCO, two registers (0x3B and 0x41) in the DIGITAL page have to be updated. Assuming a SPI clock frequency of 10 MHz (100 ns period), programming two registers (2x (16 bit address and 8 bit data) = 48 bit) means that the NCO frequency would be updated in ~ 5 us.

When updating the currently being used NCO frequency to a new frequency, the following command has to be written in order to load the new frequency into the NCO - 0x181 0x00/0x30 in each of the DDCA/B pages.

Table 7-26. Example Register Writes

| ADDR | DATA | DESCRIPTION |
|---------------|------|---|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x3B | 0x01 | Select frequency 2 for NCO1 of channel A. |
| 0x235 | 0xFF | Select NCO using SPI |
| 0x05 | 0x08 | Select DDCA page |
| 0x10D...0x108 | 0x.. | Write new frequency in frequency 2 of NCO1 of channel A |

Table 7-26. Example Register Writes (continued)

| ADDR | DATA | DESCRIPTION |
|-------|------|--|
| 0x181 | 0x00 | Update NCO with current frequencies from the register map. |
| 0x181 | 0x30 | |

The NCO phase accumulators can be reset using the external SYSREF signal. A SYSREF mask can be setup such the SYSREF signal only goes to the NCO and the remaining device remains unaffected. The following register writes configure the SYSREF mask to only affect the NCO. After completion, the SYSREF mask should be set back to default.

Table 7-27. Example Register Writes to configure the SYSREF MASK

| ADDR | DATA | DESCRIPTION |
|-------|------|---|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x357 | 0xA2 | SYSREF mask settings (0x00 is mask default) |
| 0x358 | 0x02 | SYSREF mask settings (0x00 is mask default) |

7.3.5.7 Fast Frequency Hopping

The ADC32RF5x supports several different options to update the NCO frequencies. Fast frequency hopping can be achieved in one of the following ways:

- Using the GPIO1/2 pins to select the NCO frequency
- Using the GPIO1/2, SPISEL and SCLK/SDIO pins to select the NCO frequency
- Using the GPIO1/2 pins to program the NCO frequency selection (Fast SPI)

| NCO CONTROL | SCLK | SDIO | SPISEL | GPIO1 | GPIO2 | NCO SEL MODE |
|----------------------------|---------------|------|--------|------------------------|-------|--------------|
| Regular SPI (default) | SPI Interface | | 0 | used for other purpose | | 00 |
| GPIO1/2 | SPI Interface | | 0 | used for NCO control | | 00 |
| GPIO1/2, SPISEL, SCLK/SDIO | NCO CONTROL | | 1 | used for NCO control | | 00 |
| FAST SPI | SPI Interface | | 1 | SDIO | SCLK | 10 |

The internal NCO is switched quickly; however, the switching time depends primarily on the time it takes to flush out the decimation filter as shown in [Table 7-28](#).

Table 7-28. NCO Switching Time ($F_S = 2.6$ GSPS) vs Decimation Setting

| Decimation Setting | NCO Switching Time |
|--------------------|--------------------|
| /4 | ~ 250 ns |
| /8 | ~ 350 ns |
| /16 | ~ 600 ns |
| /32 | ~ 1 us |
| /64 | ~ 2 us |
| /128 | ~ 4 us |

7.3.5.7.1 Fast frequency hopping Using the GPIO1/2 pins

The NCO frequency is selected as shown in [Table 7-29](#). This mode is enabled with the following register write:

1. Set 0x234 to 0x03 (NCO SEL MODE = 0, GPIO MODE = 3)

Table 7-29. NCO Frequency Selection Using GPIO1/2 Pins

| # OF BANDS | GPIO2 | GPIO1 | GPIO2 | GPIO1 | GPIO2 | GPIO1 | GPIO2 | GPIO1 |
|------------|----------------|-------|----------------|-------|----------------|-------|----------------|-------|
| SINGLE | 0 | 0 | 0 | 0 | 0 | 0 | NCO1 CHA [1:0] | |
| | 0 | 0 | 0 | 0 | 0 | 0 | NCO1 CHB [1:0] | |
| DUAL | 0 | 0 | 0 | 0 | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | 0 | 0 | 0 | 0 | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |
| QUAD | NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |

7.3.5.7.2 Fast frequency hopping using GPIO1/2, SEN and SDIO pins

This mode is enabled by setting the SPISEL to logic high and using the following register write:

1. Set 0x234 to 0x63 (NCO SEL MODE = 3, GPIO MODE = 3)

Table 7-30. NCO Frequency Selection SPI Interface Registers

| # OF BANDS | SDIO | SEN | GPIO2 | GPIO1 | SDIO | SEN | GPIO2 | GPIO1 |
|------------|----------------|-----|----------------|-------|----------------|-----|----------------|-------|
| SINGLE | 0 | 0 | 0 | 0 | NCO2 CHA [1] | 0 | NCO1 CHA [1:0] | |
| | 0 | 0 | 0 | 0 | NCO2 CHB [1] | 0 | NCO1 CHB [1:0] | |
| DUAL | 0 | 0 | 0 | 0 | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | 0 | 0 | 0 | 0 | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |
| QUAD | NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |

7.3.5.7.3 Fast Frequency Hopping Using the Fast SPI

In this mode, the GPIO1/2 pins are used as a "fast SPI" input which only updates the NCO selection registers. No register address information needs to be sent. GPIO1 pin is SDIO and GPIO2 pin is SCLK.

This mode is enabled by setting the SPISEL to logic high and using the following register write:

1. Set 0x234 to 0x43 (NCO SEL MODE = 2, GPIO MODE = 3)

The NCO frequencies are selected as shown in [Table 7-31](#).

Table 7-31. NCO Frequency Programming Using FAST SPI

| # OF BANDS | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------|----------------|-----|----------------|-----|----------------|-----|----------------|----|----------------|----|----------------|----|----------------|----|----------------|----|
| SINGLE | 0 | 0 | 0 | 0 | NCO1 CHB [2] | 0 | NCO1 CHB [1:0] | | 0 | 0 | 0 | 0 | NCO1 CHA [2] | 0 | NCO1 CHA [1:0] | |
| DUAL | 0 | 0 | 0 | 0 | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | | 0 | 0 | 0 | 0 | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| QUAD | NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | | NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |

7.3.6 JESD204B Interface

The ADC32RF5x uses the JESD204B high-speed serial interface to transfer data from the ADC to the receiving logic device. ADC32RF5x serialized lanes are capable of operating up to 13 Gbps, slightly above the JESD204B max lane rate. A maximum of 8 lanes can be used to allow lower lane rates for interfacing with speed limited logic devices. Figure 7-41 shows a simplified block diagram of the JESD204B interface.

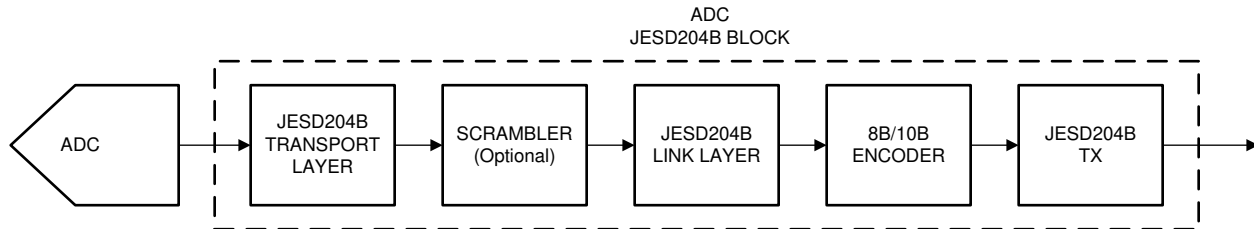


Figure 7-41. JESD204B Block Diagram

7.3.6.1 JESD204B Initial Lane Alignment (ILA)

The receiving device starts the initial lane alignment process by deasserting the $\overline{\text{SYNC}}$ signal. When a logic low state is detected on the $\overline{\text{SYNC}}$ input, the ADC starts transmitting comma characters (K28.5) in order to establish the code group synchronization, as shown in Figure 7-42. When synchronization is completed, the receiving device reasserts the $\overline{\text{SYNC}}$ signal and the ADC starts the initial lane alignment sequence with the next local multi-frame clock (LMFC) boundary. The ADC transmits four multi-frames, each containing K frame (K is SPI programmable). Each of the multi-frames contains the frame start and frame end symbols. The second multi-frame also contains the JESD204B link configuration data.

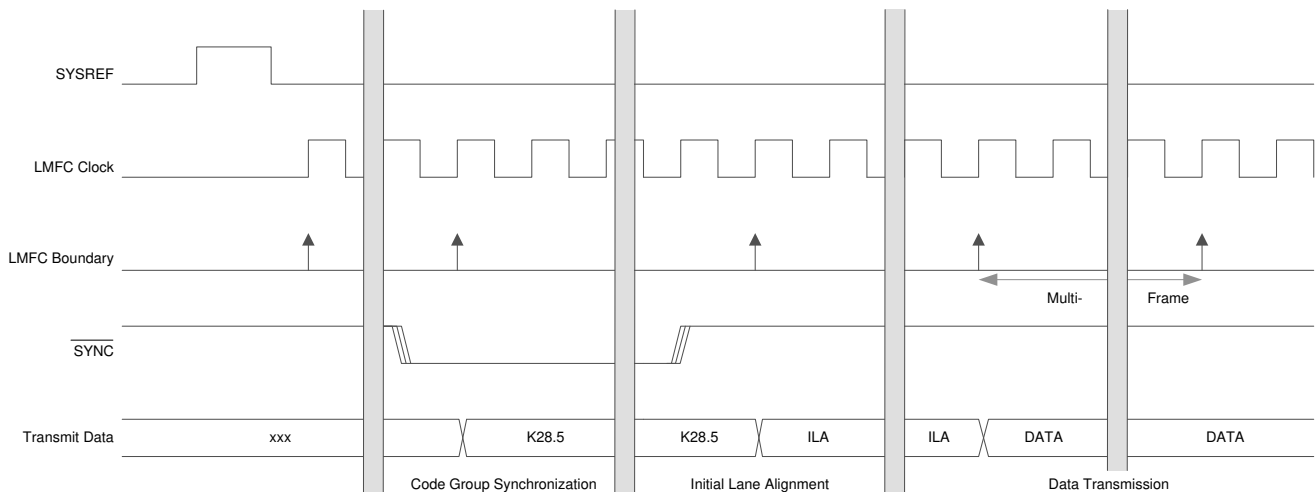


Figure 7-42. JESD204B Internal Timing Diagram

7.3.6.1.1 $\overline{\text{SYNC}}$ Signal

The $\overline{\text{SYNC}}$ signal can be issued using one of two different methods:

- One of the GPIO1/2 pins can be configured via SPI to become the $\overline{\text{SYNC}}$ input pin (address 0x234 in the digital page)
- The synchronization command can be issued via SPI register write (address 0x21 in the JESD page)

When using the GPIO1/2 pins for the $\overline{\text{SYNC}}$ signal input, the device also supports the option to invert the signal polarity (address 0x236 in the digital page).

7.3.6.2 JESD204B Frame Assembly

The JESD204B standard defines the following parameters:

- L: number of lanes per link
- M: number of converters per device
- F: number of octets per frame clock period
- S: number of samples per frame

7.3.6.3 JESD204B Frame Assembly in Bypass Mode

Table 7-32 lists the available JESD204B formats and corresponding valid sampling rate ranges for the ADC32RF5x. The sampling rates are limited by the minimum and maximum SERDES line rate as well as ADC sampling clock frequencies. The JESD204B frame assembly for the different lanes is shown in Table 7-33.

When internal digital averaging is used, the output resolution is automatically adjusted from 14-bit to 16-bit to avoid quantization noise limitation.

Table 7-32. JESD Mode Options: Bypass Mode

| DECIMATION SETTING D (complex) | OUTPUT RESOLUTION (Bits) | L | M | F | S | MIN F _S (Gsp/s) | MAX F _S (Gsp/s) | RATIO [f _{SERDES} /F _S] |
|--------------------------------|--------------------------|---|---|---|----|----------------------------|----------------------------|--|
| Bypass | 12 ⁽¹⁾ | 8 | 2 | 8 | 20 | 0.5 | 3.0 | 4 |
| | 14/16 ⁽²⁾ | 8 | 2 | 2 | 4 | 0.5 | 2.6 | 5 |
| | | 4 | 2 | 2 | 2 | 0.5 | 1.3 | 10 |

(1) In full rate output, two LSBs are truncated to a 12-bit output.

(2) When using digital averaging the output resolution changes to 16-bit.

Table 7-33. JESD Sample Frame Assembly: Bypass Mode

| OUTPUT LANE | LMFS = 82820 | | | | | | | | LMFS = 8224 | | LMFS = 4222 | |
|-------------|------------------------|--|-----------------------|------------------------|--|-----------------------|------------------------|--------------------------------|-----------------------|-----------------------------|-----------------------|-----------------------------|
| DOUT0 | A ₀ [11:4] | A ₀ [3:0], A ₁ [11:8] | A ₁ [7:0] | A ₂ [11:4] | A ₂ [3:0], A ₃ [11:8] | A ₃ [7:0] | A ₄ [11:4] | A ₄ [3:0], 0000 | A ₀ [13:6] | A ₀ [5:0], 00 | A ₀ [13:6] | A ₀ [5:0], 00 |
| DOUT1 | A ₅ [11:4] | A ₅ [3:0], A ₆ [11:8] | A ₆ [7:0] | A ₇ [11:4] | A ₇ [3:0], A ₈ [11:8] | A ₈ [7:0] | A ₉ [11:4] | A ₉ [3:0], 0000 | A ₁ [13:6] | A ₁ [5:0], 00 | A ₁ [13:6] | A ₁ [5:0], 00 |
| DOUT2 | A ₁₀ [11:4] | A ₁₀ [3:0], A ₁₁ [11:8] | A ₁₁ [7:0] | A ₁₂ [11:4] | A ₁₂ [3:0], A ₁₃ [11:8] | A ₁₃ [7:0] | A ₁₄ [11:4] | A ₁₄ [3:0], 0000 | A ₂ [13:6] | A ₂ [5:0], 00 | B ₀ [13:6] | B ₀ [5:0], 00 |
| DOUT3 | A ₁₅ [11:4] | A ₁₅ [3:0], A ₁₆ [11:8] | A ₁₆ [7:0] | A ₁₇ [11:4] | A ₁₇ [3:0], A ₁₈ [11:8] | A ₁₈ [7:0] | A ₁₉ [11:4] | A ₁₉ [3:0], 0000 | A ₃ [13:6] | A ₃ [5:0], 00 | B ₁ [13:6] | B ₁ [5:0], 00 |
| DOUT4 | B ₀ [11:4] | B ₀ [3:0], B ₁ [11:8] | B ₁ [7:0] | B ₂ [11:4] | B ₂ [3:0], B ₃ [11:8] | B ₃ [7:0] | B ₄ [11:4] | B ₄ [3:0], 0000 | B ₀ [13:6] | B ₀ [5:0], 00 | | |
| DOUT5 | B ₅ [11:4] | B ₅ [3:0], B ₆ [11:8] | B ₆ [7:0] | B ₇ [11:4] | B ₇ [3:0], B ₈ [11:8] | B ₈ [7:0] | B ₉ [11:4] | B ₉ [3:0], 0000 | B ₁ [13:6] | B ₁ [5:0], 00 | | |
| DOUT6 | B ₁₀ [11:4] | B ₁₀ [3:0], B ₁₁ [11:8] | B ₁₁ [7:0] | B ₁₂ [11:4] | B ₁₂ [3:0], B ₁₃ [11:8] | B ₁₃ [7:0] | B ₁₄ [11:4] | B ₁₄ [3:0], 0000 | B ₂ [13:6] | B ₂ [5:0], 00 | | |
| DOUT7 | B ₁₅ [11:4] | B ₁₅ [3:0], B ₁₆ [11:8] | B ₁₆ [7:0] | B ₁₇ [11:4] | B ₁₇ [3:0], B ₁₈ [11:8] | B ₁₈ [7:0] | B ₁₉ [11:4] | B ₁₉ [3:0], 0000 | B ₃ [13:6] | B ₃ [5:0], 00 | | |

7.3.6.4 JESD204B Frame Assembly with Complex Decimation - Single Band

Table 7-34 lists the available JESD204B interface formats and corresponding valid sampling rate ranges for the ADC32RF5x with complex decimation (single band). The sampling rates are limited by the minimum and maximum SERDES line rate as well as ADC sampling clock frequencies. The JESD204B frame assembly for the different lanes is shown in Table 7-33.

Table 7-34. JESD Mode Options: Complex Decimation - Single Band

| DECIMATION SETTING D (complex) | L | M | F | S | MIN F_S (Gbps) | MAX F_S (Gbps) | RATIO [$f_{SERDES}/(F_S/D)$] |
|--------------------------------|-----|---|---|---|------------------|------------------|--------------------------------|
| /4 | 8 | 4 | 2 | 2 | 0.5 | 3.0 | 10 |
| /8 | | | | | 0.8 | | |
| /16 | | | | | 1.6 | | |
| /32 | 4 | 4 | 2 | 1 | 0.5 | 2.6 | 20 |
| /8 | | | | | | 3.0 | |
| /16 | | | | | | | |
| /32 | | | | | | | |
| /64 | 2 | 4 | 4 | 1 | 0.5 | 2.6 | 40 |
| /8 | | | | | | 3.0 | |
| /16 | | | | | | | |
| /32 | | | | | | | |
| /64 | 1 | 4 | 8 | 1 | 0.5 | 1.3 | 80 |
| /8 | | | | | | 3.0 | |
| /16 | | | | | | | |
| /32 | | | | | | | |
| /64 | 0.8 | | | | | | |
| /128 | | | | | | | |

Table 7-35. JESD Sample Frame Assembly: Complex Decimation - Single Band

| OUTPUT LANE | LMFS = 8422 | | LMFS = 4421 | | LMFS = 2441 | | | | LMFS = 1481 | | | | | | | |
|-------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|------------------------|-----------------------|
| | AI ₀ [15:8] | AI ₀ [7:0] | AI ₀ [15:8] | AI ₀ [7:0] | AI ₀ [15:8] | AI ₀ [7:0] | AQ ₀ [15:8] | AQ ₀ [7:0] | AI ₀ [15:8] | AI ₀ [7:0] | AQ ₀ [15:8] | AQ ₀ [7:0] | BI ₀ [15:8] | BI ₀ [7:0] | BQ ₀ [15:8] | BQ ₀ [7:0] |
| DOUT0 | AI ₁ [15:8] | AI ₁ [7:0] | AQ ₀ [15:8] | AQ ₀ [7:0] | BI ₀ [15:8] | BI ₀ [7:0] | BQ ₀ [15:8] | BQ ₀ [7:0] | | | | | | | | |
| DOUT1 | AQ ₀ [15:8] | AQ ₀ [7:0] | BI ₀ [15:8] | BI ₀ [7:0] | | | | | | | | | | | | |
| DOUT2 | AQ ₁ [15:8] | AQ ₁ [7:0] | BQ ₀ [15:8] | BQ ₀ [7:0] | | | | | | | | | | | | |
| DOUT3 | BI ₀ [15:8] | BI ₀ [7:0] | | | | | | | | | | | | | | |
| DOUT4 | BI ₁ [15:8] | BI ₁ [7:0] | | | | | | | | | | | | | | |
| DOUT5 | BQ ₀ [15:8] | BQ ₀ [7:0] | | | | | | | | | | | | | | |
| DOUT6 | BQ ₁ [15:8] | BQ ₁ [7:0] | | | | | | | | | | | | | | |
| DOUT7 | | | | | | | | | | | | | | | | |

7.3.6.5 JESD204B Frame Assembly with Real Decimation - Single Band

Table 7-36 lists the available JESD204B formats and corresponding valid sampling rate ranges for the ADC32RF5x. The sampling rates are limited by the minimum and maximum SERDES line rate as well as ADC sampling clock frequencies. The JESD204B frame assembly for the different lanes is shown in Table 7-37.

Table 7-36. JESD Mode Options: Real Decimation

| DECIMATION SETTING D (complex) | L | M | F | S | MIN F _S (Gbps) | MAX F _S (Gbps) | RATIO [f _{SERDES} /(F _S /D)] |
|--------------------------------|---|---|---|---|---------------------------|---------------------------|--|
| /4 | 8 | 2 | 2 | 4 | 0.5 | 3.0 | 5 |
| /8 | | | | | 0.8 | | |
| /16 | | | | | 1.6 | | |
| /4 | 4 | 2 | 2 | 2 | 0.5 | 3.0 | 10 |
| /8 | | | | | 0.8 | | |
| /16 | | | | | 1.6 | | |
| /32 | 2 | 2 | 2 | 1 | 0.5 | 3.0 | 20 |
| /16 | | | | | 0.8 | | |
| /64 | | | | | 1.6 | | |
| /8 | 1 | 2 | 4 | 1 | 0.5 | 3.0 | 40 |
| /16 | | | | | 0.8 | | |
| /32 | | | | | 1.6 | | |
| /64 | 1 | 2 | 4 | 1 | 0.5 | 3.0 | 40 |
| /128 | | | | | 0.8 | | |
| | | | | | 1.6 | | |

Table 7-37. JESD Sample Frame Assembly: Real Decimation - Single Band

| OUTPUT LANE | LMFS = 8224 | | LMFS = 4222 | | LMFS = 2221 | | LMFS = 1241 | | | |
|-------------|-----------------------|----------------------|-----------------------|----------------------|-----------------------|----------------------|-----------------------|----------------------|-----------------------|----------------------|
| DOUT0 | A ₀ [15:8] | A ₀ [7:0] | A ₀ [15:8] | A ₀ [7:0] | A ₀ [15:8] | A ₀ [7:0] | A ₀ [15:8] | A ₀ [7:0] | B ₀ [15:8] | B ₀ [7:0] |
| DOUT1 | A ₁ [15:8] | A ₁ [7:0] | A ₁ [15:8] | A ₁ [7:0] | B ₀ [15:8] | B ₀ [7:0] | | | | |
| DOUT2 | A ₂ [15:8] | A ₂ [7:0] | B ₀ [15:8] | B ₀ [7:0] | | | | | | |
| DOUT3 | A ₃ [15:8] | A ₃ [7:0] | B ₁ [15:8] | B ₁ [7:0] | | | | | | |
| DOUT4 | B ₀ [15:8] | B ₀ [7:0] | | | | | | | | |
| DOUT5 | B ₁ [15:8] | B ₁ [7:0] | | | | | | | | |
| DOUT6 | B ₂ [15:8] | B ₂ [7:0] | | | | | | | | |
| DOUT7 | B ₃ [15:8] | B ₃ [7:0] | | | | | | | | |

7.3.6.6 JESD204B Frame Assembly with Complex Decimation - Dual Band

Table 7-38 lists the available JESD204B interface formats and corresponding valid sampling rate ranges for the ADC32RF5x with complex decimation (dual band). The sampling rates are limited by the minimum and maximum SERDES line rate as well as ADC sampling clock frequencies. The JESD204B frame assembly for the different lanes are shown in Table 7-39 and Table 7-40.

Table 7-38. JESD Mode Options: Complex Decimation - Dual Band

| DECIMATION SETTING D (complex) | L | M | F | S | MIN F _S (Gbps) | MAX F _S (Gbps) | RATIO [f _{SERDES} /(F _S /D)] |
|--------------------------------|---|---|----|---|---------------------------|---------------------------|--|
| /8 | 8 | 8 | 2 | 1 | 0.5 | 3.0 | 20 |
| /16 | | | | | 0.8 | | |
| /64 | | | | | 1.6 | | |
| /8 | 4 | 8 | 4 | 1 | 0.5 | 2.6 | 40 |
| /16 | | | | | | 3.0 | |
| /32 | | | | | | | |
| /64 | | | | | 1.6 | | |
| /128 | 2 | 8 | 8 | 1 | 0.5 | 1.3 | 80 |
| /16 | | | | | | 2.6 | |
| /32 | | | | | | 3.0 | |
| /64 | | | | | | | |
| /128 | | | | | 0.8 | | |
| /16 | 1 | 8 | 16 | 1 | 0.5 | 1.3 | 160 |
| /32 | | | | | | 2.6 | |
| /64 | | | | | | 3.0 | |
| /128 | | | | | | | |

Table 7-39. JESD Sample Frame Assembly: Complex Decimation - Dual Band

| OUTPUT LANE | LMFS = 8821 | | LMFS = 4841 | | | | LMFS = 2881 | | | | | | | |
|-------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|
| | A1I ₀ [15:8] | A1I ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] |
| DOUT0 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] |
| DOUT1 | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] |
| DOUT2 | A2I ₀ [15:8] | A2I ₀ [7:0] | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | | | | | | | | |
| DOUT3 | A2Q ₀ [15:8] | A2Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | | | | | | | | |
| DOUT4 | B1I ₀ [15:8] | B1I ₀ [7:0] | | | | | | | | | | | | |
| DOUT5 | B1Q ₀ [15:8] | B1Q ₀ [7:0] | | | | | | | | | | | | |
| DOUT6 | B2I ₀ [15:8] | B2I ₀ [7:0] | | | | | | | | | | | | |
| DOUT7 | B2Q ₀ [15:8] | B2Q ₀ [7:0] | | | | | | | | | | | | |

Table 7-40. JESD Sample Frame Assembly: Complex Decimation - Dual Band

| OUTPUT LANE | LMFS = 1-8-16-1 | | | | | | | | | | | | | | | |
|-------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|
| | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] |
| DOUT 0 | | | | | | | | | | | | | | | | |
| DOUT 1 | | | | | | | | | | | | | | | | |
| DOUT 2 | | | | | | | | | | | | | | | | |
| DOUT 3 | | | | | | | | | | | | | | | | |
| DOUT 4 | | | | | | | | | | | | | | | | |
| DOUT 5 | | | | | | | | | | | | | | | | |
| DOUT 6 | | | | | | | | | | | | | | | | |
| DOUT 7 | | | | | | | | | | | | | | | | |

7.3.6.7 JESD204B Frame Assembly with Complex Decimation - Quad Band

Table 7-41 lists the available JESD204B interface formats and corresponding valid sampling rate ranges for the ADC32RF5x with complex decimation (quad band). The sampling rates are limited by the minimum and maximum SERDES line rate as well as ADC sampling clock frequencies. The JESD204B frame assembly for the different lanes are shown in Table 7-42, Table 7-43 and Table 7-44.

Table 7-41. JESD Mode Options: Complex Decimation - Quad Band

| DECIMATION SETTING D (complex) | L | M | F | S | MIN F _S (Gbps) | MAX F _S (Gbps) | RATIO [f _{SERDES} /(F _S /D)] |
|--------------------------------|---|----|----|---|---------------------------|---------------------------|--|
| /8 | 8 | 16 | 4 | 1 | 0.5 | 2.6 | 40 |
| /16 | | | | | | 3.0 | |
| /32 | | | | | | | |
| /64 | | | | | | 0.8 | |
| /128 | | | | | | 1.6 | |
| /16 | 4 | 16 | 8 | 1 | 0.5 | 2.6 | 80 |
| /32 | | | | | | 3.0 | |
| /64 | | | | | | | |
| /128 | | | | | | 0.8 | |
| /16 | 2 | 16 | 16 | 1 | 0.5 | 1.3 | 160 |
| /32 | | | | | | 2.6 | |
| /64 | | | | | | 3.0 | |
| /128 | | | | | | | |
| /16 | 1 | 16 | 32 | 1 | 0.5 | 0.65 | 320 |
| /32 | | | | | | 1.3 | |
| /64 | | | | | | 2.6 | |
| /128 | | | | | | 3.0 | |

Table 7-42. JESD Sample Frame Assembly: Complex Decimation - Quad Band

| OUTPUT LANE | LMFS = 8-16-4-1 | | | | LMFS = 4-16-8-1 | | | | | | | |
|-------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| | DOUT0 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] |
| DOUT1 | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] | A4Q ₀ [7:0] |
| DOUT2 | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] |
| DOUT3 | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] | A4Q ₀ [7:0] | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] |
| DOUT4 | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | | | | | | | | |
| DOUT5 | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | | | | | | | | |
| DOUT6 | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | | | | | | | | |
| DOUT7 | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] | | | | | | | | |

Table 7-43. JESD Sample Frame Assembly: Complex Decimation - Quad Band

| OUTPUT LANE | LMFS = 2-16-16-1 | | | | | | | | | | | | | | | |
|-------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| | DOUT 0 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] |
| DOUT 1 | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] |
| DOUT 2 | | | | | | | | | | | | | | | | |
| DOUT 3 | | | | | | | | | | | | | | | | |
| DOUT 4 | | | | | | | | | | | | | | | | |
| DOUT 5 | | | | | | | | | | | | | | | | |
| DOUT 6 | | | | | | | | | | | | | | | | |
| DOUT 7 | | | | | | | | | | | | | | | | |

Table 7-44. JESD Sample Frame Assembly: Complex Decimation - Quad Band

| OUTPUT LANE | LMFS = 1-16-32-1 | | | | | | | | | | | | | | | | |
|-------------|------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|
| | DOUT 0 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A3I ₀ [15:8] | A3I ₀ [7:0] | A3Q ₀ [15:8] | A3Q ₀ [7:0] | A4I ₀ [15:8] | A4I ₀ [7:0] | A4Q ₀ [15:8] | A4Q ₀ [7:0] |
| ... | | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | B3I ₀ [15:8] | B3I ₀ [7:0] | B3Q ₀ [15:8] | B3Q ₀ [7:0] | B4I ₀ [15:8] | B4I ₀ [7:0] | B4Q ₀ [15:8] | B4Q ₀ [7:0] |
| DOUT 1 | | | | | | | | | | | | | | | | | |
| DOUT 2 | | | | | | | | | | | | | | | | | |
| DOUT 3 | | | | | | | | | | | | | | | | | |
| DOUT 4 | | | | | | | | | | | | | | | | | |
| DOUT 5 | | | | | | | | | | | | | | | | | |
| DOUT 6 | | | | | | | | | | | | | | | | | |
| DOUT 7 | | | | | | | | | | | | | | | | | |

7.3.7 SERDES Output MUX

The SERDES output block contains one digital mux per SERDES output lane with a 3-bit register. This allows routing any of the 8 digital streams to any output serdes transmitter as shown in the example in Figure 7-43. The MUX can be used to reorder lanes as well as duplicate lane outputs (for example in LMFS = 1-4-8-1 mode the same output stream could be duplicated on all 8 lanes).

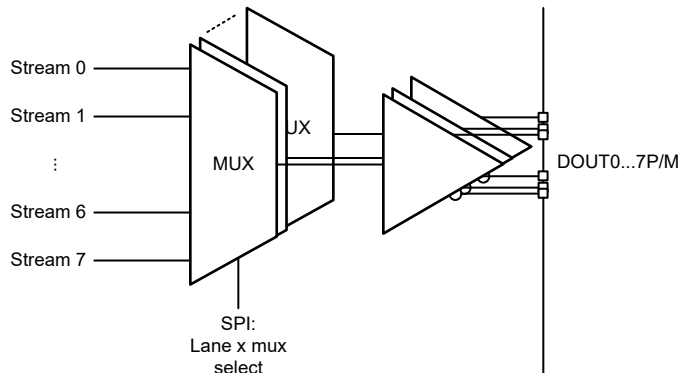


Figure 7-43. SERDES output mux for DOUT0

By default after power, the active SERDES lanes start on lane DOUT0 as shown for the complex decimation dual band example in Table 7-45. After power up, the output is transmitted on lanes DOUT0..3. Using the digital output muxes, the output data for channel B is shifted from lanes DOUT2,3 to DOUT4,5. All SERDES transmitters are powered up and enabled by default. After configuring the output mux unused lanes can be powered down to save power consumption.

Table 7-45. JESD Sample Frame Assembly: Complex Decimation - Dual Band with LMFS = 4841

| OUTPUT LANE | Default | | | | Using MUX | | | |
|-------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|-------------------------|------------------------|
| DOUT0 | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] | A1I ₀ [15:8] | A1I ₀ [7:0] | A1Q ₀ [15:8] | A1Q ₀ [7:0] |
| DOUT1 | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] | A2I ₀ [15:8] | A2I ₀ [7:0] | A2Q ₀ [15:8] | A2Q ₀ [7:0] |
| DOUT2 | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] | | | | |
| DOUT3 | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] | | | | |
| DOUT4 | | | | | B1I ₀ [15:8] | B1I ₀ [7:0] | B1Q ₀ [15:8] | B1Q ₀ [7:0] |
| DOUT5 | | | | | B2I ₀ [15:8] | B2I ₀ [7:0] | B2Q ₀ [15:8] | B2Q ₀ [7:0] |
| DOUT6 | | | | | | | | |
| DOUT7 | | | | | | | | |

Table 7-46 shows the register writes to shift the output lanes from default as illustrated in Table 7-45.

Table 7-46. Example register writes to shift the output serdes lanes using the SERDES Output MUX

| ADDR | DATA | DESCRIPTION |
|------|------|---|
| 0x05 | 0x04 | Select JESD page |
| 0x81 | 0x54 | Select internal JESD streams 4 and 5 to lanes DOUT2 and DOUT3 |
| 0x82 | 0x32 | Select internal JESD streams 2 and 3 to lanes DOUT4 and DOUT5 |

7.3.8 Test Pattern

The ADC32RF5x provides two different options to output test patterns instead of the actual output data of the ADC in order to simplify the serial interface and system debug of the JESD204B digital interface link. The output data path is shown in Figure 7-44.

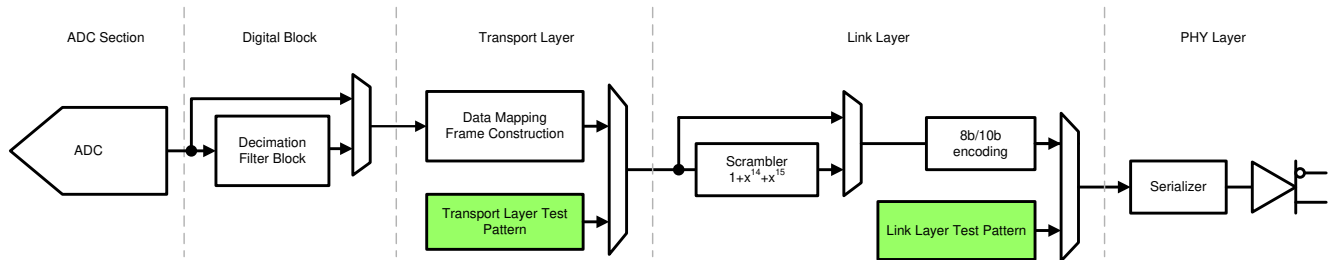


Figure 7-44. Test Pattern Options

The available test patterns in each block are described in Table 7-47. Both test pattern blocks replace output data from the digital block, and not from the ADC; therefore, it is available in decimation or decimation bypass mode. The test patterns are synchronized with the SYSREF signal.

Table 7-47. Test Pattern Overview

| TEST PATTERN LOCATION | TYPE | 8b/10b encoded | REGISTER PAGE | REGISTER |
|-----------------------|--------------------------------|----------------|-------------------|-------------|
| TRANSPORT LAYER | CUSTOM PATTERN | Yes | JESD 0x05 0x04 | 0x2E, D0 |
| | TOGGLE 1010 PATTERN | Yes | | 0x2E, D1 |
| | RAMP PATTERN | Yes | | 0x2E, D2 |
| LINK LAYER | JESD204B TEST PATTERNS | Depends | | 0x2D, D2-D0 |
| | PRBS PATTERN ($2^7..2^{31}$) | No | | 0x2F, D6-D4 |

The RAMP pattern provides two different output options. Internally each ADC data bus consists of parallel data streams (1 stream per serdes lane). The RAMP pattern is generated for each stream and a different starting value can be set for each stream. By default, the starting values are 0. For example, a LMFS mode using 4 lanes/ADC would show a *slow* ramp which increments once every 4 clock cycles with starting values set to 0 and ramp increment = 1. Also, a RAMP pattern which increments every clock cycle can be set using different starting values (such as 0, 1, 2, 3) for the 4 streams/lanes and setting the RAMP increment to 4. The follow table shows how to enable the RAMP test pattern.

Table 7-48. RAMP Test Pattern

| ADDR | DATA | DESCRIPTION |
|------|------|---|
| 0x05 | 0x04 | Select JESD page |
| 0x32 | 0x01 | Set lane DOUT1 starting value = 1 |
| 0x34 | 0x02 | Set lane DOUT2 starting value = 2 |
| 0x36 | 0x03 | Set lane DOUT3 starting value = 3 |
| 0x42 | 0x01 | Set lane DOUT5 starting value = 1 |
| 0x44 | 0x02 | Set lane DOUT6 starting value = 2 |
| 0x46 | 0x03 | Set lane DOUT7 starting value = 3 |
| 0x2E | 0x34 | Enable RAMP pattern, RAMP increment = 4 |

7.3.8.1 Transport Layer

The transport layer maps the ADC output data into 8-bit octets and constructs the JESD204B frames using the LMFS parameters. Tail bits or 0's are added when needed. Alternatively, test patterns can be substituted instead of the ADC data with the JESD frame, as shown in Table 7-47.

7.3.8.2 Link Layer

The link layer contains the scrambler and the 8b/10b encoding of any data passed on from the transport layer. Additionally, the link layer controls the initial lane alignment sequence that can be manually restarted. The link layer test patterns are intended for testing the quality of the link (jitter testing and so forth). The test patterns do not pass through the 8b/10b encoder and contain the options listed in [Table 7-47](#).

7.3.8.3 Internal Capture Memory Buffer

The ADC includes a small internal capture memory buffer which can store up to 64 samples. Once a strobe is given to the memory using SPI register write, the memory will store the next continuous 64 samples of one ADC channel (selected via SPI register write) and stop. The samples are captured from the ADC cores (prior to averaging or decimation). These samples can be read back using the SPI interface without involving the JESD204B interface at all.

This mode allows debug of the analog front end during the initial bring-up phase even if the JESD204B interface is not operational yet.

Table 7-49. Register writes to enable the internal sample capture buffer

| ADDR | DATA | DESCRIPTION |
|------|------|---|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x34 | | Select ADC channel (D5/D4) and give strobe (D6). The 64 samples are stored in 0x800 to 0x87F in the digital page |

7.4 Device Functional Modes

The device offers two different operating modes: bypass mode (1x AVG) and digital averaging (2x/4x AVG). Both operating modes use the same digital back end and JESD204B output configurations.

7.4.1 Digital Averaging

The ADC32RF5x provides a total of eight internal single core 3.0 Gsps ADCs. Normal bypass mode uses only two ADC cores (one ADC per channel). However, the additional six ADCs can be used to trade off further noise density improvement against additional power consumption. Figure 7-45 shows the internal block diagrams for the digital averaging modes. In averaging mode the output resolution is increased to 16-bit to avoid quantization noise limitation.

In 2x averaging mode (left), one external input is connected to the INx1 input where two ADC cores internally average the input signal. In 4x averaging (right), the signal has to be split externally and connected to both the INx1 and INx2 inputs where four ADC cores internally average the signal.

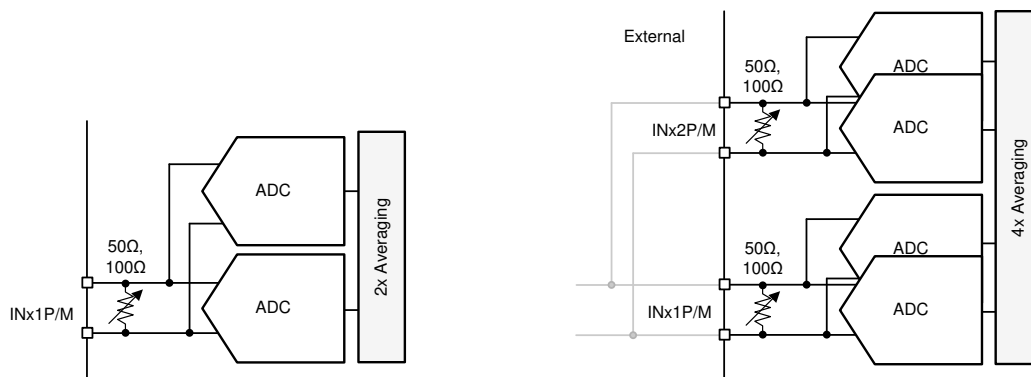


Figure 7-45. Internal digital averaging (left: 2x, right: 4x)

Table 7-50 provides a trade-off comparison of the 3 different averaging mode options vs the default, non-averaged mode.

Table 7-50. Digital Averaging vs Full Power Input Bandwidth (–3 dB)

| # of ADCs averaged | ADC inputs used for averaging | Input Bandwidth (–3 dB) | Selected differential input termination | Noise density | Power/ch (W) |
|--------------------|-------------------------------|-------------------------|---|---------------|--------------|
| Default | INx1 | 2.75 GHz | 100 Ω | -156 dBFS/Hz | ~2.1 |
| 2 | INx1 | 2.75 GHz | 100 Ω | -158 dBFS/Hz | ~2.6 |
| 4 | INx1, INx2 | 2.1 GHz | 100 Ω | -160 dBFS/Hz | ~3.5 |

Digital averaging improves decorrelated noise contributions by 3 dB per 2x AVG (ideal) while correlated noise does not improve with averaging. Some of the dominant noise sources are correlated, that is, clock jitter (external or first clock input buffer), or power supply noise. While others (such as, ADC thermal noise, clock distribution buffers) are decorrelated. Table 7-51 illustrates a performance example comparison across averaging options.

SNR: When operating close to ADC fullscale, some of the SNR limitation is due to jitter and hence the SNR improvement will not reach 3 dB (2x AVG) or 6 dB (4x AVG). As the input fullscale is reduced, the clock jitter contribution to SNR becomes less and the SNR improvement is approaching the ideal 3 dB per 2x AVG. The same phenomenon can be observed when using digital decimation. As the decimation factor increases, the close-in (correlated noise) becomes the more dominating noise unless the input signal amplitude is reduced.

SFDR: The amplitude of low order harmonics (HD2-HD5) and IMD3 typically is similar across ADCs; thus, the improvement with averaging is small.

Table 7-51. Performance Comparison Example with 1x/2x/4x Averaging with $F_S = 2.6$ GSPS, $F_{IN} = 1$ GHz and Dither EN

| Parameter | Input Amplitude (dBFS) | 1x AVG | 2x AVG | 4x AVG |
|-----------------|------------------------|--------|--------|--------|
| SNR (dBFS) | -4 | 62.8 | 64.9 | 67.2 |
| | -10 | 63.9 | 66.3 | 68.2 |
| | -20 | 64.0 | 66.4 | 69.4 |
| HD2 (dBc) | -4 | 66 | 62 | 71 |
| | -10 | 74 | 74 | 75 |
| | -20 | 70 | 70 | 80 |
| HD3 (dBc) | -4 | 73 | 76 | 78 |
| | -10 | 80 | 78 | 80 |
| | -20 | 74 | 71 | 72 |
| Non HD23 (dBFS) | -4 | 86 | 84 | 83 |
| | -10 | 90 | 91 | 92 |
| | -20 | 96 | 100 | 97 |
| IMD3 (dBc) | -10 dBFS/tone | 77 | 73 | 71 |
| | -20 dBFS/tone | 78 | 79 | 72 |

7.5 Programming

The device is primarily configured and controlled using the serial programming interface (SPI); however, it can operate in a default configuration without requiring the SPI interface. Furthermore, the power down function as well as NCO frequency hopping or JESD synchronization are possible via pin control (GPIO1/2 pins).

7.5.1 GPIO Pin Control

There are several commands which can be executed using SPI programming or GPIO pins. [Table 7-52](#) provides an overview of the commands available using GPIO pins.

Table 7-52. GPIO Pin Command Options

| FEATURE | DESCRIPTION |
|--------------------|--|
| JESD SYNC | Support for single ended CMOS or differential LVDS |
| NCO Control | Fast frequency hopping with 3 different control options |
| Fast Overage | GPIO1 indicates overrange for channel A and GPIO2 for channel B. In this mode the overrange indication is 'sticky' - the flag stays high until it is cleared using SPI commands. |
| Calibration Freeze | Freezes swapping of calibration ADC |

7.5.2 Configuration Using the SPI Interface

The device has a set of internal registers that can be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock) and SDIO (serial interface data input/output) pins. Serially shifting bits into the device is enabled when SEN is low. Serial data input are latched at every SCLK rising edge when SEN is active (low). The serial data are loaded into the register at every 24th SCLK rising edge when SEN is low. When the word length exceeds a multiple of 24 bits, the excess bits are ignored. Data can be loaded in multiples of 24-bit words within a single active SEN pulse. The interface can function with SCLK frequencies from 20 MHz down to ~ 1 MHz and also with a non-50% SCLK duty cycle.

7.5.2.1 Register Write

The internal registers can be programmed following these steps:

1. Drive the SEN pin low
2. Set the R/W bit to 0 (bit A15 of the 16-bit address) and bits A[14:12] in address field to 0.
3. Initiate a serial interface cycle by specifying the address of the register (A[11:0]) whose content is written and
4. Write the 8-bit data that are latched in on the SCLK rising edges

Figure 7-46 shows the timing requirements for the serial register write operation.

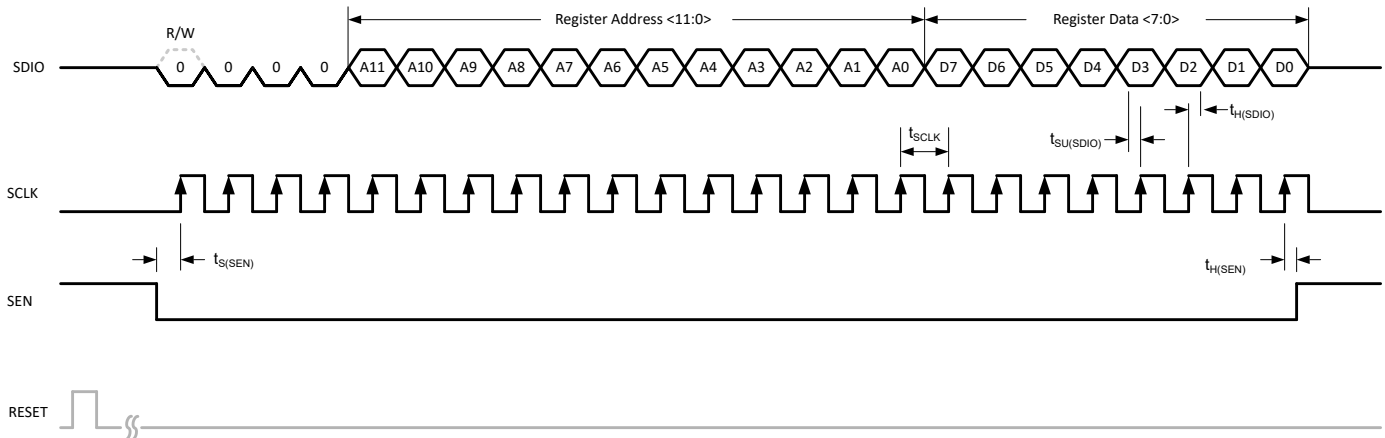


Figure 7-46. Serial Register Write Timing Diagram

7.5.2.2 Register Read

The device includes a mode where the contents of the internal registers can be read back using the SDIO pin. This readback mode can be useful as a diagnostic check to verify the serial interface communication between the external controller and the ADC. The procedure to read the contents of the serial registers is as follows:

1. Drive the SEN pin low
2. Set the R/W bit (A15) to 1. This setting disables any further writes to the registers. Set A[14:12] in address field to 0.
3. Initiate a serial interface cycle specifying the address of the register (A[11:0]) whose content must be read
4. The device outputs the contents (D[7:0]) of the selected register on the SDIO pin
5. The external controller can latch the contents at the SCLK falling edge

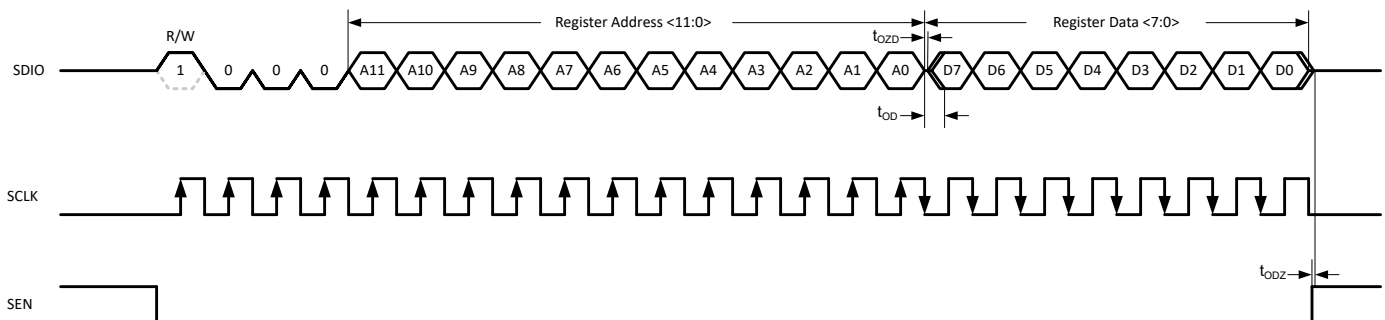


Figure 7-47. Serial Register Read Timing Diagram

7.6 Register Maps

Table 7-53. Register Map Summary

| PAGE | REGISTER ADDRESS | REGISTER DATA | | | | | | | |
|---------|------------------|-----------------|--------------|----------------|-----------|----------------|--------------|----------------|-------------|
| | A[11:0] | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| GLOBAL | 0x00 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | RESET |
| | 0x05 | MEM PAGE | ANALOG PAGE | CALIB PAGE | DDCB PAGE | DDCA PAGE | JESD PAGE | DIGITAL PAGE | 0 |
| DIGITAL | 0x2C | 20-BIT OUT | DDC BAND SEL | | 0 | 0 | 0 | DDC REAL | BYP EN |
| | 0x2D | 0 | DECIMATION | | | 0 | 0 | 0 | 0 |
| | 0x2E | 0 | 0 | 0 | 0 | AVG EN | AVG SEL(1) | | OVR ON JESD |
| | 0x33 | 0 | 0 | 0 | 1 | FORMAT | 0 | GBL PDN | 0 |
| | 0x34 | 0 | MEM STROBE | MEM CH SEL | | 0 | 0 | 0 | 0 |
| | 0x3B | NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| | 0x41 | NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |
| | 0x22F | 1 | SYSREF X5 | SYSREF X4 | SYSREF X3 | SYSREF X2 | SYSREF X1 | SYSREF OR | 1 |
| | 0x234 | 0 | NCO SEL MODE | | 0 | 0 | GPIO MODE | | |
| | 0x235 | NCO SEL SOURCE | | | | | | | |
| | 0x236 | 0 | GPIO2 INV | GPIO1 INV | GPIO SWAP | 0 | 0 | SYSREF RESET | SYSREF EN |
| | 0x237 | 0 | 0 | 0 | 0 | 0 | GPIO2 CFG | 0 | GPIO1 CFG |
| | 0x238 | OVR OUTPUT CFG | | | | 0 | 0 | 0 | 0 |
| JESD | 0x20 | K | | | | | | | |
| | 0x21 | 0 | SYNC SPI EN | SYNC SPI | 0 | 0 | SYSREF MODE | | |
| | 0x22 | LMFS MODE | | | | | | | |
| | 0x24 | DDC CLK DIV | | | | | | | |
| | 0x25 | JESD TX CLK DIV | | | | | | | |
| | 0x27 | 0 | 0 | DROP LSB | 0 | 0 | 0 | CLK BAL EN | 0 |
| | 0x28 | JESD TX LANE EN | | | | | | | |
| | 0x2B | 0 | 0 | 0 | 0 | 0 | 0 | 0 | SYNC INV |
| | 0x2D | 0 | 0 | 0 | 0 | 0 | TEST SEQ SEL | | |
| | 0x2E | RAMP INCR | | | | 0 | RAMP EN | ALT PAT | 0 |
| 0x2F | 0 | PRBS PAT | | PRBS EN | 0 | 0 | 0 | 0 | |

Table 7-53. Register Map Summary (continued)

| PAGE | REGISTER ADDRESS | REGISTER DATA | | | | | | | | |
|------|------------------|-----------------------------|---------------------|--------------|---------------------|-----------------|----------------|-----------------|--------------|--|
| | A[11:0] | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| JESD | 0x30 | START VALUE JESD RAMP DOUT0 | | | | | | | | |
| | 0x32 | START VALUE JESD RAMP DOUT1 | | | | | | | | |
| | 0x34 | START VALUE JESD RAMP DOUT2 | | | | | | | | |
| | 0x36 | START VALUE JESD RAMP DOUT3 | | | | | | | | |
| | 0x40 | START VALUE JESD RAMP DOUT4 | | | | | | | | |
| | 0x42 | START VALUE JESD RAMP DOUT5 | | | | | | | | |
| | 0x44 | START VALUE JESD RAMP DOUT6 | | | | | | | | |
| | 0x46 | START VALUE JESD RAMP DOUT7 | | | | | | | | |
| | 0x53 | SCR EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| | 0x7A | JESD LANE POL INV | | | | | | | | |
| | 0x80 | 0 | LANE DOUT1 SEL | | | 0 | LANE DOUT0 SEL | | | |
| | 0x81 | 0 | LANE DOUT3 SEL | | | 0 | LANE DOUT2 SEL | | | |
| | 0x82 | 0 | LANE DOUT5 SEL | | | 0 | LANE DOUT4 SEL | | | |
| | 0x83 | 0 | LANE DOUT7 SEL | | | 0 | LANE DOUT6 SEL | | | |
| | 0x84 | 0 | 0 | 0 | 0 | 0 | 0 | JESD PLL FACTOR | | |
| | 0x89 | TX EMPH DOUT1 [0] | TX EMPH DOUT0 [5:0] | | | | | | 0 | |
| | 0x8A | 0 | 0 | 0 | TX EMPH DOUT1 [5:1] | | | | | |
| | 0x8B | TX EMPH DOUT3 [0] | TX EMPH DOUT2 [5:0] | | | | | | 0 | |
| | 0x8C | 0 | 0 | 0 | TX EMPH DOUT3 [5:1] | | | | | |
| | 0x8D | TX EMPH DOUT5 [0] | TX EMPH DOUT4 [5:0] | | | | | | 0 | |
| | 0x8E | 0 | 0 | 0 | TX EMPH DOUT5 [5:1] | | | | | |
| | 0x8F | TX EMPH DOUT7 [0] | TX EMPH DOUT6 [5:0] | | | | | | 0 | |
| | 0x90 | 0 | 0 | 0 | TX EMPH DOUT7 [5:1] | | | | | |
| | 0x9D | PD DOUT7 [0] | PD DOUT6 [0] | PD DOUT5 [0] | PD DOUT4 [0] | PD DOUT3 [0] | PD DOUT2 [0] | PD DOUT1 [0] | PD DOUT0 [0] | |
| | 0x9E | PD DOUT7 [1] | PD DOUT6 [1] | PD DOUT5 [1] | PD DOUT4 [1] | PD DOUT3 [1] | PD DOUT2 [1] | PD DOUT1 [1] | PD DOUT0 [1] | |
| | 0x9F | 0 | JESD PLL1 | | | 0 | JESD PLL2 | | | |
| | 0xA0 | 0 | JESD PLL INPUT1 | | | 0 | 0 | 0 | 0 | |
| | 0xA1 | 0 | JESD PLL INPUT2 | | | 0 | 0 | 0 | 0 | |
| | 0xA2 | 0 | 0 | 0 | 0 | JESD PLL INPUT3 | | | 0 | |

Table 7-53. Register Map Summary (continued)

| PAGE | REGISTER ADDRESS | REGISTER DATA | | | | | | | |
|-------------|------------------|--|-------------|----------|--------------|------------|----------------|----|--------------|
| | A[11:0] | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| DDCA/B | 0x100..0x105 | NCO1 FREQUENCY1 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x108..0x10D | NCO1 FREQUENCY2 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x110..0x115 | NCO1 FREQUENCY3 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x118..0x11D | NCO1 FREQUENCY4 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x120..0x125 | NCO2 FREQUENCY1 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x128..0x12D | NCO2 FREQUENCY2 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x130..0x135 | NCO2 FREQUENCY3 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x138..0x13D | NCO2 FREQUENCY4 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x140..0x145 | NCO3 FREQUENCY1 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x148..0x14D | NCO3 FREQUENCY2 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x150..0x155 | NCO3 FREQUENCY3 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x158..0x15D | NCO3 FREQUENCY4 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x160..0x165 | NCO4 FREQUENCY1 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x168..0x16D | NCO4 FREQUENCY2 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x170..0x175 | NCO4 FREQUENCY3 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x178..0x17D | NCO4 FREQUENCY4 [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| | 0x180 | 0 | 0 | DDC PDN | DDC DITH PDN | REAL DDC | DB/QB DDC | 0 | NCO MODE |
| | 0x181 | 0 | 0 | LOAD NCO | | 0 | 0 | 0 | 0 |
| CALIBRATION | 0x34 | 0 | 0 | 0 | 0 | 0 | AVG SEL(2) | | 1 |
| | 0x45 | CAL SPI | CAL GPIO | 0 | 0 | 1 | 0 | 1 | 0 |
| | 0x298 | 0 | 0 | 0 | 0 | CAL STATUS | | | |
| ANALOG | 0x6D | RESET SW [1:0] | | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0x6E | 0 | 0 | 0 | 0 | 0 | RESET SW [3:2] | | |
| | 0x7B | 0 | 0 | TERM A | 0 | 0 | 0 | 0 | TERM A |
| | 0x8B | 0 | 0 | TERM B | 0 | 0 | 0 | 0 | TERM B |
| | 0xA8 | 0 | DITHER AMP1 | | | | 0 | 0 | 0 |
| | 0xAF | DITHER DIS | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| | 0xB1 | DITHER DIVIDER | | | | | | | |
| | 0xB4 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | SYSREF AC EN |
| | 0xCD | 0 | DITH AMP2 | | | 0 | 0 | 0 | 0 |
| | 0xE6 | TX SWING [0] | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0xE7 | 0 | 0 | 0 | 0 | 0 | TX SWING [2:1] | | |

7.6.1 Detailed Register Description

Figure 7-48. Register 0x00

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | RESET |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-54. Register 0x00 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------|------|-------|---|
| 7-1 | 0 | R/W | 0 | Must write 0 |
| 0 | RESET | R/W | 0 | This bit resets all internal registers to the default values. Does not self clear to 0. |

Figure 7-49. Register 0x05

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------|-------------|------------|-----------|-----------|-----------|--------------|-------|
| MEM PAGE | ANALOG PAGE | CALIB PAGE | DDCB PAGE | DDCA PAGE | JESD PAGE | DIGITAL PAGE | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-55. Register 0x05 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|--|
| 7 | MEM PAGE | R/W | 0 | This bit enables access to the MEMORY page 0: MEMORY page access disabled 1: MEMORY page access enabled |
| 6 | ANALOG PAGE | R/W | 0 | This bit enables access to the ANALOG page 0: ANALOG page access disabled 1: ANALOG page access enabled |
| 5 | CALIB PAGE | R/W | 0 | This bit enables access to the CALIBRATION page 0: CALIBRATION page access disabled 1: CALIBRATION page access enabled |
| 4 | DDCB PAGE | R/W | 0 | This bit enables access to the DDCB page. Contents can be written to DDCA and DDCB page simultaneously if it is identical. 0: DDCB page access disabled 1: DDCB page access enabled. |
| 3 | DDCA PAGE | R/W | 0 | This bit enables access to the DDCA page. Contents can be written to DDCA and DDCB page simultaneously if it is identical. 0: DDCA page access disabled 1: DDCA page access enabled |
| 2 | JESD PAGE | R/W | 0 | This bit enables access to the JESD page 0: JESD page access disabled 1: JESD page access enabled |
| 1 | DIGITAL PAGE | R/W | 0 | This bit enables access to the DIGITAL page 0: DIGITAL page access disabled 1: DIGITAL page access enabled |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-50. Register 0x2C (DIGITAL page)

| | | | | | | | |
|------------|--------------|-------|-------|-------|-------|----------|--------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 20-BIT OUT | DDC BAND SEL | | 0 | 0 | 0 | DDC REAL | BYP EN |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-56. Register 0x2C Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|--|
| 7 | 20-BIT OUT | R/W | 0 | This bit enables the 20-bit output mode. It carries the output sample with 20-bit output resolution from the DDC and the sample is filled to 32-bit with 12 trailing 0s. 0: Normal operation 1: 20-bit output mode |
| 6-5 | DDC BAND SEL | R/W | 00 | Selects 1, 2 or 4 DDC per ADC when complex decimation is enabled 0: Single band 1: Dual band 2: Quad band 3: not used |
| 4-2 | 0 | R | 0 | Must write 0 |
| 1 | DDC REAL | R/W | 0 | This bit enables real decimation filter (NCO = 0). BYP EN (D0) must be set to 0. 0: Complex decimation 1: Real decimation |
| 0 | BYP EN | R/W | 0 | This bit enables DDC bypass mode 0: Decimation filter enabled. Complex decimation by default unless D1 is set 1: Decimation filter bypass |

Figure 7-51. Register 0x2D (DIGITAL page)

| | | | | | | | |
|-------|------------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | DECIMATION | | | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-57. Register 0x2D Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|---|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-4 | DECIMATION | R/W | 0 | Selects decimation. 0,1: not used 2: Decimation by 4 3: Decimation by 8 4: Decimation by 16 5: Decimation by 32 6: Decimation by 64 7: Decimation by 128 |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-52. Register 0x2E (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|--------|-------------|-------|-------------|
| 0 | 0 | 0 | 0 | AVG EN | AVG SEL (1) | | OVR ON JESD |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-58. Register 0x2E Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------|------|-------|--|
| 7-4 | 0 | R/W | 0 | Must write 0 |
| 3 | AVG EN | R/W | 0 | This bit enables averaging 0: no average 1: ADC averaging enabled |
| 2-1 | AVG SEL (1) | R/W | 00 | Selects ADC averaging. Also AVG SEL (2) in CALIBRATION page needs to be set. 0: no average 1: 2 ADC average 2: 4 ADC average |
| 0 | OVR ON JESD | R/W | 0 | This bit enables to output OVR flag to replace the LSB in the JESD output stream 0: OVR on GPIO 1: OVR replaces LSB on JESD stream |

Figure 7-53. Register 0x33 (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|--------|-------|---------|-------|
| 0 | 0 | 0 | 1 | FORMAT | 0 | GBL PDN | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-59. Register 0x33 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|---------|------|-------|---|
| 7-5 | 0 | R/W | 0 | Must write 0 |
| 4 | 1 | R/W | 0 | Must write 1 |
| 3 | FORMAT | R/W | 0 | This register bit determines the output data format in DDC bypass mode only. 0: Offset Binary 1: 2s Complement DDC mode only supports 2s complement output format. |
| 2 | 0 | R/W | 0 | Must write 0 |
| 1 | GBL PDN | R/W | 0 | This register bit enables global power down mode 0: normal operation 1: global power down mode enabled |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-54. Register 0x34 (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|------------|------------|-------|-------|-------|-------|-------|
| 0 | MEM STROBE | MEM CH SEL | | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-60. Register 0x34 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|--|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6 | MEM STROBE | R/W | 0 | This register enables fast power down mode 0: normal operation 1: fast power down mode enabled |

Table 7-60. Register 0x34 Field Descriptions (continued)

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|--|
| 5-4 | MEM CH SEL | R/W | 0 | This register selects which ADC channel is used to fill up the capture sample buffer. Only 1 channel can be selected at a time and the samples are captured from the ADC core without averaging or decimation. 00: capture memory is filled from chA1 input 01: capture memory is filled from chA2 input 10: capture memory is filled from chB1 input 11: capture memory is filled from chB2 input |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-55. Register 0x3B (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-------|----------------|-------|----------------|-------|----------------|-------|
| NCO4 CHA [1:0] | | NCO3 CHA [1:0] | | NCO2 CHA [1:0] | | NCO1 CHA [1:0] | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-61. Register 0x3B Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7-6 | NCO4 CHA [1:0] | R/W | 00 | This register is used when selecting the NCO frequency for channel A, band 4 with the SPI interface in quad DDC mode. |
| 5-4 | NCO3 CHA [1:0] | R/W | 00 | This register is used when selecting the NCO frequency for channel A, band 3 with the SPI interface in quad DDC mode. |
| 3-2 | NCO2 CHA [1:0] | R/W | 00 | In single band DDC mode this register is used to select between NCO bank 1 or 2. 00: NCO bank 1 01: NCO bank 2 In dual band DDC mode this register is used to select the NCO frequency for channel A, band 2 with the SPI interface. |
| 1-0 | NCO1 CHA [1:0] | R/W | 00 | This register is used when selecting the NCO1 of channel A with the SPI interface. |

Figure 7-56. Register 0x41 (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-------|----------------|-------|----------------|-------|----------------|-------|
| NCO4 CHB [1:0] | | NCO3 CHB [1:0] | | NCO2 CHB [1:0] | | NCO1 CHB [1:0] | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-62. Register 0x41 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|--|
| 7-6 | NCO4 CHB [1:0] | R/W | 00 | This register is used when selecting the NCO frequency for channel B, band 4 with the SPI interface in quad DDC mode. |
| 5-4 | NCO3 CHB [1:0] | R/W | 00 | This register is used when selecting the NCO frequency for channel B, band 3 with the SPI interface in quad DDC mode. |
| 3-2 | NCO2 CHB [1:0] | R/W | 00 | In single band DDC mode this register is used to select between NCO bank 1 or 2 of channel B. 00: NCO bank 1 01: NCO bank 2 In dual band DDC mode this register is used to select the NCO frequency for channel B, band 2 with the SPI interface. |
| 1-0 | NCO1 CHB [1:0] | R/W | 00 | This register is used when selecting the NCO1 of channel B with the SPI interface. |

Figure 7-57. Register 0x22F (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-----------|-----------|-----------|-----------|-----------|-----------|-------|
| 1 | SYSREF X5 | SYSREF X4 | SYSREF X3 | SYSREF X2 | SYSREF X1 | SYSREF OR | 1 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-63. Register 0x22F Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|---|
| 7 | 1 | R/W | 1 | Must write 1 |
| 6-2 | SYSREF X1..5 | R/W | 0 | These bits are the XOR flags from the SYSREF window monitoring circuitry. The sampling clock gets delayed internally by ~ 160 ps and used to capture the SYSREF signal. If a SYSREF signal transition happens within +/- 50 ps of the SYSREF capture the appropriate XOR flag gets raised. These bits are not sticky - they get overwritten with the next SYSREF rising edge. X1: Window from 110 ps to 135 ps after the rising sampling clock edge X2: Window from 135 ps to 160 ps after the rising sampling clock edge X3: Window from 160 ps to 176 ps after the rising sampling clock edge X4: Window from 176 ps to 192 ps after the rising sampling clock edge X5: Window from 192 ps to 208 ps after the rising sampling clock edge 0: No SYSREF transition detected 1: SYSREF transition detected within given window |
| 1 | SYSREF OR | R/W | 0 | This bit is the output of the five SYSREF XOR flags logically OR'ed together. 0: no SYSREF flag raised 1: one of the five SYSREF XOR flags is raised. |
| 0 | 1 | R/W | 1 | Must write 1 |

Figure 7-58. Register 0x234 (DIGITAL page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|--------------|-------|-------|-------|-------|-----------|-------|
| 0 | NCO SEL MODE | | | 0 | 0 | GPIO MODE | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-64. Register 0x234 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|---|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-5 | NCO SEL MODE | R/W | 00 | These bits select control of the NCO selection in complex decimation. 0: NCO selection using GPIO pins (GPIO MODE (D2-D0) needs to be set accordingly) 2: GPIO1/2 pins are used as a fast serial interface only for the NCO selection for each digital mixer 3: GPIO1/2, SCLK, SDIO pins are used for NCO selection. others: not used Register 0x235 may need to be set as well. |
| 4-3 | 0 | R/W | 0 | Must write 0 |
| 2-0 | GPIO MODE | R/W | 000 | This register sets the functionality of the two GPIO pins 0: GPIO pins are used as SYNC input (LVDS), GPIO1 = SYNC, GPIO2 = SYNCM 1: GPIO1 is used as SYNC input (CMOS) 3: Both GPIO pins are used to select NCOs for the decimation filters 4: GPIO1 is used to disable the calibration 5: GPIO1 is used as start of SYSREF counter others: not used |

Figure 7-59. Register 0x235 (DIGITAL page)

| | | | | | | | |
|----------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| NCO SEL SOURCE | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-65. Register 0x235 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7-0 | NCO SEL SOURCE | R/W | 0 | This register works in conjunction with NCO SEL MODE (0x234). 0x00: NCO selection other than regular SPI (GPIO, Fast SPI etc) 0xFF: NCO selection using regular SPI with addresses 0x3B/41. |

Figure 7-60. Register 0x236 (DIGITAL page)

| | | | | | | | |
|-------|-----------|-----------|-----------|-------|-------|--------------|-----------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | GPIO2 INV | GPIO1 INV | GPIO SWAP | 0 | 0 | SYSREF RESET | SYSREF EN |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-66. Register 0x236 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|--|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6 | GPIO2 INV | R/W | 0 | This bit inverts polarity of the GPIO2 pin 0: Polarity as is 1: Polarity inverted |
| 5 | GPIO1 INV | R/W | 0 | This bit inverts polarity of the GPIO1 pin 0: Polarity as is 1: Polarity inverted |
| 4 | GPIO SWAP | R/W | 0 | This bit swaps GPIO1 and GPIO2 pins internally. 0: Normal operation 1: GPIO1 and GPIO2 are swapped |
| 3-2 | 0 | R/W | 0 | Must write 0 |
| 1 | SYSREF RESET | R/W | 0 | This bit enables and clears the internal SYSREF counter: 0: Normal operation 1: Enables SYSREF and clears the internal counter |
| 0 | SYSREF EN | R/W | 0 | This bit starts the internal SYSREF counter: 0: Normal operation 1: Starts SYSREF counter |

Figure 7-61. Register 0x237 (DIGITAL page)

| | | | | | | | |
|-------|-------|-------|-------|-------|-----------|-------|-----------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | GPIO2 CFG | 0 | GPIO1 CFG |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-67. Register 0x237 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7-3 | 0 | R/W | 0 | Must write 0 |
| 2 | GPIO2 CFG | R/W | 0 | This bit configures GPIO2 pin either as input or output. 0: GPIO2 pin is input 1: GPIO2 pin is output |
| 1 | 0 | R/W | 0 | Must write 0 |
| 0 | GPIO1 CFG | R/W | 0 | This bit configures GPIO1 pin either as input or output. 0: GPIO1 pin is input 1: GPIO1 pin is output |

Figure 7-62. Register 0x238 (DIGITAL page)

| | | | | | | | |
|----------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OVR OUTPUT CFG | | | | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-68. Register 0x238 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7-4 | OVR OUTPUT CFG | R/W | 0000 | This bit configures if the overrange indication (OVR) is output on JESD output stream or on GPIO pins 0000: OVR on JESD 1111: OVR on GPIO |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-63. Register 0x20 (JESD page)

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| K | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-69. Register 0x20 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------|------|----------|---|
| 7-0 | K | R/W | 00000000 | This is JESD204B parameter K which sets number of frames in a multi-frame. Bit value is set as K minus 1. |

Figure 7-64. Register 0x21 (JESD page)

| | | | | | | | |
|-------|-------------|----------|-------|-------|-------------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | SYNC SPI EN | SYNC SPI | 0 | 0 | SYSREF MODE | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-70. Register 0x21 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------|------|-------|--|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6 | SYNC SPI EN | R/W | 0 | This bit enables JESD SYNC control using SPI (ignoring SYNC using GPIO1/2 pins) using bit D5 (SYNC SPI). 0: SPI SYNC disabled 1: SPI SYNC (using register bit D5) enabled |
| 5 | SYNC SPI | R/W | 0 | This bit enables JESD SYNC. SYNC control via SPI must be enabled also (D6). 0: ADC outputs data (SYNC disabled) 1: SYNC enabled (ADC outputs K28.5 characters for JESD interface synchronization) |
| 4-3 | 0 | R/W | 0 | Must write 0 |
| 2-0 | SYSREF MODE | R/W | 000 | This register controls how the ADC processes incoming SYSREF pulses. 0: Ignore all SYSREF pulses 1: Use all SYSREF pulses 2: Don't use SYSREF pulses 3: Skip one SYSREF pulse then use only the next one 4: Skip one SYSREF pulse then use all pulses 5: Skip two SYSREF pulses and then use one 6: Skip two SYSREF pulses and then use all |

Figure 7-65. Register 0x22 (JESD page)

| | | | | | | | |
|-----------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| JESD MODE | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-71. Register 0x22 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|----------|--|
| 7:0 | JESD MODE | R/W | 00000000 | This register sets the LMFS configuration 0: LMFS = 8-2-8-20 (also bit DROP LSB in 0x27 needs to be set) 1: LMFS = 8-2-2-4 3: LMFS = 8-4-2-2 4: LMFS = 8-16-4-1 5: LMFS = 4-16-8-1 6: LMFS = 2-16-16-1 7: LMFS = 1-16-32-1 8: LMFS = 8-8-2-1 9: LMFS = 4-8-4-1 10: LMFS = 2-8-8-1 11: LMFS = 1-8-16-1 12: LMFS = 4-4-2-1 13: LMFS = 2-4-4-1 14: LMFS = 1-4-8-1 15: LMFS = 2-2-2-1 16: LMFS = 1-2-4-1 others: not used |

Figure 7-66. Register 0x24 (JESD page)

| | | | | | | | |
|-------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| DDC CLK DIV | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-72. Register 0x24 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------|------|----------|--|
| 7:0 | DDC CLK DIV | R/W | 00000000 | This register sets the internal clock divider when using the decimation filter. See Table 7-74 . |

Figure 7-67. Register 0x25 (JESD page)

| | | | | | | | |
|-----------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| JESD TX CLK DIV | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-73. Register 0x25 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------------|------|----------|--|
| 7:0 | JESD TX CLK DIV | R/W | 00000000 | This register sets the internal clock divider for the selected LMFS output mode. See Table 7-74 for 16-bit and Table 7-75 for 20-bit output. |

Table 7-74. Register Settings for 0x24/0x25 Based on Bypass/Decimation and LMFS Mode (16-bit Output)

| LMFS | 0x24 (DDC CLK DIV) | | | | | | | 0x25 (JESD TX CLK DIV) | | | | | | |
|-----------|--------------------|----|----|-----|-----|-----|------|------------------------|----|----|-----|-----|-----|------|
| | BYP | /4 | /8 | /16 | /32 | /64 | /128 | BYP | /4 | /8 | /16 | /32 | /64 | /128 |
| 8-2-2-4 | 0 | | | | | | | 0 | | | | | | |
| 8-2-8-20 | 0 | | | | | | | 4 | | | | | | |
| 8-4-8-10 | 1 | | | | | | | 4 | | | | | | |
| 8-4-2-2 | 1 | 0 | 0 | 0 | 0 | | | 0 | 1 | 1 | 1 | 1 | | |
| 8-8-2-1 | | 0 | 0 | 0 | 0 | 0 | | | 0 | 0 | 0 | 0 | 0 | |
| 8-16-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-2-2-2 | | 0 | 0 | 0 | 0 | 0 | 0 | | 1 | 1 | 1 | 1 | 1 | 1 |
| 4-4-2-1 | | 0 | 0 | 0 | 0 | 0 | | | 0 | 0 | 0 | 0 | 0 | |
| 4-8-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-16-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-2-2-1 | | 0 | 0 | 0 | 0 | 0 | | | 0 | 0 | 0 | 0 | 0 | |
| 2-4-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-8-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-16-16-1 | | | 7 | 7 | 7 | 7 | 7 | | | 0 | 0 | 0 | 0 | 0 |
| 1-2-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 1-4-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 1-8-16-1 | | | 7 | 7 | 7 | 7 | 7 | | | 0 | 0 | 0 | 0 | 0 |
| 1-16-32-1 | | | | 15 | 15 | 15 | 15 | | | | 0 | 0 | 0 | 0 |

Table 7-75. Register Settings for 0x24/0x25 Based on Decimation and LMFS Mode (20-bit Output).

| LMFS | 0x24 (DDC CLK DIV) | | | | | | | 0x25 (JESD TX CLK DIV) | | | | | | |
|-----------|--------------------|----|----|-----|-----|-----|------|------------------------|----|----|-----|-----|-----|------|
| | BYP | /4 | /8 | /16 | /32 | /64 | /128 | BYP | /4 | /8 | /16 | /32 | /64 | /128 |
| 8-8-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 8-16-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-4-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-8-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-16-16-1 | | | 7 | 7 | 7 | 7 | 7 | | | 0 | 0 | 0 | 0 | 0 |
| 2-2-4-1 | | 1 | 1 | 1 | 1 | 1 | 1 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-4-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-8-16-1 | | | 7 | 7 | 7 | 7 | 7 | | | 0 | 0 | 0 | 0 | 0 |
| 2-16-32-1 | | | | 15 | 15 | 15 | 15 | | | | 0 | 0 | 0 | 0 |
| 1-2-8-1 | | 3 | 3 | 3 | 3 | 3 | 3 | | 0 | 0 | 0 | 0 | 0 | 0 |
| 1-4-16-1 | | | 7 | 7 | 7 | 7 | 7 | | | 0 | 0 | 0 | 0 | 0 |
| 1-8-32-1 | | | | 15 | 15 | 15 | 15 | | | | 0 | 0 | 0 | 0 |
| 1-16-64-1 | | | | | 31 | 31 | 31 | | | | | 0 | 0 | 0 |

Figure 7-68. Register 0x27 (JESD page)

| | | | | | | | |
|-------|-------|----------|-------|-------|-------|------------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | DROP LSB | 0 | 0 | 0 | CLK BAL EN | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-76. Register 0x27 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|---|
| 7-6 | 0 | R/W | 0 | Must write 0 |
| 5 | DROP LSB | R/W | 0 | This register needs to be set when using the 12-bit output LMFS mode. 0: Drop LSB disabled 1: Drop LSB enabled when using LMFS = 8-2-8-2-20 |
| 4-2 | 0 | R/W | 0 | Must write 0 |
| 1 | CLK BAL EN | R/W | 0 | This register bit needs to be enabled in bypass mode LMFS = 8-2-2-4 only in order to improve some internal clock balancing. 0: CLK BAL disabled 1: CLK BAL EN. Set for LMFS = 8-2-2-4 |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-69. Register 0x28 (JESD page)

| | | | | | | | |
|--------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| JESD LANE EN | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-77. Register 0x28 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|----------|---|
| 7-0 | JESD LANE EN | R/W | 11111111 | This register turns on individual output lanes 0: Lane powered down 1: Serdes lane enabled D0: Lane DOUT0 D1: Lane DOUT1 ... D7: Lane DOUT7 |

Figure 7-70. Register 0x2B

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|----------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | SYNC INV |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-78. Register 0x2B Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------|------|-------|--|
| 7-1 | 0 | R/W | 0 | Must write 0 |
| 0 | SYNC INV | R/W | 0 | This register inverts the polarity from external SYNC pin 0: Polarity as is 1: Polarity inverted |

Figure 7-71. Register 0x2D (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|-------|--------------|-------|-------|
| 0 | 0 | 0 | 0 | 0 | JESD SEQ SEL | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-79. Register 0x2D Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|---|
| 7-3 | 0 | R/W | 0 | Must write 0 |
| 2-0 | JESD SEQ SEL | R/W | 000 | This register selects the JESD test pattern sequence 0: Test sequence disabled 1: Repeat D21.5 high frequency pattern for random jitter (RJ) 2: Repeat K28.5 mixed frequency pattern for deterministic jitter (DJ) 3: Repeat initial lane alignment (ILA) sequence 4: Modified random pattern 5: Scrambled jitter pattern 6: Repeat K28.7 low frequency pattern 7: Short test pattern |

Figure 7-72. Register 0x2E (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------|-------|-------|-------|-------|---------|---------|-------|
| RAMP INCR | | | | 0 | RAMP EN | ALT PAT | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-80. Register 0x2E Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|--|
| 7-4 | RAMP INCR | R/W | 0000 | This register value sets the increment step size for the ramp pattern on 16-bit output. The step size is RAMP INCR plus 1. |
| 3 | 0 | R/W | 0 | Must write 0 |
| 2 | RAMP EN | R/W | 0 | Enables RAMP output pattern in the TRANSPORT LAYER. |
| 1 | ALT PAT | R/W | 0 | Enables a toggle pattern switching between 0x0000 and 0xFFFF in the TRANSPORT LAYER |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-73. Register 0x2F (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------------|-------|----------------|-------|-------|-------|-------|
| 0 | SERDES PRBS | | SERDES PRBS EN | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-81. Register 0x2F Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|--|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-5 | SERDES PRBS | R/W | 0 | This register selects the PRBS pattern in the LINK LAYER (no 8b/10b encoding). PRBS pattern must be enabled (D4). 0: PRBS 2 ⁷ -1 1: PRBS 2 ¹⁵ -1 2: PRBS 2 ²³ -1 3: PRBS 2 ³¹ -1 |
| 4 | SERDES PRBS EN | R/W | 0 | This register enables PRBS test pattern in the LINK LAYER 0: Test pattern mode disabled 1: PRBS test pattern mode enabled |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-74. Register 0x30/32/34/36/40/42/44/46 (JESD page)

| | | | | | | | |
|---|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| START VALUE JESD RAMP DOUT0/1/2/3/4/5/6/7 | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-82. Register 0x30/32/34/36/40/42/44/46 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|---|------|----------|--|
| 7-0 | START VALUE JESD RAMP DOUT0/1/2/3/4/5/6/7 | R/W | 00000000 | The JESD RAMP test pattern is designed to act as an individual RAMP pattern on each output lane. If the starting value on each lane is set to 0 (default), each output lane shows the same RAMP code at any given time. The RAMP pattern can be configured such that the RAMP pattern is constructed across JESD output lanes using the start value registers. DOUT1=1, DOUT2=2, DOUT3=3, DOUT4=0, DOUT5=1, DOUT6=2 and DOUT7=3 as well as the RAMP increment to 4 (RAMP INCR (0x2E) = 0x30) results in a RAMP pattern across lanes for each channel in bypass mode. |

Figure 7-75. Register 0x53 (JESD page)

| | | | | | | | |
|--------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| SCR EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-83. Register 0x53 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------|------|-------|---|
| 7 | SCR EN | R/W | 0 | Enables scrambling of the JESD output data 0: Output scrambling disabled 1: Output scrambling enabled |
| 6-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-76. Register 0x7A (JESD page)

| | | | | | | | |
|-------------------|-------|-------|-------|-------|-------|-------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| JESD LANE POL INV | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-84. Register 0x7A Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|----------|--|
| 7-0 | JESD LANE POL INV | R/W | 00000000 | This register inverts the polarity of the individual SERDES output lanes. Register bit D0 corresponds to SERDES lane DOUT0, D1 to DOUT1 etc 0: Output polarity as is 1: Output polarity inverted |

Figure 7-77. Register 0x80/81/82/83 (JESD page)

| ADDR | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-------|----------------|-------|-------|-------|----------------|-------|-------|
| 0x80 | 0 | LANE DOUT1 SEL | | | 0 | LANE DOUT0 SEL | | |
| 0x81 | 0 | LANE DOUT3 SEL | | | 0 | LANE DOUT2 SEL | | |
| 0x82 | 0 | LANE DOUT5 SEL | | | 0 | LANE DOUT4 SEL | | |
| 0x83 | 0 | LANE DOUT7 SEL | | | 0 | LANE DOUT6 SEL | | |
| | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-85. Register 0x80/81/82/83 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------------|------|-------|---|
| 7,3 | 0 | R/W | 0 | Must write 0 |
| 6-4 | LANE DOUT1/3/5/7 SEL | R/W | 000 | These register bits control the output mux. Any physical serdes output lane (DOUTx) can be connected to any JESD digital stream. By default lane DOUT0 is connected to JESD stream 0, lane DOUT1 to JESD stream 1 etc. 0: JESD stream 0 1: JESD stream 1 ... 7: JESD stream 7 |
| 2-0 | LANE DOUT0/2/4/6 SEL | R/W | 000 | |

Figure 7-78. Register 0x84 (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|-------|-------|-----------------|-------|
| 0 | 0 | 0 | 0 | 0 | 0 | JESD PLL FACTOR | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-86. Register 0x84 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------------|------|-------|---|
| 7-2 | 0 | R/W | 0 | Must write 0 |
| 1-0 | JESD PLL FACTOR | R/W | 00 | This register bit must be set for 12-bit output LMFS = 8-2-8-20 only. 0: all other JESD LMFS modes 1: Set for LMFS = 8-2-8-20 |

Figure 7-79. Register 0x89/8A/8B/8C/8D/8E/8F/90 (JESD page)

| ADDR | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-------------------|---------------------|-------|---------------------|-------|-------|-------|-------|
| 0x89 | TX EMPH DOUT1 [0] | TX EMPH DOUT0 [5:0] | | | | | | 0 |
| 0x8A | 0 | 0 | 0 | TX EMPH DOUT1 [5:1] | | | | |
| 0x8B | TX EMPH DOUT3 [0] | TX EMPH DOUT2 [5:0] | | | | | | 0 |
| 0x8C | 0 | 0 | 0 | TX EMPH DOUT3 [5:1] | | | | |
| 0x8D | TX EMPH DOUT5 [0] | TX EMPH DOUT4 [5:0] | | | | | | 0 |
| 0x8E | 0 | 0 | 0 | TX EMPH DOUT5 [5:1] | | | | |
| 0x8F | TX EMPH DOUT7 [0] | TX EMPH DOUT6 [5:0] | | | | | | 0 |
| 0x90 | 0 | 0 | 0 | TX EMPH DOUT7 [5:1] | | | | |
| | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-87. Register 0x89/8A/8B/8C/8D/8E/8F/90 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-------|---------------------------|------|--------|--|
| 7-5,0 | 0 | R/W | 0 | Must write 0 |
| 6-1 | TX EMPH DOUT0/2/4/6 [5:0] | R/W | 000000 | These bits select the amount of de-emphasis for the JESD output transmitter. The de-emphasis value in dB is measured as the ratio between the peak value after the signal transition to the settled value of the voltage in one bit period. 0: 0 dB 1: -1 dB 3: -2 dB 7: -4.1 dB 15: -6.2 dB 31: -8.2 dB 63: -11.5 dB |
| 4-0,7 | TX EMPH DOUT1/3/5/7 [5:0] | R/W | 000000 | |

Figure 7-80. Register 0x9D/9E (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| PD DOUT7 [0,1] | PD DOUT6 [0,1] | PD DOUT5 [0,1] | PD DOUT4 [0,1] | PD DOUT3 [0,1] | PD DOUT2 [0,1] | PD DOUT1 [0,1] | PD DOUT0 [0,1] |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-88. Register 0x9D/9E Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|--|
| 7-0 | PD DOUTx [0,1] | R/W | 0 | Register 0x9D and 0x9E allow power down of individual serdes output lanes. Register 0x9D (PD DOUTx [0]) covers the output driver, 0x9E (PD DOUTx [1]) covers the associated internal high-speed data clock. 0: Output lane enabled 1: Output lane powered down |

Figure 7-81. Register 0x9F (JESD page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-----------|-------|-------|-------|-----------|-------|-------|
| 0 | JESD PLL1 | | | 0 | JESD PLL2 | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-89. Register 0x9F Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-4 | JESD PLL1 | R/W | 000 | Internal JESD PLL input divider setting. See Table 7-91 how to configure it for the different decimation and LMFS settings. |
| 3 | 0 | R/W | 0 | Must write 0 |
| 2-0 | JESD PLL2 | R/W | 000 | Internal JESD PLL input divider setting. See Table 7-91 how to configure it for the different decimation and LMFS settings. |

Figure 7-82. Register 0xA0/A1/A2 (JESD page)

| ADDR | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-------|-----------------|-------|-------|-----------------|-------|-------|-------|
| 0xA0 | 0 | JESD PLL INPUT1 | | | 0 | 0 | 0 | 0 |
| 0xA1 | 0 | JESD PLL INPUT2 | | | 0 | 0 | 0 | 0 |
| 0xA2 | 0 | 0 | 0 | 0 | JESD PLL INPUT3 | | | 0 |
| | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-90. Register 0xA0/A1/A2 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|-------|--|
| 7-0 | 0 | R/W | 0 | Must write 0 |
| 6-4 | JESD PLL INPUT1/2 | R/W | 000 | Internal JESD PLL input divider setting. See Table 7-91 (16-bit output) and Table 7-91 (20-bit output) how to configure it for the different decimation and LMFS settings. |
| 3-1 | JESD PLL INPUT3 | R/W | 000 | Internal JESD PLL input divider setting. See Table 7-91 (16-bit output) and Table 7-91 (20-bit output) how to configure it for the different decimation and LMFS settings. |

Table 7-91. Register settings for 0x9F/A0/A1/A2 based on bypass/decimation and LMFS mode (16-bit output)

| LMFS | JESD PLL1/2, JESD PLL INPUT 1/2 | | | | | | | JESD PLL INPUT 3 | | | | | | |
|-----------|---------------------------------|----|----|-----|-----|-----|------|------------------|----|----|-----|-----|-----|------|
| | BYP | /4 | /8 | /16 | /32 | /64 | /128 | BYP | /4 | /8 | /16 | /32 | /64 | /128 |
| 8-2-2-4 | 0 | | | | | | | 0 | | | | | | |
| 8-2-8-20 | 0 | | | | | | | 0 | | | | | | |
| 8-4-8-10 | 0 | | | | | | | 1 | | | | | | |
| 8-4-2-2 | 0 | 1 | 2 | 3 | 3 | | | 1 | 0 | 0 | 0 | 2 | | |
| 8-8-2-1 | | 0 | 1 | 2 | 3 | 4 | | 0 | 0 | 0 | 0 | 0 | 0 | |
| 8-16-4-1 | | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-2-2-2 | | 1 | 2 | 3 | | | | 0 | 0 | 0 | | | | |
| 4-4-2-1 | | 0 | 1 | 2 | 3 | 4 | | 0 | 0 | 0 | 0 | 0 | 0 | |
| 4-8-4-1 | | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4-16-8-1 | | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 | 0 |
| 2-2-2-1 | | 0 | 1 | 2 | 3 | 4 | | 0 | 0 | 0 | 0 | 0 | 0 | |
| 2-4-4-1 | | 0 | 0 | 1 | 2 | 3 | 4 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2-8-8-1 | | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 | 0 |
| 2-16-16-1 | | | 0 | 0 | 0 | 1 | 2 | | 3 | 1 | 0 | 0 | 0 | 0 |
| 1-2-4-1 | | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1-4-8-1 | | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 | 0 |

Table 7-91. Register settings for 0x9F/A0/A1/A2 based on bypass/decimation and LMFS mode (16-bit output) (continued)

| | JESD PLL1/2, JESD PLL INPUT 1/2 | | | | | | JESD PLL INPUT 3 | | | | | | | |
|-----------|---------------------------------|--|---|---|---|---|------------------|--|--|---|---|---|---|---|
| | | | | | | | | | | | | | | |
| 1-8-16-1 | | | 0 | 0 | 0 | 1 | 2 | | | 3 | 1 | 0 | 0 | 0 |
| 1-16-32-1 | | | | 0 | 0 | 0 | 1 | | | | 3 | 1 | 0 | 0 |

Table 7-92. Register settings for 0x9F/A0/A1/A2 based on decimation and LMFS mode (20-bit output)

| LMFS | JESD PLL1/2, JESD PLL INPUT 1/2 | | | | | | JESD PLL INPUT 3 | | | | | |
|-----------|---------------------------------|----|-----|-----|-----|------|------------------|----|-----|-----|-----|------|
| | /4 | /8 | /16 | /32 | /64 | /128 | /4 | /8 | /16 | /32 | /64 | /128 |
| 8-8-4-1 | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 |
| 8-16-8-1 | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 |
| 4-4-4-1 | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 |
| 4-8-8-1 | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 |
| 4-16-16-1 | | 0 | 0 | 0 | 1 | 2 | | 3 | 1 | 0 | 0 | 0 |
| 2-2-4-1 | 0 | 0 | 1 | 2 | 3 | 4 | 1 | 0 | 0 | 0 | 0 | 0 |
| 2-4-8-1 | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 |
| 2-8-16-1 | | 0 | 0 | 0 | 1 | 2 | | 3 | 1 | 0 | 0 | 0 |
| 2-16-32-1 | | | 0 | 0 | 0 | 1 | | | 3 | 1 | 0 | 0 |
| 1-2-8-1 | 0 | 0 | 0 | 1 | 2 | 3 | 3 | 1 | 0 | 0 | 0 | 0 |
| 1-4-16-1 | | 0 | 0 | 0 | 1 | 2 | | 3 | 1 | 0 | 0 | 0 |
| 1-8-32-1 | | | 0 | 0 | 0 | 1 | | | 3 | 1 | 0 | 0 |
| 1-16-64-1 | | | | 0 | 0 | 0 | | | | 3 | 1 | 0 |

Figure 7-83. Register 0x100..0x17D (DDCA/B page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--|-------|-------|-------|-------|-------|-------|-------|
| NCOx FREQUENCYx [7:0],[15:8],[23:16],[31:24],[39:32],[47:40] | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-93. Register 0x100..0x17D Field Descriptions

| Bit | Field | Type | Reset | Description |
|------|-----------------|------|-------|--|
| 47:0 | NCOx FREQUENCYx | R/W | 0 | The frequencies for NCOs are located in addresses 0x100 to 0x17D. Each frequency is 48-bit and the MSB starts on the highest address as illustrated in Section 7.3.5.6 . |

Figure 7-84. Register 0x180 (DDCA/B page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|---------|--------------|----------|-----------|-------|----------|
| 0 | 0 | DDC PDN | DDC DITH PDN | REAL DDC | DB/QB DDC | 0 | NCO MODE |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-94. Register 0x180 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|--|
| 7-6 | 0 | R/W | 0 | Must write 0 |
| 5 | DDC PDN | R/W | 0 | This bit powers down the DDC mixer and NCO 0: DDC block enabled 1: DDC block powered down |
| 4 | DDC DITH PDN | R/W | 0 | This bit powers down the dither in the DDC digital block 0: DDC dither enabled 1: DDC dither powered down |
| 3 | REAL DDC | R/W | 0 | Set this bit to 1 in real decimation mode to disable the NCO. 0: Complex Decimation 1: Real Decimation |
| 2 | DB/QB DDC | R/W | 0 | This register splits the NCOs for dual or quad band operation. 0: Dual Band 1: Quad Band |
| 1 | 0 | R/W | 0 | Must write 0 |
| 0 | NCO MODE | R/W | 0 | This register selects phase coherent or phase continuous operation of the NCO. 0: Phase continuous 1: Phase coherent |

Figure 7-85. Register 0x181 (DDCA/B page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|----------|-------|-------|-------|-------|-------|
| 0 | 0 | LOAD NCO | | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-95. Register 0x181 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------|------|-------|--|
| 7-6 | 0 | R/W | 0 | Must write 0 |
| 5-4 | LOAD NCO | R/W | 00 | This register loads all the NCO frequencies from the memory to the NCOs. To update the NCO this register has to be set to 3 and back to 0 as shown in Table 7-96 . |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Table 7-96. NCO frequency programming example

| ADDR | DATA | DESCRIPTION |
|-------|------|--|
| 0x105 | 0x4E | Frequency = 920 MHz with $F_S = 3$ GSPS 86,318,992,857,935 = 0x4E81B4E81BE4 where the MSB goes to address 0x105 and the LSB to 0x100. |
| 0x104 | 0x81 | |
| 0x103 | 0xB4 | |
| 0x102 | 0xE8 | |
| 0x101 | 0x1B | |
| 0x100 | 0x4E | |
| 0x181 | 0x00 | Load and update all NCO frequencies |
| 0x181 | 0x30 | |

Figure 7-86. Register 0x34 (CALIBRATION page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|-------|-------------|-------|-------|
| 0 | 0 | 0 | 0 | 0 | AVG SEL (2) | | 1 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-97. Register 0x34 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------|------|-------|---|
| 7-3 | 0 | R/W | 0 | Must write 0 |
| 2-1 | AVG SEL (2) | R/W | 00 | Selects ADC averaging. Also AVG SEL (1) in DIGITAL page needs to be set. 0: no average 01: 2 ADC average 10: not used 11: 4 ADC average |
| 0 | 1 | R/W | 1 | Must write 1 |

Figure 7-87. Register 0x45 (CALIBRATION page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------|----------|-------|-------|-------|-------|-------|-------|
| CAL SPI | CAL GPIO | 0 | 0 | 1 | 0 | 1 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-98. Register 0x45 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------|------|-------|---|
| 7 | CAL SPI | R/W | 0 | This register triggers the calibration using SPI write. It needs to be toggled (0=>1=>0). |
| 6 | CAL GPIO | R/W | 0 | This register triggers the calibration using the GPIO1 pin. |
| 5-4 | 0 | R/W | 0 | Must write 0 |
| 3 | 1 | R/W | 1 | Must write 1 |
| 2 | 0 | R/W | 0 | Must write 0 |
| 1 | 1 | R/W | 1 | Must write 1 |
| 0 | 0 | R/W | 0 | Must write 0 |

Figure 7-88. Register 0x298 (CALIBRATION page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|------------|-------|-------|-------|
| 0 | 0 | 0 | 0 | CAL STATUS | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-99. Register 0x298 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|---|
| 7-4 | 0 | R/W | 0 | Must write 0 |
| 3-0 | CAL STATUS | R/W | 0000 | This register can be used to check if calibration state machine has finished without any errors. A value of 0xE indicates successful calibration. |

Figure 7-89. Register 0x6D/6E (ANALOG page)

| | | | | | | | |
|----------------|-------|-------|-------|-------|-------|----------------|-------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESET SW [1:0] | | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | RESET SW [3:2] | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-100. Register 0x6D/6E Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7-6 | RESET SW [1:0] | R/W | 00 | This register disables the sampling reset switch. 00: Sampling reset switch enabled 1: Sampling reset switch disabled |
| 5-0 | 0 | R/W | 0 | Must write 0 |
| 1-0 | RESET SW [3:2] | R/W | 00 | This register disables the sampling reset switch. 00: Sampling reset switch enabled 1: Sampling reset switch disabled |
| 7-2 | 0 | R/W | 0 | Must write 0 |

Figure 7-90. Register 0x7B (ANALOG page)

| | | | | | | | |
|-------|-------|--------|-------|-------|-------|-------|--------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | TERM A | 0 | 0 | 0 | 0 | TERM A |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-101. Register 0x7B Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------|------|-------|---|
| 7-6 | 0 | R/W | 0 | Must write 0 |
| 5,0 | TERM A | R/W | 00 | These registers set the internal termination resistor at the analog inputs for channel A1 and A2. Both registers need to be set to the same value. 0: 100 ohm differential termination 1: 50 ohm differential termination |
| 4-1 | 0 | R/W | 0 | Must write 0 |

Figure 7-91. Register 0x8B (ANALOG page)

| | | | | | | | |
|-------|-------|--------|-------|-------|-------|-------|--------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | TERM B | 0 | 0 | 0 | 0 | TERM B |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-102. Register 0x8B Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------|------|-------|---|
| 7-6 | 0 | R/W | 0 | Must write 0 |
| 5,0 | TERM B | R/W | 00 | These registers set the internal termination resistor at the analog inputs for channel B1 and B2. Both registers need to be set to the same value. 0: 100 ohm differential termination 1: 50 ohm differential termination |
| 4-1 | 0 | R/W | 0 | Must write 0 |

Figure 7-92. Register 0xA8 (ANALOG page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-------|-----------|-------|-------|-------|-------|-------|-------|---|
| 0 | DITH AMP1 | | | | | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | |

Table 7-103. Register 0xA8 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-3 | DITH AMP1 | R/W | 0000 | This register sets dither amplitude coarse gain. There are two recommended settings: 0000: Amplitude = 0 0011: Amplitude = 3 Here is a list of all the settings: 0000: Amplitude = 0 (smallest) 0001: Amplitude = 1 ... 1110: Amplitude = 14 1111: Amplitude = 15 (largest) |
| 2-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-93. Register 0xAF (ANALOG page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|-------|-------|-------|-------|-------|-------|-------|
| DITHER DIS | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-104. Register 0xAF Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|--|
| 7 | DITHER DIS | R/W | 0 | This register disables internal dither. 0: Dither enabled 1: Dither disabled |
| 6-5 | 0 | R/W | 0 | Must write 0 |
| 4 | 1 | R/W | 0 | Must write 1 |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-94. Register 0xB1 (ANALOG page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-------|-------|-------|-------|-------|-------|-------|
| DITHER DIVIDER | | | | | | | |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-105. Register 0xB1 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|--|
| 7-0 | DITHER DIVIDER | R/W | 0 | This register sets the dither divider frequency. SPI write is actual -1. For example a divider of 48 is 47 (0x2F). 0x00 (default) is a divide /50 |

Figure 7-95. Register 0xB4 (ANALOG page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|-------|-------|-------|-------|-------|-----------|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | SYSREF AC |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-106. Register 0xB4 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7-1 | 0 | R/W | 0 | Must write 0 |
| 0 | SYSREF AC | R/W | 0 | This register enables external AC coupling of the SYSREF input with internal biasing. 0: External DC coupling with internal 100 Ω termination 1: External AC coupling with internal biasing |

Figure 7-96. Register 0xCD (ANALOG page)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-----------|-------|-------|-------|-------|-------|-------|
| 0 | DITH AMP2 | | | 0 | 0 | 0 | 0 |
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-107. Register 0xCD Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7 | 0 | R/W | 0 | Must write 0 |
| 6-4 | DITH AMP2 | R/W | 0 | This register sets dither amplitude fine gain. There are two recommended settings: 000: Amplitude = 0 100: Amplitude = -4 Here is a list of all the settings: 000: Amplitude = 0 001: Amplitude = 1 010: Amplitude = 2 011: Amplitude = 3 (largest) 100: Amplitude = -4 (smallest) 101: Amplitude = -3 110: Amplitude = -2 111: Amplitude = -1 |
| 3-0 | 0 | R/W | 0 | Must write 0 |

Figure 7-97. Register 0xE6/E7 (ANALOG page)

| ADDR | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|--------------|-------|-------|-------|-------|-------|----------------|-------|
| 0xE6 | TX SWING [0] | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0xE7 | 0 | 0 | 0 | 0 | 0 | 0 | TX SWING [2:1] | |
| | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |

Table 7-108. Register 0xE6/E7 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-------|----------------|------|-------|---|
| 7-0 | 0 | R/W | 0 | Must write 0 |
| 1,0,7 | TX SWING [2:0] | R/W | 000 | This register adjusts the output amplitude on all 8 serdes lanes. 0: 850 mVpp 1: 825 mVpp 2: 800 mVpp 3: 775 mVpp 4: 950 mVpp 5: 925 mVpp 6: 900 mVpp 7: 875 mVpp |

8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

The ADC32RF5x can be used in a wide range of applications including radar, frequency domain digitizer and spectrum analyzer, test and communications equipment and software-defined radios (SDRs). The Typical Applications section describe one configuration that meets the needs of a number of these applications.

8.2 Typical Applications

8.2.1 Wideband RF Sampling Receiver

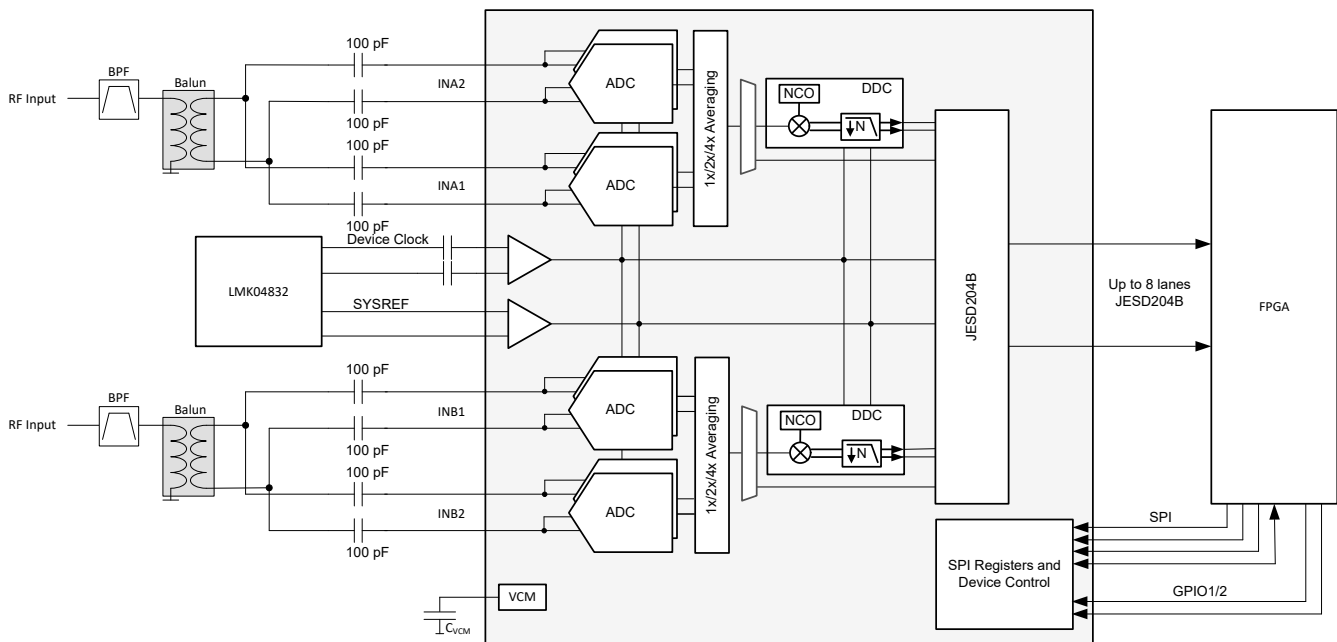


Figure 8-1. Typical Configuration for Wideband RF Sampling

8.2.1.1 Design Requirements

8.2.1.1.1 Input Signal Path

Appropriate band limiting filters should be used to reject unwanted frequencies in the receive signal path.

A 1:2 (for 100 ohm effective termination impedance) or a 1:1 (for 50 ohm effective termination impedance) balun transformer is needed to convert the single ended RF input to differential for input to the ADC. The balun outputs should be AC coupled with 100 pF capacitors. The balun should have good amplitude (< 0.5 dB) and phase balance (less than 2 deg) within the frequency range of interest. A back-to-back balun configuration often times gives better SFDR performance. [Table 8-1](#) lists a number of recommended baluns for different impedance ratios and frequency ranges.

The S-parameters of the ADC input can be used in order to design the front end matching network.

Table 8-1. Recommended Baluns

| PART NUMBER | MANUFACTURER | IMPEDANCE RATIO | AMPLITUDE BALANCE (dB) | PHASE BALANCE (°) | FREQUENCY RANGE |
|-------------|-----------------|-----------------|------------------------|-------------------|------------------|
| BAL-0009SMG | Marki Microwave | 1:2 | 0.6 | 5 | 0.5 MHz to 9 GHz |
| TCM2-43X+ | Minicircuits | 1:2 | 0.5 | 7 | 10 MHz to 4 GHz |
| TCM2-33WX+ | Minicircuits | 1:2 | 0.7 | 4 | 10 MHz to 3 GHz |
| TC1-1-13M+ | Minicircuits | 1:1 | 0.5 | 2-3 | 10 MHz to 3 GHz |

8.2.1.1.2 Clocking

The device clock inputs must be AC-coupled to the device to provide the rated performance. The clock source must have low jitter (integrated phase noise) for the ADC to meet the stated SNR performance, especially when operating at higher input frequencies. The clock signal may need to be filtered with a band pass filter in order to remove some of the broad band clock noise.

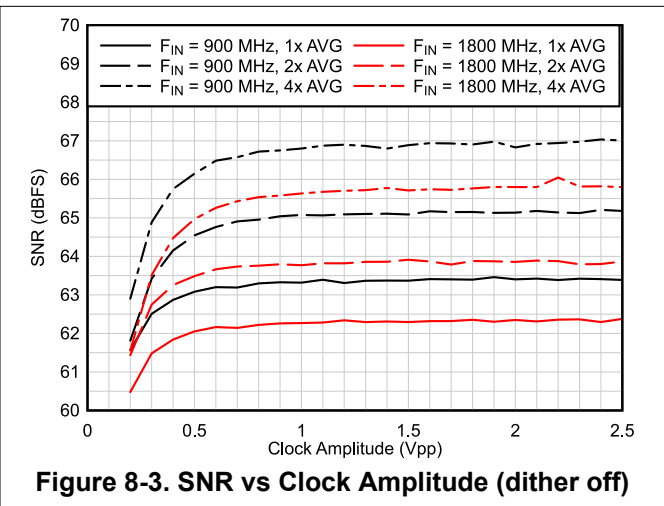
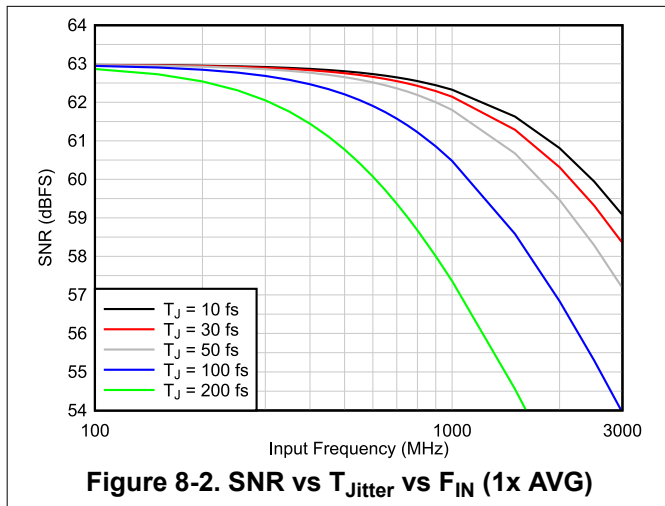
The JESD204B data converter system (ADC and FPGA) requires additional SYSREF and device clocks. The LMK04828 or LMK04832 devices are suitable to generate these clocks. Depending on the ADC clock frequency and jitter requirements. The device may also be used as a system clock synthesizer or as a device clock and SYSREF distribution device when using multiple ADC32RF5x devices in a system.

8.2.1.2 Detailed Design Procedure

8.2.1.2.1 Sampling Clock

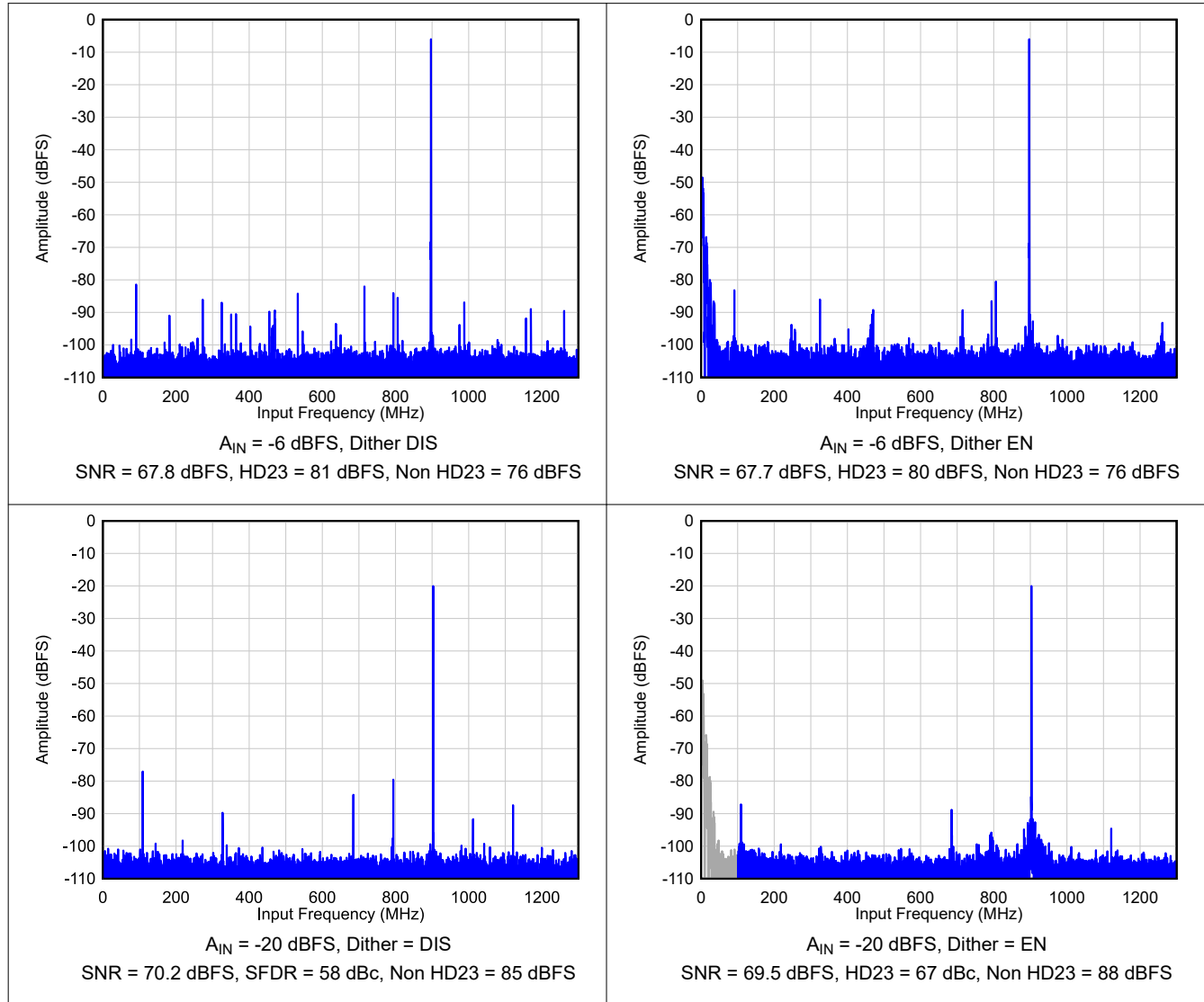
In order to maximize the SNR performance of the ADC a very low jitter (< 50 fs) sampling clock is required. Figure 8-2 shows the estimated SNR performance vs input frequency vs external clock jitter. The internal ADC aperture jitter also has some dependency to the clock amplitude (gets more sensitive with higher input frequency) as shown in Figure 8-3.

When using averaging and/or decimation, the SNR for a single ADC core should be estimated first before adding the SNR improvement from internal averaging and/or decimation.



8.2.1.3 Application Curves

The following application curves demonstrate performance and results only of the ADC using a balun front end and configured to 4x internal averaging. The input frequency is 900 MHz ($F_S = 2.6$ GSPS) and input amplitudes of -6 and -20 dBFS are shown with dither enabled/disabled.



8.3 Initialization Set Up

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a low pulse on the RESET pin, as shown in Figure 8-4.

1. Apply 1.2 V DVDD digital power supply
2. Apply remaining 1.2 V power supplies (AVDD12, CLKVDD), in no specific order
3. Apply 1.8 V AVDD18 power supply
4. Apply hardware reset. After hardware reset is released, the default registers are loaded from internal fuses.
5. Begin programming the internal registers using the SPI interface.

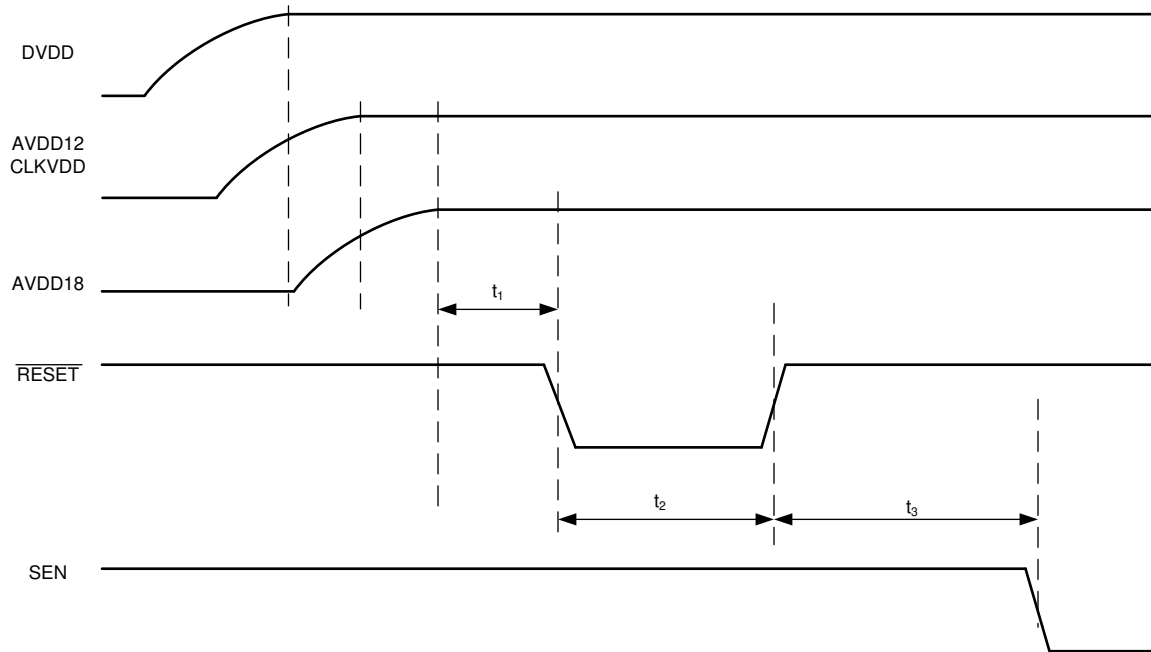


Figure 8-4. Initialization of Serial Registers After Power-Up

Table 8-2. Power-Up Timing

| | | MIN | TYP | MAX | UNIT |
|----------------|--|-----|-----|-----|--------------|
| t ₁ | Power-on delay: delay from power up to active high RESET pulse | 1 | | | ms |
| t ₂ | Reset pulse width: active low RESET pulse width | 100 | | | ns |
| t ₃ | Register write delay: delay from RESET disable to SEN active | 45k | | | Clock cycles |

8.3.1 Initial Device Configuration After Power-Up

The following section outlines the sequence of register writes for the device configuration after initial power-up.

Table 8-3. Summary of Programming Steps After Initial Power-Up

| Step | Section | Description |
|------|---------------|--|
| 1 | RESET | Hardware and software RESET in order to reset all registers to known state |
| 2 | DEVICE CONFIG | Configures the digital operating modes like averaging, test pattern output, input termination, internal dither and decimation. |
| 3 | JESD | Configures the JESD204B interface |
| 4 | SYSREF | Enables SYSREF input and resets internal circuits based on external SYSREF signal. |
| 5 | JESD | Clears and configures some of the JESD registers |
| 6 | TRIM | Set trim settings for best analog performance |
| 7 | CALIB CONFIG | Configure the calibration settings |
| 8 | SYSREF | Issue SYSREF for trim settings to go into effect |
| 9 | RUN CALIB | Run power up calibration |
| 10 | JESD | Synchronize the JESD interface with the receiver |

The following sections outlines the detailed register writes for the device configuration after initial power up. This includes all the register writes (fields in grey) which are not documented in the register summary table. The register examples are given for 2x internal averaging, DDC bypass mode (LMFS = 8224).

8.3.1.1 STEP 1: RESET

After the initial power up, both hardware and software reset are required.

Table 8-4. Register Programming Sequence for Software RESET

| ADDRESS | DATA | DESCRIPTION |
|---------|------|--|
| 0x00 | 0x01 | Software set and reset |
| 0x00 | 0x00 | |
| 0x01 | 0x00 | These two resets are staggered in order to minimize strain on external power supply. |
| 0x09 | 0x20 | |
| 0x09 | 0x80 | |
| 0x09 | 0x00 | Internal memory reset (set and reset) |
| 0x08 | 0x01 | |
| 0x08 | 0x00 | Select ANALOG page |
| 0x05 | 0x40 | |
| 0x47 | 0x80 | Analog reset (set and reset) |
| 0x47 | 0x00 | |

8.3.1.2 STEP 2: Device Configuration

In this step, the operating mode and digital features (DDC, test pattern) are configured.

Table 8-5. Register Programming Sequence for Device Configuration

| ADDRESS | DATA | DESCRIPTION |
|---------|------|---|
| 0x05 | 0x20 | Select CALIBRATION page |
| 0x34 | 0x03 | Select 2x averaging (1x AVG: 0x01, 4x AVG: 0x07) |
| 0x05 | 0x02 | Select DIGITAL page |
| 0x2C | 0x01 | Select DDC Bypass mode |
| 0x2D | 0x00 | No decimation, step can be skipped |
| 0x2E | 0x0B | Select 2x averaging (1x: 0x09, 2x: 0x0B, 4x: 0x0D), OVR on JESD |
| 0x23C | 0x07 | Set register to 0x07 |
| 0x33 | 0x10 | Set register to 0x10 |
| 0x2F | 0x11 | Set register to 0x11 (1x: 0x55, 2x: 0x11, 4x: 0xE1) |
| 0x30 | 0x11 | Set register to 0x11 (1x: 0x55, 2x: 0x11, 4x: 0xE1) |
| 0x05 | 0x40 | Select ANALOG page |
| 0x7B/8B | 0x00 | Select internal input termination (0x00 = 100 Ω) |
| 0xA8 | 0x00 | DITHER AMP1: 3 = 0x80, 0 = 0x00 |
| 0xCD | 0x00 | DITHER AMP2: -4 = 0x40, 0 = 0x00 |
| 0x04 | 0x01 | |
| 0x20 | 0x04 | |
| 0x91 | 0x40 | |
| 0xAF | 0x10 | |
| 0xB1 | 0x00 | Sets dither divider. 0x00 = /50 |
| 0xB2 | 0x00 | |
| 0xAF | 0x18 | |
| 0xAF | 0x10 | 0x10 = dither ENABLED, 0x90 = dither DISABLED |
| 0x04 | 0x01 | |
| 0x20 | 0x00 | |
| 0x04 | 0x00 | |
| 0x05 | 0x02 | |
| 0x363 | 0x01 | |
| 0x05 | 0x18 | Select DDCA and DDCB pages, load non linearity correction (NLC) trims |
| 0x21D | 0x00 | |
| 0x21E | 0x01 | |
| 0x205 | 0x03 | |
| 0x204 | 0xFF | |
| 0x31D | 0x00 | |
| 0x31E | 0x01 | |
| 0x305 | 0x03 | |
| 0x304 | 0xFF | |
| 0x31C | 0x3E | |
| 0x325 | 0x00 | Load NLC |
| 0x325 | 0x01 | |
| 0x325 | 0x00 | |

Table 8-5. Register Programming Sequence for Device Configuration (continued)

| ADDRESS | DATA | DESCRIPTION | | | | |
|---------------|-----------------|-------------|------------------|------|------------------|------|
| Sampling Rate | 640 - 2250 MSPS | | 2250 - 2800 MSPS | | 2800 - 3000 MSPS | |
| Nyquist Zone | 1st | 2nd | 1st | 2nd | 1st | 2nd |
| 0x206 | 0x0E | 0x0F | 0x27 | 0x10 | 0x00 | 0x00 |
| 0x207 | 0x00 | 0x00 | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x208 | 0x00 | 0x00 | 0xA6 | 0x52 | 0x00 | 0x00 |
| 0x209 | 0x00 | 0x00 | 0x03 | 0x00 | 0x00 | 0x00 |
| 0x20A | 0xF5 | 0xF4 | 0x8D | 0x4D | 0x00 | 0x00 |
| 0x20B | 0x03 | 0x03 | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x20C | 0x27 | 0x28 | 0xBD | 0xC2 | 0x00 | 0x00 |
| 0x20D | 0x00 | 0x00 | 0x03 | 0x00 | 0x00 | 0x00 |
| 0x210 | 0xFC | 0F9 | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x211 | 0x03 | 0x03 | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x212 | 0x5F | 0xFD | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x213 | 0x03 | 0x03 | 0x00 | 0x00 | 0x00 | 0x00 |
| 0x21A | 0x3C | 0x3D | 0x3C | 0x3D | 0x3C | 0x3D |
| 0x21C | 0x00 | 0x00 | 0x00 | 0x00 | 0x00 | 0x02 |
| 0x223 | 0xFF | 0xFF | 0xFF | 0xFF | 0x00 | 0x00 |
| 0x224 | 0xFF | 0xFF | 0xFF | 0xFF | 0x00 | 0x00 |
| 0x225 | 0x00 | Load NLC | | | | |
| 0x225 | 0x01 | | | | | |
| 0x225 | 0x00 | | | | | |
| 0x20 | 0x02 | OVR MUX EN | | | | |
| 0x203 | 0x30 | | | | | |
| 0x303 | 0x30 | | | | | |
| 0x180 | 0x30 | | | | | |

8.3.1.3 STEP 3: JESD Interface Configuration (1)

In this step, the JESD204B digital interface and the parameters are configured.

Table 8-6. Register Programming Sequence for JESD204B Interface Configuration

| ADDRESS | DATA | DESCRIPTION |
|---------|------|--|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x81 | 0x00 | Set register to 0x00 |
| 0x80 | 0xF0 | Set register to 0xF0 |
| 0x7F | 0xFF | Set register to 0xFF |
| 0x7E | 0xFF | Set register to 0xFF |
| 0x7D | 0xFF | Set register to 0xFF |
| 0x7C | 0xFF | Set register to 0xFF |
| 0x7B | 0x3B | Set register to 0x3B |
| 0x7A | 0x28 | Set register to 0x28 |
| 0x79 | 0x51 | Set register to 0x51 |
| 0x78 | 0x40 | Set register to 0x40 |
| 0x05 | 0x04 | Select JESD page |
| 0x23 | 0x03 | Set register to 0x03 |
| 0x29 | 0xFF | Set register to 0xFF |
| 0x20 | 0x0F | Select K (0x0F: K=15) |
| 0x21 | 0x01 | SYSREF mode |
| 0x22 | 0x01 | Select LMFS configuration (LMFS = 8-2-2-4) |
| 0x24 | 0x00 | Select DDC CLK DIV |
| 0x25 | 0x00 | Select JESD TX CLK DIV |
| 0x26 | 0x00 | |
| 0x27 | 0x02 | Select CLK BAL EN for LMFS = 8-2-2-4 |
| 0x53 | 0x80 | Output scrambler EN/DIS (SCR EN) |
| 0x5C | 0x01 | F-1 in ILA (F=2) |
| 0x5D | 0x0F | K-1 in ILA (K=15) |
| 0x6E | 0x11 | |
| 0xA0 | 0x00 | |
| 0xA1 | 0x00 | Select JESD PLL INPUT divider 1/2/3 |
| 0xA2 | 0x00 | |
| 0x9F | 0x00 | Select JESD PLL setting |
| 0x2A | 0x0C | |
| 0x23 | 0x02 | JESD INIT toggle |
| 0x23 | 0x00 | |

8.3.1.4 STEP 4: SYSREF Synchronization

After device and JESD204B interface configuration a synchronization using external SYSREF is necessary.

Table 8-7. Device Synchronization Using External SYSREF

| ADDRESS | DATA | DESCRIPTION |
|---------|------|---|
| 0x05 | 0x02 | Select DIGITAL page |
| 0x236 | 0x02 | Enable internal SYSREF input and clear SYSREF pulse counter |
| 0x236 | 0x03 | Starts SYSREF counter |

8.3.1.5 STEP 5: JESD Interface Configuration (2)

Some registers of the JESD204B interface need to be set after the first SYSREF.

Table 8-8. Register Programming Sequence for JESD204B Interface Configuration

| ADDRESS | DATA | DESCRIPTION |
|---------|------|------------------|
| 0x05 | 0x04 | Select JESD page |
| 0x29 | 0x00 | |
| 0x84 | 0x00 | JESD PLL factor |

8.3.1.6 STEP 6: Analog Trim Settings

The following registers need to be set for best analog performance. The register write order is all writes in first 2 columns before moving to the next set of address/data in middle columns, and so on.

Table 8-9. Analog Trim Setting Registers

| ADDR | DATA | COMMENT | ADDR | DATA | COMMENT | ADDR | DATA | COMMENT |
|-------|------|---------------------------|-------|---|---------------------------|-------|------|---------------------------|
| 0x05 | 0x40 | | 0x3B | 0x0C | Only for $F_S < 2.9$ GSPS | 0x56 | 0x0F | |
| 0xE8 | 0xF0 | | 0xA8 | 1x AVG: 0x18 2x/4x AVG: $F_S < 1.1$ GSPS: 0x00 $F_S = 1.1-1.8$ GSPS: 0x08 $F_S = 1.85-2.6$ GSPS: 0x60 $F_S = 2.6-3.0$ GSPS: 0x70 | | 0x6E | 0x08 | |
| 0xE9 | 0x01 | | | | 0x102 | 0x02 | | |
| 0x4B | 0x1F | | | | 0x103 | 0xD9 | | |
| 0x5B | 0x01 | | | | 0xA7 | 0x00 | | |
| 0xEA | 0x00 | | | | 0xA6 | 0x08 | | |
| 0xEB | 0x03 | | 0xCD | 0x00 | | 0x05 | 0x20 | |
| 0x95 | 0x00 | | 0xCE | 0x00 | | 0xC9 | 0x09 | |
| 0xFC | 0x28 | | 0x100 | See Table 8-10 for sample rate dependent trim registers | | 0x102 | 0xFE | |
| 0xE0 | 0x8E | | 0x101 | | 0x03 | | | |
| 0xE1 | 0x03 | | 0x104 | | 0xD4 | | | |
| 0x4C | 0x40 | | 0x105 | | 0x03 | | | |
| 0x4E | 0x01 | | 0x107 | 0x10 | | 0x106 | 0xFE | |
| 0x4E | 0x00 | | 0x05 | 0x20 | | 0x107 | 0x03 | |
| 0xA1 | 0x01 | | 0x30 | 0xE8 | | 0x108 | 0xBC | |
| 0xF8 | 0x00 | | 0x31 | 0xFF | | 0x109 | 0x1A | |
| 0x31 | 0x20 | | 0x30 | 0x08 | | 0x101 | 0x01 | |
| 0xFD | 0x1C | | 0x31 | 0x80 | | 0x159 | 0x63 | |
| 0xAA | 0x02 | | 0x32 | 0x03 | | 0x05 | 0x40 | |
| 0x4D | 0x80 | | 0x05 | 0x02 | | 0x31 | 0x00 | |
| 0xB3 | 0x30 | | 0x243 | 0x02 | | 0x4D | 0x00 | |
| 0x64 | 0x10 | | 0x05 | 0x20 | | 0x62 | 0x10 | |
| 0x62 | 0x12 | | 0x36 | 0x04 | | 0x56 | 0x0E | |
| 0xFE | 0x80 | | 0x1F8 | 0x01 | | 0x56 | 0x0C | |
| 0xFC | 0x28 | | 0x1FC | 0x0A | | 0x56 | 0x08 | |
| 0xFF | 0x14 | | 0x1F0 | 0x20 | | 0x56 | 0x00 | |
| 0x106 | 0x00 | | 0x1F1 | 0x0C | | 0x6E | 0x00 | |
| 0x107 | 0x00 | | 0x05 | 0x40 | | 0xF8 | 0x06 | |
| 0x3D | 0x06 | Only for $F_S > 2.9$ GSPS | 0x39 | 0x40 | | 0x102 | 0x42 | Only for $F_S > 2.9$ GSPS |
| 0x104 | 0x60 | | 0x56 | 0x01 | | | | |
| 0xB0 | 0x00 | | 0x56 | 0x03 | | | | |
| 0xB1 | 0x03 | | 0x56 | 0x07 | | | | |

Table 8-10. Sample rate dependent trim registers

| F _S (GSPS) | 0x100 | 0x101 | 0x104 | 0x105 |
|-----------------------|-------|-------|-------|-------|
| 0.6-0.7 | 0x48 | 0x00 | 0x01 | 0x01 |
| 0.7-0.9 | 0xC8 | 0x01 | 0x81 | 0x00 |
| 0.9-1.1 | 0x48 | 0x01 | 0x81 | 0x00 |
| 1.1-1.3 | 0xC8 | 0x00 | 0x81 | 0x00 |
| 1.3-1.5 | 0x48 | 0x00 | 0x81 | 0x00 |
| 1.5-1.7 | 0xC8 | 0x01 | 0x01 | 0x00 |
| 1.7-1.9 | 0x48 | 0x01 | 0x01 | 0x00 |
| 1.9-2.1 | 0xC8 | 0x00 | 0x01 | 0x00 |
| 2.1-2.3 | 0x48 | 0x00 | 0x01 | 0x00 |
| 2.3-2.5 | 0xC8 | 0x01 | 0x81 | 0x03 |
| 2.5-2.7 | 0x48 | 0x01 | 0x81 | 0x03 |
| 2.7-2.9 | 0xC8 | 0x00 | 0x81 | 0x03 |
| 2.9-3.0 | 0x48 | 0x00 | 0xE1 | 0x03 |

8.3.1.7 STEP 7: Calibration Configuration

The following registers configure the internal foreground calibration. The register write order is all writes in first 2 columns before moving to the next set of address/data in middle columns, and so on.

Table 8-11. Calibration Register Settings

| ADDRESS | DATA | ADDRESS | DATA | ADDRESS | DATA |
|---------|------|---------|------|---------|------|
| 0x05 | 0x40 | 0xFC | 0x13 | 0x47 | 0xC7 |
| 0x68 | 0xC0 | 0xFD | 0x08 | 0x46 | 0x13 |
| 0x69 | 0xFF | 0x36 | 0x04 | 0xFC | 0x13 |
| 0x05 | 0x20 | 0x36 | 0x05 | 0xFD | 0x00 |
| 0x46 | 0x03 | 0x36 | 0x04 | 0x36 | 0x04 |
| 0x47 | 0xC2 | 0xFC | 0x13 | 0x36 | 0x05 |
| 0x46 | 0x13 | 0xFD | 0x0A | 0x36 | 0x04 |
| 0x1AE | 0x00 | 0x36 | 0x04 | 0xFC | 0x13 |
| 0x1E6 | 0x1C | 0x36 | 0x05 | 0xFD | 0x02 |
| 0x1AE | 0x00 | 0x36 | 0x04 | 0x36 | 0x04 |
| 0x1E6 | 0x1C | 0xFC | 0x13 | 0x36 | 0x05 |
| 0x1E9 | 0x08 | 0xFD | 0x0C | 0x36 | 0x04 |
| 0x1E9 | 0xA8 | 0x36 | 0x04 | 0xFC | 0x13 |
| 0x1E8 | 0x02 | 0x36 | 0x05 | 0xFD | 0x04 |
| 0x1E8 | 0x06 | 0x36 | 0x04 | 0x36 | 0x04 |
| 0x1E8 | 0x04 | 0xFC | 0x13 | 0x36 | 0x05 |
| 0x1E8 | 0x00 | 0xFD | 0x0E | 0x36 | 0x04 |
| 0x1E9 | 0xA0 | 0x36 | 0x04 | 0xFC | 0x13 |
| 0x1F0 | 0x28 | 0x36 | 0x05 | 0xFD | 0x06 |
| 0x1F1 | 0x0C | 0x36 | 0x04 | 0x36 | 0x04 |
| 0x1F0 | 0x2A | 0xFC | 0x03 | 0x36 | 0x05 |
| 0x1F0 | 0x2E | 0x36 | 0x04 | 0x36 | 0x04 |
| 0x1F0 | 0x2C | 0x46 | 0x03 | 0xFC | 0x13 |
| 0x1F0 | 0x28 | 0x47 | 0xC0 | 0xFD | 0x08 |
| 0x1F0 | 0x08 | 0x46 | 0x13 | 0x36 | 0x04 |
| 0x1F0 | 0x18 | 0x46 | 0x03 | 0x36 | 0x05 |

Table 8-11. Calibration Register Settings (continued)

| ADDRESS | DATA | ADDRESS | DATA | ADDRESS | DATA |
|---------|------|---------|------|---------|------|
| 0x1F0 | 0x38 | 0x47 | 0xC7 | 0x36 | 0x04 |
| 0x1F1 | 0x0C | 0x46 | 0x13 | 0xFC | 0x13 |
| 0x1F0 | 0x3A | 0x1AE | 0x00 | 0xFD | 0x0A |
| 0x1F0 | 0x3E | 0x1E6 | 0x1C | 0x36 | 0x04 |
| 0x1F0 | 0x3C | 0x1AE | 0x00 | 0x36 | 0x05 |
| 0x1F0 | 0x38 | 0x1E6 | 0x1C | 0x36 | 0x04 |
| 0x1F0 | 0x18 | 0x1E9 | 0xA8 | 0xFC | 0x13 |
| 0x1F0 | 0x10 | 0x1E8 | 0x02 | 0xFD | 0x0C |
| 0x1AE | 0x00 | 0x1E8 | 0x06 | 0x36 | 0x04 |
| 0x1E6 | 0x1C | 0x1E8 | 0x04 | 0x36 | 0x05 |
| 0x1AE | 0x00 | 0x1E8 | 0x00 | 0x36 | 0x04 |
| 0x1E6 | 0x1C | 0x1E9 | 0xA0 | 0xFC | 0x13 |
| 0x47 | 0xC0 | 0x1F0 | 0x18 | 0xFD | 0x0E |
| 0x46 | 0x03 | 0x1F0 | 0x08 | 0x36 | 0x04 |
| 0x47 | 0xC2 | 0x1F0 | 0x28 | 0x36 | 0x05 |
| 0x46 | 0x13 | 0x1F1 | 0x0C | 0x36 | 0x04 |
| 0xFC | 0x13 | 0x1F0 | 0x2A | 0xFC | 0x03 |
| 0xFD | 0x00 | 0x1F0 | 0x2E | 0x36 | 0x04 |
| 0x36 | 0x04 | 0x1F0 | 0x2C | 0x46 | 0x03 |
| 0x36 | 0x05 | 0x1F0 | 0x28 | 0x47 | 0xC0 |
| 0x36 | 0x04 | 0x1F0 | 0x08 | 0x46 | 0x13 |
| 0xFC | 0x13 | 0x1F0 | 0x18 | 0x05 | 0x40 |
| 0xFD | 0x02 | 0x1F0 | 0x38 | 0x68 | 0x40 |
| 0x36 | 0x04 | 0x1F1 | 0x0C | 0x69 | 0xFD |
| 0x36 | 0x05 | 0x1F0 | 0x3A | 0x69 | 0xF5 |
| 0x36 | 0x04 | 0x1F0 | 0x3E | 0x69 | 0xD5 |
| 0xFC | 0x13 | 0x1F0 | 0x3C | 0x69 | 0x55 |
| 0xFD | 0x04 | 0x1F0 | 0x38 | 0x68 | 0x00 |
| 0x36 | 0x04 | 0x1F0 | 0x18 | 0x69 | 0x54 |
| 0x36 | 0x05 | 0x1F0 | 0x10 | 0x69 | 0x50 |
| 0x36 | 0x04 | 0x1AE | 0x00 | 0x69 | 0x40 |
| 0xFC | 0x13 | 0x1E6 | 0x1C | 0x69 | 0x00 |
| 0xFD | 0x06 | 0x1AE | 0x00 | 0x93 | 0x0E |
| 0x36 | 0x04 | 0x1E6 | 0x1C | 0x94 | 0x70 |
| 0x36 | 0x05 | 0x47 | 0xC0 | 0x94 | 0x77 |
| 0x36 | 0x04 | 0x46 | 0x03 | | |

8.3.1.8 STEP 8: SYSREF Synchronization

After setting the analog trim registers, a synchronization using external SYSREF is necessary.

Table 8-12. Device Synchronization Using External SYSREF

| ADDRESS | DATA | DESCRIPTION |
|---------|------|---|
| 0x05 | 0x18 | Select DDCA and DDCB pages |
| 0x181 | 0x34 | Resets the NCO using a single SYSREF pulse |
| 0x181 | 0x30 | |
| 0x05 | 0x02 | Select DIGITAL page |
| 0x236 | 0x02 | Enable internal SYSREF input and clear SYSREF pulse counter |
| 0x236 | 0x03 | Starts SYSREF counter |

8.3.1.9 STEP 9: Run Power up Calibration

The following registers start the power up foreground calibration. The register write order is all writes in first 2 columns before moving to the next set of address and/or data in middle columns, and so on.

Table 8-13. Calibration Register Settings

| ADDRESS | DATA | ADDRESS | DATA | ADDRESS | DATA |
|---------|------|---------|------|--|------|
| 0x05 | 0x20 | 0x05 | 0x00 | 0x95 | 0x00 |
| 0xE7 | 0x01 | 0x04 | 0x01 | 0x96 | 0x00 |
| 0x174 | 0x02 | 0x20 | 0x1F | 0x97 | 0x10 |
| 0x178 | 0x00 | 0x93 | 0x20 | 0x9C | 0x00 |
| 0x17C | 0x22 | 0x04 | 0x01 | 0x57 | 0x1E |
| 0x3C | 0x00 | 0x20 | 0x00 | 0xFE | 0x10 |
| 0xFC | 0x03 | 0x04 | 0x00 | 0xFF | 0x19 |
| 0xFD | 0x00 | 0x05 | 0x20 | 0x46 | 0x02 |
| 0x154 | 0x1C | 0xC0 | 0x7C | 0x45 | 0x8A |
| 0x155 | 0x03 | 0xBC | 0x3C | 0x45 | 0x0A |
| 0xFC | 0x03 | 0xC9 | 0x01 | Delay 1.3 x 3 GSPS/ F _S seconds | |
| 0xEE | 0x26 | 0xC9 | 0x00 | 0xFE | 0x00 |
| 0xEF | 0x02 | 0xC9 | 0x06 | 0xFF | 0x00 |
| 0x18C | 0x88 | 0x38 | 0x01 | 0x89 | 0x00 |
| 0xAE | 0xC8 | 0x110 | 0x10 | 0x95 | 0x00 |
| 0xAF | 0x00 | 0x111 | 0x42 | 0x96 | 0x00 |
| 0xB0 | 0x4C | 0x112 | 0xA6 | 0x97 | 0x00 |
| 0xB1 | 0x3F | 0x112 | 0xD6 | 0x9C | 0x00 |
| 0x4F | 0x46 | 0x113 | 0xBB | 0x57 | 0x1A |
| 0x50 | 0x2C | 0x113 | 0xDB | 0x57 | 0x3A |
| 0x51 | 0x05 | 0x114 | 0xF4 | 0x57 | 0x7A |
| 0x154 | 0x7C | 0x114 | 0x64 | 0x57 | 0xFA |
| 0x158 | 0x7C | 0x115 | 0x0E | 0x58 | 0x01 |
| 0x159 | 0x6F | 0x115 | 0xFE | 0x58 | 0x03 |
| 0x15C | 0x7C | 0x116 | 0x0D | 0x58 | 0x07 |
| 0x15D | 0x3F | 0x116 | 0xDD | 0x58 | 0x0F |
| 0x160 | 0x7C | 0x117 | 0x0D | 0x58 | 0x1F |
| 0x161 | 0x3F | 0x117 | 0xDD | 0x58 | 0x3F |
| 0x164 | 0x7C | 0x46 | 0x03 | 0x45 | 0x8A |
| 0x165 | 0x4F | 0x3D | 0x00 | 0x45 | 0x0A |

Table 8-13. Calibration Register Settings (continued)

| ADDRESS | DATA | ADDRESS | DATA | ADDRESS | DATA |
|---------|------|---------|------|-----------------------------------|------|
| 0x16C | 0x7C | 0x45 | 0x0A | Delay 1.3 x 3 GSPS/ F_S seconds | |
| 0x1B0 | 0x1C | 0x46 | 0x02 | 0x47 | 0xC0 |
| 0x1B1 | 0x5F | 0x64 | 0x4A | 0x46 | 0x03 |
| 0x1D8 | 0x1C | 0x65 | 0x05 | 0x47 | 0xC0 |
| 0x1D9 | 0xAF | 0x68 | 0x28 | 0x05 | 0x80 |
| 0xB2 | 0x1F | 0x69 | 0x5E | 0x20 | 0x1F |
| 0xB5 | 0x7F | 0x6A | 03D | 0x9D | 0x05 |
| 0x165 | 0xFF | 0x6B | 0x8F | 0x9E | 0x08 |
| 0x38 | 0x01 | 0x6C | 0x44 | 0x8B | 0x40 |
| 0xA4 | 0x30 | 0x57 | 0xDA | 0x20 | 0x00 |
| 0xC5 | 0x7F | 0x57 | 0x9A | 0x05 | 0x00 |
| 0xA8 | 0x00 | 0x57 | 0x1A | 0x04 | 0x01 |
| 0xA2 | 0x63 | 0x58 | 0x3E | 0x20 | 0x1F |
| 0xA3 | 0x00 | 0x58 | 0x3C | 0x9D | 0x05 |
| 0xAD | 0x02 | 0x58 | 0x38 | 0x9E | 0x08 |
| 0x05 | 0x80 | 0x58 | 0x30 | 0x8B | 0x40 |
| 0x20 | 0x1F | 0x58 | 0x20 | 0x20 | 0x00 |
| 0x93 | 0x20 | 0x58 | 0x00 | 0x04 | 0x00 |
| 0x20 | 0x00 | 0x89 | 0x20 | | |

8.3.1.10 STEP 10: JESD Interface Synchronization

The JESD interface can be synchronized using SPI writes or the GPIO1 pin.

Table 8-14. JESD Interface Synchronization Using SPI Writes

| ADDRESS | DATA | DESCRIPTION |
|---------|------|--|
| 0x05 | 0x04 | Select JESD page |
| 0x21 | 0x41 | Configure ADC to control SYNC using SPI writes |
| 0x21 | 0x61 | Configure JESD interface to send K28.5 characters for receiver synchronization |
| 0x21 | 0x41 | Configure JESD interface to send normal ADC data |

8.4 Power Supply Recommendations

The ADC32RF5x requires four different power-supplies. The AVDD18, AVDD12 and CLKVDD rail provides power for the internal analog and clocking circuits of the ADC. The DVDD rail powers the digital logic (including averaging and decimation filter) and the JESD204B digital interface.

Power sequencing is required as shown in [Initialization Set Up](#). The AVDD18, AVDD12 and especially the CLKVDD power supply must be low noise in order to achieve data sheet performance. For applications operating near DC, the 1/f noise contribution of the power supply needs to be considered as well.

Power supply decoupling capacitors (0.1 μF) as close to the pins as possible on the top layer are recommended.

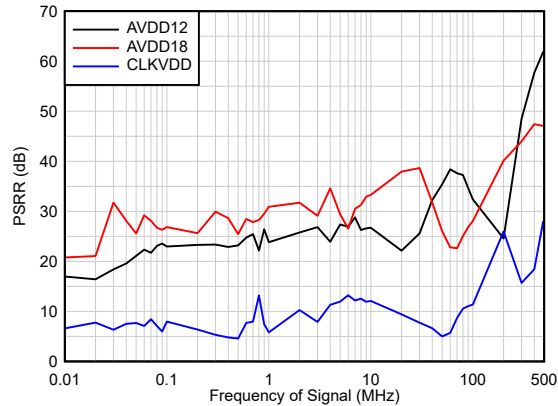


Figure 8-5. Power Supply Rejection Ratio (PSRR) vs Frequency

The recommended power supply architecture for a low noise design is to first use a high-efficiency step down switching regular, followed by a second stage of regulation using a low noise LDO for each power rail as shown in [Figure 8-6](#). This provides additional switching noise reduction and improved voltage accuracy.

TI WEBENCH® Power Designer can be used to select and design the individual power-supply elements. Recommended switching regulators for the first stage include the LMS3635, and similar devices. Recommended low dropout (LDO) linear regulators include the TPS7A8400, and similar devices.

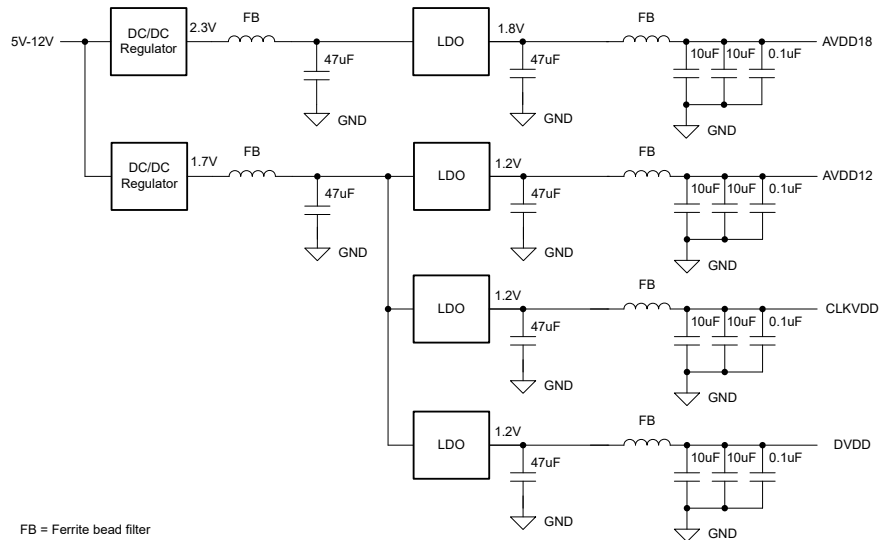


Figure 8-6. Power Supply Design Example

AVDD12 or CLKVDD should not be shared with the DVDD in order to prevent digital switching noise from coupling into the analog domain.

8.5 Layout

8.5.1 Layout Guidelines

There are several critical signals which require specific care during board design:

1. Analog input and clock signals
 - Traces should be as short as possible and vias should be avoided where possible to minimize impedance discontinuities.
 - Traces should be routed using loosely coupled 100- Ω differential traces.
 - Differential trace lengths should be matched as close as possible to minimize phase imbalance and HD2 degradation.
2. Digital JESD204B output interface
 - Traces should be routed using tightly coupled 100- Ω differential traces.
3. Power and ground connections
 - Provide low resistance connection paths to all power and ground pins.
 - Use power and ground planes instead of traces.
 - Avoid narrow, isolated paths which increase the connection resistance.
 - Use a signal/ground/power circuit board stackup to maximize coupling between the ground and power plane.

8.5.2 Layout Example

The following screen shot shows the top layer of the ADC32RF5x EVM.

- The input signal traces are routed as differential signals on the top layer avoiding vias. Care is taken to maintain symmetry between positive and negative input with matched trace length in order to minimize phase imbalance.

[Figure 8-7](#) shows the layout example for 1x and 2x averaging configuration

[Figure 8-8](#) shows the layout example for 4x averaging configuration

- JESD204B output interface lanes are routed differential and length matched
- Bypass caps are close to the power pins on the top layer avoiding vias.

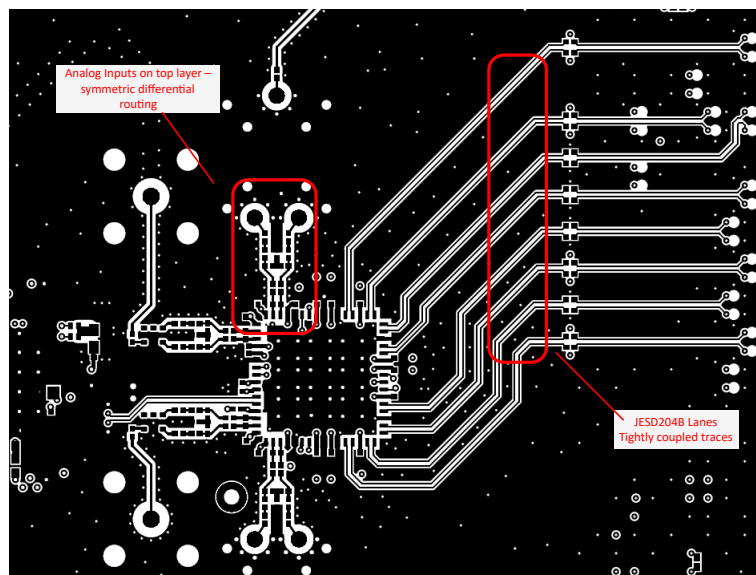


Figure 8-7. Layout example: top layer of ADC32RF5x EVM

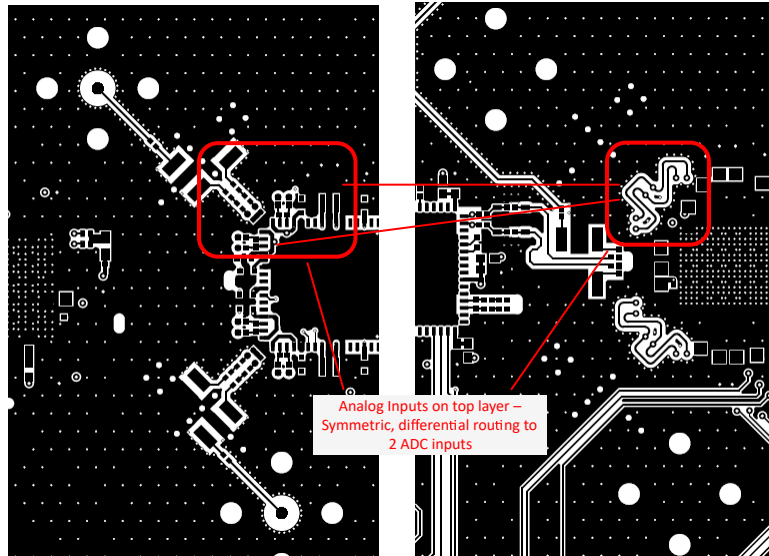


Figure 8-8. Layout example for 4x AVG: ADC32RF5x EVM

9 Device and Documentation Support

9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

9.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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9.3 Trademarks

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9.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADC32RF54IRTD | ACTIVE | VQFN | RTD | 64 | 260 | RoHS & Green | NIPDAU NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32RF54 | Samples |
| ADC32RF54IRTD | ACTIVE | VQFN | RTD | 64 | 250 | RoHS & Green | NIPDAU NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32RF54 | Samples |
| ADC32RF55IRTD | ACTIVE | VQFN | RTD | 64 | 260 | RoHS & Green | NIPDAU NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32RF55 | Samples |
| ADC32RF55IRTD | ACTIVE | VQFN | RTD | 64 | 250 | RoHS & Green | NIPDAU NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32RF55 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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GENERIC PACKAGE VIEW

RTD 64

VQFN - 0.9 mm max height

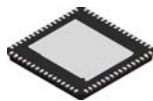
PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4205146/D

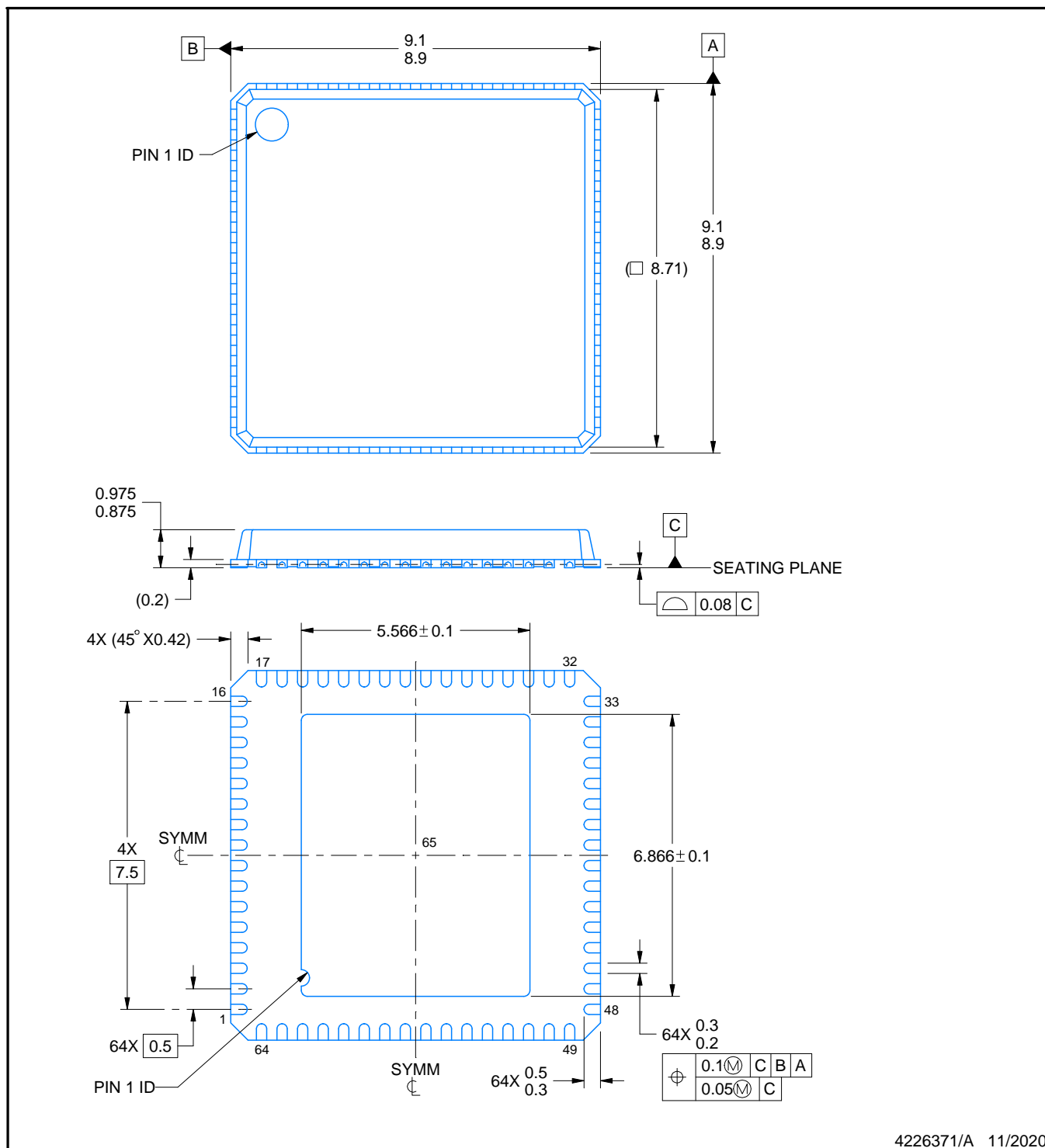
RTD0064N



PACKAGE OUTLINE

VQFN - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4226371/A 11/2020

NOTES:

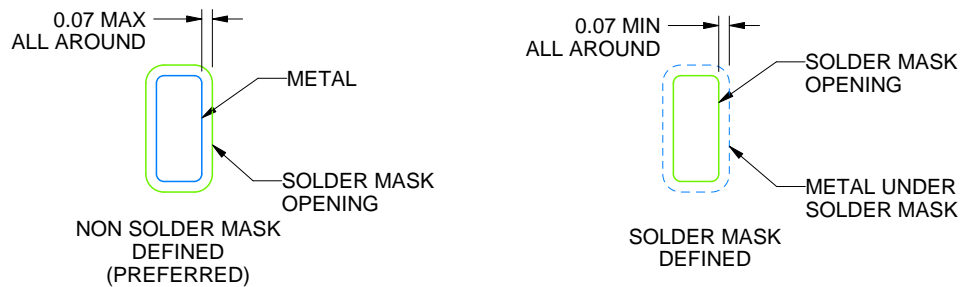
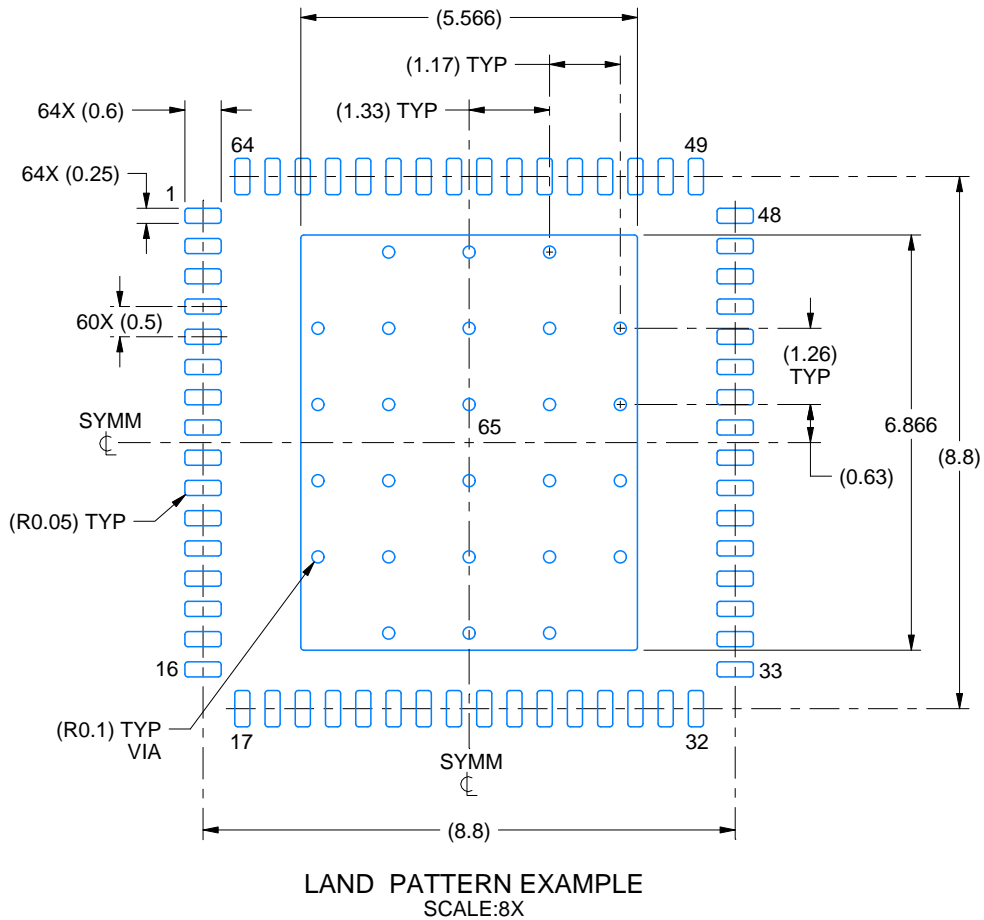
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

RTD0064N

VQFN - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



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NOTES: (continued)

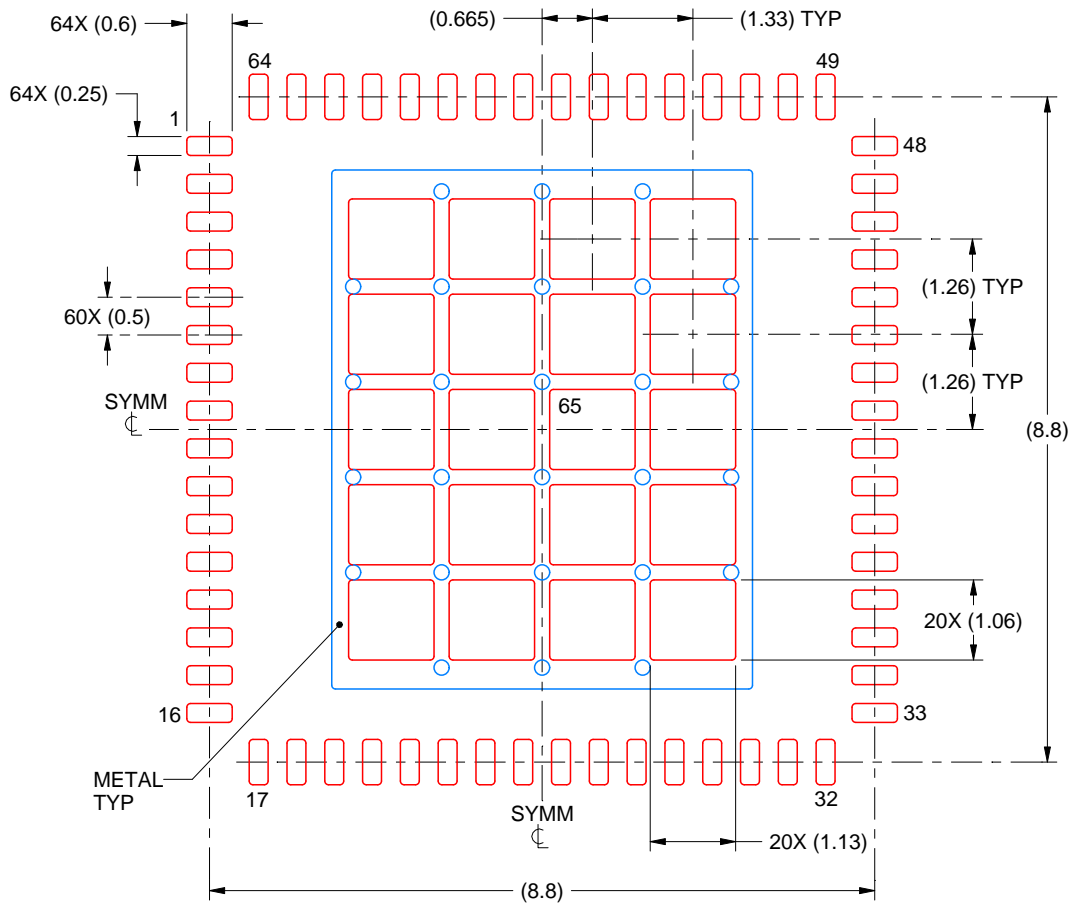
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sl原因271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RTD0064N

VQFN - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 65:
 63% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
 SCALE:10X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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